

FORM 20-F

STMICROELECTRONICS NV - STM

Filed: June 27, 2000 (period: December 31, 1999)

Registration of securities of foreign private issuers pursuant to section 12(b) or (g)

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PART I

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SECURITIES AND EXCHANGE COMMISSION Washington, D.C. 20549 _____ FORM 20-F [] REGISTRATION STATEMENT PURSUANT TO SECTION 12(b) OR (g) OF THE SECURITIES EXCHANGE ACT OF 1934 OR [X] ANNUAL REPORT PURSUANT TO SECTION 13 OR 15(d) OF THE SECURITIES ACT OF 1934 For the fiscal year ended: December 31, 1999 OR [] TRANSITION REPORT PURSUANT TO SECTION 13 OR 15(d) OF THE SECURITIES ACT OF 1934 For the transition period from to Commission file number: 1-13546 _____ STMicroelectronics N.V. (Exact name of Registrant as specified in its charter) Not Applicable The Netherlands (Translation of Registrant's (Jurisdiction of incorporation name into English) or organization)

Route de Pre-Bois ICC Bloc A1215 Geneva 15 Switzerland

(Address of principal executive offices)

Securities registered or to be registered pursuant to Section 12(b) of the Act:

 Title of each class:
 Name of each exchange on which registered:

 Common Shares, nominal value EUR 3.12 per share*
 New York Stock Exchange

 Liquid Yield OptionTM Notes due June 10, 2008
 New York Stock Exchange

 Liquid Yield OptionTM Notes due September 22, 2009
 New York Stock Exchange

* (not adjusted to reflect the 3:1 split effected on May 5, 2000)

Securities registered or to be registered pursuant to Section 12(g) of the Act: None $% \left({\left({x_{1},y_{2},y_{3}$

Securities for which there is a reporting obligation pursuant to Section 15(d) of the Act: None $% \left({{\rm Sec}} \right)$

Indicate the number of outstanding shares of each of the issuer's classes of capital or common stock as of the close of the period covered by the annual report:

289,808,140 Common Shares*

* (not adjusted to reflect the 3:1 split effected on May 5, 2000)

Indicate by check mark whether the registrant (1) has filed all reports required to be filed by Section 13 or 15(d) of the Securities Exchange Act of 1934 during the preceding 12 months (or for such shorter period that the registrant was required to file such reports), and (2) has been subject to such filing requirements for the past 90 days.

Yes [X] No []

Indicate by check mark which financial statement item the registrant has elected to follow:

Item 17 [] Item 18 [X]

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 $^{\star}\textsc{Omitted}$ because item is not applicable.

CAUTIONARY STATEMENT REGARDING FORWARD-LOOKING STATEMENTS

Certain of the statements contained in this annual report that are not historical facts, including without limitation, certain statements made in the sections hereof entitled "Item 1: Description of Business" and "Item 9: Management's Discussion and Analysis of Financial Condition and Results of Operations," are statements of future expectations and other forward-looking statements (within the meaning of Section 27A of the Securities Act of 1933, as amended) that are based on management's current views and assumptions and involve known and unknown risks and uncertainties that could cause actual results, performance or events to differ materially from those in such statements due to, among other factors, (i) inability to meet customer demand, (ii) capital requirements, (iii) new product developments and technological change, (iv) manufacturing risks, (v) inability to achieve timely ramp-up of production, (vi) the loss of key personnel and the inability to recruit additional personnel, (vii) the highly cyclical nature of the semiconductor industry, (viii) competition, (ix) inability of the foundry suppliers to meet order requirements, (x) variations in industry capacity, (xi) variability of operating results, (xii) economic downturn in any of our major markets, (xiii) possible acquisitions, (xiv) control of the Company and potential conflicts of interest, (xv) loss of key customers and strategic relationships, (xvi) intellectual property issues, (xvii) international operations and the related regulatory environment, including changes in laws related to investment and taxation, (xviii) currency fluctuations, (xix) dependence on certain sources of supply and (xx) environmental regulations. See also "Risk Factors" included in the Company's Prospectuses dated September 16, 1999.

PRESENTATION OF FINANCIAL AND OTHER INFORMATION

References in this annual report to published industry data are references to data published by Dataquest, Inc. ("Dataquest") and references to trade association data are references to World Semiconductor Trade Statistics ("WSTS"). Except as otherwise disclosed herein, all references to the Company's market positions in this annual report are based on 1999 revenues according to published industry data. Certain terms used in this annual report are defined in "Certain Terms."

In this annual report, references to the "EU" are to the European Union, references to the "EUR" and the "euro" are to the euro currency of the EU, references to the "United States" are to the United States of America and references to "\$" or to "U.S. dollars" are to United States dollars.

PART I

Item 1: Description of Business

The Company

STMicroelectronics N.V. (the "Company") is a global independent limited liability semiconductor company that designs, develops, manufactures and markets a broad range of semiconductor integrated circuits and discrete devices used in a wide variety of microelectronic applications, including automotive products, computer peripherals, telecommunications systems, consumer products, industrial automation and control systems. The Company believes it was eighth among worldwide suppliers of semiconductor devices in 1999, based on various independent market research institutes and published company reports. On this basis, STMicroelectronics was the world's leading supplier of differentiated analog and mixed-signal ICs (ASICs and ASSPs), digital decoder ICs (MPEG), disk drive ICs, special automotive ICs, EPROM memories and protection devices, and the second leading supplier of total analog and mixed-signal ICs, ADSL Kits, EEPROM memories, thyristors and triacs, and smartcard MCUs. The Company currently offers more than 3,000 main types of products to approximately 800 direct customers. Major customers include Alcatel, Bosch, DaimlerChrysler, Ericsson, Gemplus, Hewlett-Packard, IBM, Marelli, Matsushita, Maxtor, Motorola, Nokia, Nortel Networks, Philips, Pioneer, Samsung, Schlumberger, Scientific Atlanta, Seagate, Siemens, Sony, Thomson Multimedia and Western Digital. The Company also sells its products through distributors.

The Company offers a diversified product portfolio and develops products for a wide range of market applications to reduce its dependence on any single product, industry or application market. Within its diversified portfolio, the Company has focused on developing products that exploit its technological strengths in creating customized, system-level solutions with substantial analog and mixed-signal content. Products include differentiated ICs (which the Company defines as being its dedicated products, semicustom devices and microcontrollers) and analog ICs (including mixed-signal ICs), the majority of which are also differentiated ICs. As a leading provider of differentiated ICs, the Company has developed close relationships with customers, resulting in early knowledge of their evolving requirements and opportunities to access their markets for other products. Differentiated ICs, which are less vulnerable to competitive pressures than standard commodity products, accounted for approximately 63% of the Company's net revenues in 1999 compared to approximately 62% in 1998. The Company also targets applications that require substantial analog and mixed-signal content and can exploit the Company's system level expertise. Analog ICs accounted for approximately 51% of the Company's 1999 net revenues compared to approximately 50% in 1998, while discrete devices accounted for approximately 12% of the Company's net revenues in 1999 compared to approximately 13% in 1998. In general, differentiated ICs, in particular analog ICs, experience less volatility in sales growth rates and average selling prices than the overall semiconductor industry.

STMicroelectronics' products are manufactured and designed using a broad range of manufacturing processes and proprietary design methods. STMicroelectronics uses all of the prevalent function-oriented process technologies, including CMOS, bipolar and nonvolatile memory technologies. In addition, by combining basic processes, the Company has developed advanced systems-oriented technologies that enable it to produce differentiated and application-specific products, including BiCMOS technologies (bipolar and CMOS) for mixed-signal applications, BCD technologies (bipolar, CMOS and DMOS) for intelligent power applications and embedded memory technologies. This broad technology portfolio, a cornerstone of the Company's strategy for many years, enables the Company to meet the increasing demand for "system-on-a-chip" solutions. To complement this depth and diversity of process and design technology, the Company also possesses a broad intellectual property portfolio that it uses to enter into cross-licensing agreements with many major semiconductor manufacturers.

In 1999, several prestigious awards were accorded to the Company's regional subsidiaries, underscoring its long-standing commitment to business excellence: the prestigious Malcolm Baldrige National Quality Award in the U.S., the Singapore Quality Award, the Moroccan National Quality Award, and the EPA Climate Protection Award (US). These, together with the Company's previous honors - the Malaysian Prime Minister Quality Award, the Malta Quality Award and the European Quality Award for Business Excellence in the category of large businesses awarded in 1997 by the European Foundation for Quality Management - illustrate the success of the Company's unified Total Quality and Environmental Management philosophy on four continents. Total Quality and Environmental Management or "TQEM" defines a common set of objectives and performance measurements for

employees in all geographic regions, at every stage of product design, development and production for all product lines. See "Strategy" below and "Item 2: Description of Property--Manufacturing."

The Company introduced in 1999 several new products and plans to further develop and produce superintegrated, system-level silicon solutions for a set of targeted applications such as computer peripherals (including hard disk drives, optical storage devices, inkjet printers, monitors, LCD displays and webcams), digital consumer devices (including set-top boxes, DVDs, digital television, digital cameras and MP3 digital music players), wireless telecommunications products (including digital cellular handsets), digital networks (including xDSL, ATM, voice over Internet protocol ("VoIP") and optical network ICS) as well as automotive electronics (including injection control, safety, car radio and car multimedia) and smartcards (including telecommunications, banking, pay TV and personal identification).

In addition to the many dedicated and semicustom ICs developed using power analog, digital and mixed-signal technologies, the Company has focused its research and manufacturing efforts on developing an advanced range of the key technological building blocks required by targeted applications. These building blocks include (i) MPEG2 decoder ICs, (ii) a family of 16 bit (ST10, super 10), 32 bit (ST20) and 64 bit (ST50) microcontrollers, (iii) a family of general purpose DSP cores for embedded applications based on the current D950 solution and the ST100 (currently being sampled to customers) as well as several dedicated DSP cores (MMDSP, SAFIRE, EMIRALDA) for specific applications, and (iv) embedded volatile (DRAM and SRAM) and nonvolatile (EPROM, EEPROM and Flash) memories.

Applying its broad range of technologies and its expertise in diverse application domains, the Company is currently embedding dedicated, semicustom circuits and these advanced building blocks on the same chip. Superintegrated products developed to date include the STi55XX Omega platform (a platform for digital consumer applications such as set-top boxes and DVDs), which has achieved significant design wins and production volumes in 1999.

At the beginning of 1999, the Company implemented organizational changes to better orient its product groups to end use applications. As a result, the former Dedicated Products Group ("DPG") has become the Telecommunications, Peripherals and Automotive Groups ("TPA"), while the former Programmable Products Group has become the Consumer and Microcontroller Groups ("CMG"). Consequently, the Company's products are now organized into the following principal groups:

- o Telecommunications, Peripherals and Automotive
- o Consumer and Microcontroller
- o Memory Products
- o Discrete and Standard ICs

As part of its activities outside the above principal product groups, the Company also has a New Ventures Group, which identifies and develops new business opportunities to complement the Company's existing businesses, and a Subsystems Product Group, which produces subsystems for industrial and other applications.

The Company has five 8-inch wafer production facilities of which two at Crolles, France and Catania, Italy are operating at full capacity and currently being expanded, one in Phoenix, Arizona, is almost saturated, and two in Rousset, France and Agrate, Italy, are currently in start up mode with volume production expected at the end of the second quarter of 2000. Construction of a new 8-inch submicron facility is underway in Singapore. An additional 8-inch submicron fabrication plant in Catania, Italy is planned to become operational by the year 2002.

In 1999, to face the sudden increase in demand, the Company bought a new facility in Singapore preparing for production of 6-inch wafer by the end of 2000, performed expansion of its production of 6-inch wafers in Carrollton, Texas and Rancho Bernardo, California, and completed three conversions from 5 to 6-inch in Rennes and Tours, France, and Catania, Italy.

In line with its expansion of front-end facilities, the Company is also expanding all its back-end plants at its existing facilities in Morocco, Malta, Malaysia, Singapore, and China and started in early 2000 to equip a newly acquired back-end plant in Tuas, Singapore.

The Company has historically subcontracted part of its back-end operations (in the range of 15% of total volumes) to external suppliers. In 1999, to cope with a sudden surge in demand, the Company has decided to significantly increase the qualification of external foundries for front-end manufacturing, with the aim of having the possibility to satisfy in the range of 15% of its total wafer demand through sub-contracts.

The Company has also announced its decision to build an advanced 12-inch wafer pilot-line fab in Crolles, France which will be funded and operated jointly with Philips Semiconductors. This new agreement expands the existing technological cooperation agreement that has been in place with Philips Semiconductors since 1992. The pilot line will initially be designed to produce up to 1000 wafer per week, with potential to ramp up to 2000 wafers per week as needed. Site preparation has commenced, with the first 12-inch wafers expected to be processed around two years time. Furthermore, the Company will continue its very productive cooperation program with France Telecom R&D (formerly CNET) and with Leti (research lab of the French Commissariat a l'Energie Atomique - CEA) as part of its contribution to the new joint pilot line in Crolles.

STMicroelectronics is international in scope. The Company operates front-end and/or back-end manufacturing facilities in Europe, the United States, the Mediterranean and Asia Pacific regions, and conducts research and development primarily in France and Italy and design, marketing and sales activities in each of the electronics industry's major economic regions: Europe, the United States, the Asia Pacific region and Japan. In 1999, approximately 36.3% of the Company's net revenues originated in Europe (compared to 41.6% in 1998), approximately 22.9% in North America (compared to 22.1% in 1998), approximately 32.8% in the Asia Pacific region (compared to 29.4% in 1998), approximately 4.7% in Japan (compared to 4.3% in 1998) and approximately 3.3% in Region Five (including emerging markets such as South America, Africa, Eastern Europe, India and the Middle East) (compared to 2.6% in 1998). See "--Sales, Marketing and Distribution". In 1999, approximately 38% of the 6-inch equivalent wafers manufactured by the Company were manufactured outside Europe and approximately 45% of the Company's employees were located outside Europe.

STMicroelectronics believes that strategic alliances are critical to success in the semiconductor industry, and has entered into strategic alliances with customers, other semiconductor manufacturers and major suppliers of design software. The Company has entered into several strategic customer alliances, including alliances with Alcatel, Bosch, Hewlett-Packard, Marelli, Nortel Networks, Pioneer, Seagate, Thomson Multimedia and Western Digital, among others. Customer alliances provide the Company with valuable systems and application know-how and access to markets for key products, while allowing the Company's customers to share some of the risks of product development with the Company and gain access to the Company's process technologies and manufacturing infrastructure. Alliances with other semiconductor manufacturers, such as the cooperation with Philips Semiconductors in Crolles, France, for the development of advanced CMOS logic manufacturing processes, as well as the building and operations of a 12-inch wafer pilot line fab in Crolles, France, the agreement with Mitsubishi for CMOS flash memory processes using 0.20 through 0.18 micron lithography and the agreement with Hitachi on SuperH microprocessors, permit costly research and development and manufacturing resources to be shared to mutual advantage for joint technology development. The Company has established joint development programs with leading suppliers such as Air Liquide, Applied Materials, ASM Lithography, Canon, Hewlett-Packard, KLA-Tencor, LAM Research, MEMC, Schlumberger, Teradyne and Wacker and with CAD tool producers including Cadence and Synopsys. It is a participant in Sematech I 300I for the development of 300 millimeter wafer manufacturing processes. STMicroelectronics is active in joint European research efforts such as the MEDEA program, and also cooperates with major research institutions and universities.

In 1999, STMicroelectronics started development of 0.15 micron drawn (0.13 micron effective gate length) CMOS process technology, at Crolles, France. At the same time, STMicroelectronics has recently started production of its 0.15 micron effective gate length (0.18 micron drawn) CMOS technology, known as HCMOS-8. This process is aimed at producing "system-on-chip" products incorporating up to tens of millions of transistors combined with embedded memory for telecom, digital consumer and computer applications.

Semiconductors are the basic building blocks used to create an increasing variety of electronic products and systems. Since the invention of the transistor in 1948, continuous improvements in semiconductor process and design technologies have led to smaller, more complex and more reliable devices at a lower cost per function. As performance has increased and size and cost have decreased, semiconductors have expanded beyond their original primary applications (military applications and computer systems), to applications such as telecommunications systems, consumer goods, automotive products and industrial automation and control systems. In addition, system users and designers have demanded systems with more functionality, higher levels of performance, greater reliability and shorter design cycle times, all in smaller packages at lower costs. These demands have resulted in increased semiconductor content as a percentage of system cost. Calculated on the basis of the total available market (the "TAM"), which includes all semiconductor products, as a percentage of worldwide revenues from production of electronic equipment according to published industry data, semiconductor pervasiveness has increased from approximately 9% in 1991 to approximately 18% in 1999. The demand for electronic systems has also expanded geographically with the emergence of new markets, particularly in the Asia Pacific region.

Semiconductor sales have increased significantly over the long term but have experienced significant cyclical variations in growth rates. According to trade association data the TAM increased from \$17.8 billion in 1983 to \$149.4 billion in 1999 (growing at a compound annual rate of approximately 14%). At the same time the serviceable available market (the "SAM"), which prior to 1995 consisted of the TAM without DRAMS, microprocessors and opto-electronic products and commencing in 1995 and for all subsequent periods presented, includes microprocessors, increased from approximately \$15.0 billion in 1983 to \$122.9 billion in 1999 (growing at a compound annual rate of approximately 14%). In 1999, the TAM increased by 18.9%. Based on preliminary trade association data for the first quarter of 2000, the TAM increased in the first quarter of 2000 by 33.8% compared to the first quarter of 1999. The SAM increased 14.9% in 1999 compared to 1998; however, based on preliminary trade association data for the first guarter of 2000, the SAM increased by 33.2% compared to the first guarter of 1999. In 1999, approximately 31.8% of all semiconductors were shipped to the Americas, 21.9% to Japan, 21.3% to Europe, and 25% to the Asia Pacific region.

Although cyclical changes in production capacity in the semiconductor industry and demand for electronic systems have resulted in pronounced cyclical changes in the level of semiconductor sales and fluctuations in prices and margins for semiconductor products from time to time, the semiconductor industry has experienced substantial growth over the long term. Factors that are contributing to long-term growth include the development of new semiconductor applications, increased semiconductor content as a percentage of total system cost, emerging strategic partnerships and growth in the electronic systems industry in the Asia Pacific region.

Semiconductor Classifications

The process technologies, levels of integration, design specificity, functional technologies and applications for different semiconductor products vary significantly. As differences in these characteristics have increased, the semiconductor market has become highly diversified as well as subject to constant and rapid change. Semiconductor product markets may be classified according to each of these characteristics.

Semiconductors can be manufactured using different process technologies, each of which is particularly suited to different applications. Since the mid-1970s, the two dominant processes have been bipolar (the original technology used to produce integrated circuits) and CMOS (complementary metal-oxide-silicon). Bipolar devices typically operate at higher speeds than CMOS devices, but CMOS devices consume less power and permit more transistors to be integrated on a single IC. While bipolar semiconductors were once used extensively in large computer systems, CMOS has become the prevalent technology, particularly for devices used in personal computer systems. In connection with the development of new semiconductor applications and the demands of system designers for more integrated semiconductors, advanced technologies have been developed during the last decade that are particularly suited to more systems-oriented semiconductor applications. For mixed-signal applications, BiCMOS technologies have been developed to combine the high speed and high voltage characteristics of bipolar technologies with the low power consumption and high integration of CMOS technologies. For intelligent power applications, BCD technologies have been developed that combine bipolar, CMOS and DMOS technologies. Such systems-oriented technologies require more process steps and mask levels, and are more complex than the basic

function-oriented technologies. The use of systems-oriented technologies requires knowledge of system design and performance characteristics (in particular, analog and mixed-signal systems and power systems) as well as expertise and experience with several semiconductor process technologies.

Semiconductors are often classified as either discrete devices (such as individual diodes, thyristors, transistors as well as opto-electronic products) or integrated circuits (in which thousands of functions are combined on a single "chip" of silicon to form a more complex circuit). Compared to the market for ICs, there is typically less differentiation among discrete products supplied by different semiconductor manufacturers. Also, discrete markets have generally grown at slower, but more stable, rates than IC markets.

Semiconductors may also be classified as either standard components or application-specific ICs ("ASICs"). Standard components are used by a large group of systems designers for a broad range of applications, while ASICs are designed to perform specific functions in specific applications. Generally, there are three types of ASICs: full-custom devices, semicustom devices and application-specific standard products ("ASSPs"). Full custom devices are typically designed to meet the particular requirements of one specific customer. Semicustom devices are more standardized ICs that can be customized with efficient CAD tools within a short design cycle time to perform specific functions. ASSPs are standardized ASICs that are designed to perform specific functions in a specific application, but are not proprietary to a single customer.

The two basic functional technologies for semiconductor products are analog and digital. Analog (or linear) devices monitor, condition, amplify or transform analog signals, which are signals that vary continuously over a wide range of values. Analog circuits are critical as an interface between electronic systems and a variety of real world phenomena such as sound, light, temperature, pressure, weight or speed. Electronics systems continuously translate analog signals into digital data, and vice versa.

The analog semiconductor market consists of a large and growing group of specific markets that serve numerous and widely differing applications, including applications for automotive systems, instrumentation, computer peripheral equipment, industrial controls, communications devices, video products and medical systems. Because of the varied applications for analog circuits, manufacturers typically offer a greater variety of devices to a more diverse group of customers. Compared to the market for commodity digital devices such as standard memory and logic devices, the analog market is characterized by longer product life cycles, products that are less vulnerable to technological obsolescence, and lower capital requirements due to the use of mature manufacturing technologies. Such characteristics have resulted in growth rates that have been less volatile than growth rates for the overall semiconductor industry.

Digital devices perform binary arithmetic functions on data represented by a series of on/off states. Historically, the digital IC market has been primarily focused on the fast growing markets for computing and information technology systems. Increasing demands for high-throughput computing and networking and the proliferation of more powerful personal computers and workstations in recent years have led to dramatic increases in digital device density and integration. As a result, significant advances in electronic system integration have occurred in the design and manufacture of digital devices.

There are two major types of digital ICs: memory products and logic devices. Memory products, which are used in electronic systems to store data and program instructions, are generally classified as either volatile memories (which lose their data content when power supplies are switched off) or nonvolatile memories (which retain their data content without the need for constant power supply). Volatile memories are used to store data in virtually all computer systems, from large and mid-range computers to personal computers and workstations. Memory products are typically standard, general purpose ICs that can be manufactured in high volumes using basic CMOS processes, and they are generally differentiated by cost and physical and performance characteristics, including data capacity, die size, power consumption and access speed.

The primary volatile memory devices are DRAMs, which accounted for 13.8% of semiconductor memory sales in 1999, and SRAMs (static RAMs). DRAMs are volatile memories that lose their data content when power supplies are switched off, whereas SRAMs are volatile memories that allow the storage of data in the memory array but without the need for clock or refresh logic circuitry. SRAMs are roughly four times as complex as DRAMs (four transistors per bit of memory compared to one transistor) and are significantly more expensive than DRAMs per unit

of storage. DRAMs are used in a computer's main memory to temporarily store data retrieved from low cost external mass memory devices such as hard disk drives. SRAMs are principally used as caches and buffers between a computer's microprocessor and its DRAM-based main memory.

Nonvolatile memories are typically used to store program instructions that control the operation of microprocessors and electronic systems. Among such nonvolatile memories, read-only memories ("ROMs") are permanently programmed when they are manufactured while programmable ROMs (PROMs) can be programmed by system designers or end-users after they are manufactured. Erasable PROMs (EPROMs) may be erased and reprogrammed several times, but to do so EPROMs must be physically removed from electronic systems, exposed to ultraviolet light, reprogrammed using an external power supply and then returned to the systems. Electrically erasable PROMs (EEPROMS) can be erased byte by byte and reprogrammed "in-system" without the need for removal. Using EEPROMs, a system designer or user can program or reprogram systems at any time. "Flash" memories are products that represent an intermediate solution for system designers between EPROMs and EEPROMs based on their cost and functionality.

Flash memories are typically less expensive per bit of stored information than EEPROMs, and can also be erased and rewritten. The entire content of a flash memory or large blocks of data (not individual bytes) can be erased with a "flash" of current. Because flash memories can be erased and reprogrammed electrically and in-system, they are more flexible than EPROMs and, therefore, progressively replace EPROMs in many of their current applications. Flash memories are typically used in high volume in digital mobile phones and digital consumer applications (set-top boxes, DVDs, digital cameras, MP3 digital music players) and are also suitable for solid state mass storage of data and emerging high volume application.

Logic devices process digital data to control the operation of electronic systems. The largest segment of the logic market, standard logic devices, includes microprocessors, microcontrollers and digital signal processors. Microprocessors are the central processing units of computer systems. Microcontrollers are complete computer systems contained on single integrated circuits that are programmed to specific customer requirements. They contain microprocessor cores as well as logic circuitry and memory capacity. Microcontrollers control the operation of electronic and electromechanical systems by processing input data from electronic sensors and generating electronic control signals, and are used in a wide variety of consumer products (including alarm systems, household appliance controls and video products), automotive systems (including engine control and dashboard instrumentation), computer peripheral equipment (including disk drives, facsimile machines, printers and optical scanners), industrial applications (including motor drives and process controllers), and telecommunications systems (including telephones, answering machines and digital cellular phones). Digital signal processors ("DSPs") are parallel processors used for high complexity, high speed real-time computations in a wide variety of applications, including answering machines, modems, digital cellular telephone systems, audio processors and data compression systems. Standard devices are intended to be utilized by a large group of systems designers for a broad range of applications. Consequently, standard devices usually contain more functions than are actually required and, therefore, may not be cost-effective for certain specific applications. In addition to standard logic devices, a broad range of full-custom, semicustom and ASSP logic devices is developed for a wide variety of applications. These devices are typically designed to meet particular customer requirements. Compared to memory markets, logic device markets are much more differentiated and dependent upon intellectual property and advanced product design skills.

Analog/digital (or "mixed-signal") ICs combine analog and digital devices on a single chip to process both analog signals and digital data. Historically, analog and digital devices have been developed separately as they are fundamentally different and it has been technically difficult to combine analog and digital devices on a single IC. System manufacturers have generally addressed mixed-signal requirements using printed circuit boards containing many separate analog and digital circuits acquired from multiple suppliers. However, system designers are increasingly demanding system level integration in which complete electronic systems containing both analog and digital functions are integrated on a single IC.

Mixed-signal ICs are typically characterized as analog ICs due to their similar market characteristics, including longer product life cycles, diverse applications and customers and more stable growth through economic cycles as compared to digital devices. However, certain parts of the mixed-signal market are becoming higher volume markets as the increasing use of mixed-signal devices has enhanced the options of system designers and contributed to the development of new applications, including multimedia, video conferencing, automotive, mass storage and personal communications.

The Semiconductor Market

The following table sets forth information with respect to worldwide semiconductor sales by type of semiconductor and geographic region:

	Worldwide Semiconductor Sales(1)			Compound Anr	ual Growth	Rates(2)			
	1983	1993	1997	1998	1999	83-93	93-97	97-98	98-99
			oillions of	\$)		(expres	sed as per	centages)	
Integrated Circuits Analog (linear and	\$13.3	\$66.0	\$119.5	\$109.1	\$130.3	17.4%	16.0%	(8.8)%	19.3%
Mixed-signal) Digital Logic Memory:	2.8 6.7	10.7 34.1	19.7 70.4	19.1 67.0	22.1 75.9	14.3 17.7	16.5 19.9	(3.4) (4.9)	15.7 13.3
DRAM Others	1.7 2.0	13.1 8.1	19.7 9.6	14.0 9.0	20.7 11.6	22.7 15.0	10.7 4.4	(29.2) (5.8)	47.8 28.9
Total Memory Total digital Discrete Opto-electronics	3.7 10.4 3.7 0.7	21.2 55.3 8.6 2.6	29.3 99.6 13.1 4.5	23.0 90.0 11.9 4.6	32.3 108.2 13.4 5.7	19.1 18.2 8.8 14.0	8.4 15.8 11.1 14.7	(21.6) (9.8) 2.5 2.5	40.3 20.0 12.6 23.9
TAM	\$17.8 =====	\$77.3	\$137.2	\$125.6	\$149.4	15.8% =====	15.4%	(8.4)%	18.9% =====
Europe Americas Asia Pacific Japan	3.3 7.8 1.2 5.5	14.6 24.7 14.2 23.8	29.1 45.9 30.1 32.1	29.4 41.4 28.9 25.9	31.9 47.5 37.2 32.8	16.0 12.2 28.0 15.8	18.8 16.8 20.7 7.8	1.1 (9.6) (4.4) (19.2)	8.5 14.7 28.7 26.6
TAM	\$17.8	\$77.3 =====	\$137.2	\$125.6	\$149.4 ======	15.8%	15.4%	(8.4)%	18.9%

Source: WSTS.

(2) Calculated using end points of the periods specified.

During the 1960s and 1970s, the development of semiconductor process technologies was critical to the success of participants in the industry. As process technologies matured, manufacturing sciences became important; in the 1980s, the emphasis shifted to increasing production volumes and yields and lowering production costs. The large capital expenditures and other resources required during this period to develop advanced manufacturing capabilities resulted in a stratification of the industry between broad range suppliers operating multiple front-end and back-end manufacturing facilities and specialty niche players operating small wafer fabs or subcontracting wafer production.

With the continuing development of new semiconductor applications and increasing demands of system designers for more integrated systems-oriented products, semiconductor manufacturers must continually improve their core technology and manufacturing competencies. In addition, the increasing diversity and complexity of semiconductor products, the demands of technological change, and the costs associated with keeping pace with industry developments have contributed to the growth of cooperation in product design and development and manufacturing alliances with customers as well as among semiconductor suppliers. Alliances with customers provide the manufacturer with valuable system and application know-how and access to markets for key products, while allowing the manufacturer's customers to share some of the risks and benefits of product development. Customers also gain access to the manufacturer's process technologies and manufacturing infrastructure. Alliances with other semiconductor manufacturers permit costly research and development and manufacturing resources to be shared to mutual advantage for joint technology development.

The Company believes that as part of the new "e-society", major new growth segments in the semiconductor market are developing, in particular for digital multimedia, networking and wireless communications applications. New applications have emerged, such as set-top boxes, digital television, digital video discs, digital mobile computing and communications, smartcards, automotive multimedia, digital still imaging and mass storage, that are requiring new and rapidly evolving semiconductor technologies. The Company believes many of these new products will require a high level of semiconductor integration, combining various technologies such as bipolar, CMOS, DMOS and memory, on a single chip.

To compete as a leading player for system-on-chip applications, management believes that it is necessary to combine (i) a broad and diverse customer base; (ii) system knowhow; (iii) strategic alliances; (iv) broad range of product technologies; (v) world-class volume manufacturing; (vi) software expertise; (vii) design methodology; (viii) broad IP portfolio; and (ix) powerful engines DSP and microcontroller cores and that the Company possesses all the aforementioned ingredients. The Company also believes that its independence from any single system group manufacturer is an advantage for STMicroelectronics in working closely with customers in different market segments.

Strategy

The key elements of the Company's strategy are set forth below.

Broad Product Portfolio. The Company offers a diversified product portfolio and develops products for a wide range of market applications to reduce its dependence on any single product, industry or application market. Within its diversified portfolio, the Company has focused on developing products that exploit its technological strengths in creating customized, system-level solutions with substantial analog and mixed-signal content. Products include differentiated ICs (which the Company defines as being its dedicated products, semicustom devices and microcontrollers) and analog ICs (including mixed-signal ICs), the majority of which are also differentiated ICs. As a leading provider of differentiated ICs, the Company has developed close relationships with customers, resulting in early knowledge of their evolving requirements and opportunities to access their markets for other products. Differentiated ICs, which are less vulnerable to competitive pressures than standard commodity products, accounted for approximately 63% of the Company's net revenues in 1999 compared to approximately 62% in 1998. The Company also targets applications that require substantial analog and mixed-signal content and can exploit the Company's system level expertise. Analog ICs accounted for approximately 51% of the Company's 1999 net revenues compared to approximately 50% in 1998, while discrete devices accounted for approximately 12% of the Company's net revenues in 1999 compared to approximately 13% in 1998. In general, differentiated ICs, in particular analog ICs, have experienced less volatility in sales growth rates and average selling prices than the overall semiconductor industry.

However, as a broad range supplier, the Company can also benefit from selling standard products. Consistent with this view, the Company has established the Gold Standard program to promote the sale of certain standard products meeting specified quality, cost and lead-time criteria. The related initiatives include worldwide advertising, promotional task forces in all regions, special distribution initiatives and worldwide training of sales and marketing personnel.

Total standard products (including all nonvolatile memories, discrete devices, and all standard logical and linear ICs) represented approximately 37% of the Company's sales in 1999 and, in management's view, increased sales of these products represent an opportunity to improve cash flow because the manufacture of standard products requires moderate capital investment.

Broad Range of Process and Design Technologies. The Company intends to continue to exploit its expertise and experience with a wide range of process and design technologies to develop its capabilities. The Company is committed to continuing to increase research and development expenditures in the future as well as continuing to develop alliances with other semiconductor companies and suppliers of software development tools. Technological advances in the areas of transistor performance and interconnection technologies are being developed through the Company's logic products and semicustom devices. The Company continually works with key suppliers to develop advanced and standardized design methodologies for its CMOS processes as well as libraries of macrofunctions and megafunctions for many of its products, and is focusing on improving its concurrent engineering practices to better coordinate design activities and reduce overall time-to-market. It is also working closely with many of its key suppliers to develop easy-to-use design tools for specific applications. Alliances with other semiconductor manufacturers are generally designed both to permit costly research and development and manufacturing resources to be shared to mutual advantage for joint technology development and to reduce time to market.

Leading Global Customer Base with Focus on Strategic Alliances. The Company works with its key customers to identify evolving needs and new applications and to develop innovative products and product features. The Company also seeks to use its access to key customers as a supplier of application-specific products to establish itself as a supplier across a broad range of products. Alliances with customers allow the Company and its customers to share some of the risks of product development and the customers to gain access to the Company's process technologies and manufacturing infrastructure. The Company has targeted alliances with customers in each of its key application markets of telecommunications, automotive, consumer and computer. It has established alliances with, among others, Alcatel, Bosch, Hewlett-Packard, Marelli, Nortel Networks, Pioneer, Seagate, Thomson Multimedia and Western Digital. In establishing these alliances, the Company has also aimed to cover its key geographical markets.

Integrated Presence in Key Regional Markets. The Company has consistently sought to develop a competitive advantage by building an integrated presence in each of the world's three major economic zones: Europe, Asia and North America. An integrated presence means having manufacturing, design, sales and marketing capabilities in each region, in order to ensure that the Company is well positioned to anticipate and meet its customers' business requirements in local markets. Therefore, the Company has established front-end manufacturing facilities in the United States (in Phoenix, Carrollton and Rancho Bernardo), in Europe (Agrate, Castelletto, Catania, Crolles, Rennes, Rousset and Tours) and in Asia (Singapore); the more labor-intensive back-end facilities have been located in Malaysia, Malta, Morocco, Singapore and China, enabling the Company to take advantage of favorable production costs (particularly labor costs). With major design centers and local sales and marketing groups within close proximity of key customers in each region, the Company believes it can maintain strong relationships with its customers. STMicroelectronics intends to continue to build its integrated local presence in each region where it competes in its efforts to better serve its customers and to develop an early presence in potential high growth markets such as China, where the Company has both a back-end facility and a design center, and India, where the Company has a design center.

Balanced Sales by Application and Region in High Growth Market Segments. The Company has developed a strong product portfolio across major application markets including computer peripherals, wireless communications, digital consumer electronics, smartcards, automotive and power management. While the Company is consolidating its position in its established high volume businesses, including switching, engine management, car safety, traditional analog TV, VCR, computer peripherals, power and industrial and consumer appliances, it has also been investing research and development and design resources to develop the next generation of high growth applications, such as smartcards, portable computing, digital consumer (DVD, new generations of set-top boxes, digital TV, digital cameras and MP3 digital music players), wireless communications (digital cellular phones), data transport (fiber optic ICs and voice over IP), Internet (xDSL), new automotive products (car multimedia) and new generations of mass storage devices. The Company also maintains a geographically diverse customer base across a broad range of market applications.

Pervasive TQEM Culture. STMicroelectronics is fostering a corporate-wide TQEM culture that defines a common set of objectives and performance measurements for employees in all geographic regions, at every stage of product design, development, production and consignment for all product lines. TQEM in STMicroelectronics is based on five key principles: management commitment, employee empowerment, continuous improvement, management by fact and customer focus. TQM has become an integral part of the STMicroelectronics' culture and it is designed to develop a self-directed work force with a common set of values, objectives and problem-solving processes. Since 1987, the Company has continually improved average AIQ (electrical) status levels. Most of the Company's manufacturing facilities have been certified to conform to ISO international quality standards and Eco Management and Audit Scheme ("EAMS"). Several major customers, including Hewlett-Packard, Nokia, Sharp, DaimlerChrysler and Sanyo have recognized STMicroelectronics' commitment to quality and have honored the Company with quality awards in the recent past. In 1999, several prestigious awards were accorded to the Company's regional subsidiaries, underscoring its long-standing commitment to business excellence: the prestigious Malcolm Baldrige National Quality Award in the U.S., the Singapore Quality Award, the Moroccan National Quality Award, and the EPA Climate Protection Award (US). These, together with the Company's previous honors

- the Malaysian Prime Minister Quality Award, the Malta Quality Award and the European Quality Award for Business Excellence in the category of large businesses awarded in 1997 by the European Foundation for Quality Management - illustrate the success of the Company's unified Total Quality and Environmental Management philosophy on four continents.

Pioneer in System-on-chip. Since its inception, the Company has leveraged its know-how of a broad range of industries to integrate different system functions on a single chip, pionneering the trend towards system evolutions on silicon and superintegration. A modular approach is being utilized to develop options to the main manufacturing processes and blocks of intellectual property; strategic partnerships are the main lever for acquisitions of the system know-how to be embedded on the chip. The Company currently supplies highly integrated products in all its main applications, and particularly in high volume domains such as hard disk drives (disk controllers), set-top boxes and Digital video drives.

To date, the Company's growth has been attributable primarily to internal growth. However, in 1999, the Company completed the acquisition from Adaptec of Peripheral Technology Solutions Group which is specialized in the design of products for the hard disk drive market, as well as the purchase of Vision Group, a leading designer and supplier of CMOS sensors. In 1999, the Company also acquired Arithmos, a company which designs controller ICs for flat panel displays and LCD monitors. In June 2000, the Company also acquired from Nortel Networks its semiconductor business and in particular its manufacturing activity in Ottawa. Furthermore, the Company may, from time to time, consider making selected acquisitions that the Company believes would complement or expand its existing business. Announcements concerning potential acquisitions could be made at any time. Acquisitions involve a number of risks that could adversely affect the Company's operating results, including: (i) the diversion of management's attention; (ii) the assimilation of the operations and personnel of the acquired companies; (iii) the assumption of potential liabilities, disclosed or undisclosed, associated with the business acquired, which liabilities may exceed the amount of indemnification available from the seller; (iv) the risk that the financial and accounting systems utilized by the business acquired will not meet the Company's standards; (v) the risk that the businesses acquired will not maintain the quality of products and services that the Company has historically provided; (vi) the inability to attract and retain qualified management for the acquired business; and (vii) the inability of the Company to retain customers of the acquired entity. There can be no assurance that (a) the Company will be able to consummate future acquisitions on satisfactory terms, if at all, (b) adequate financing will be available for future acquisitions on terms acceptable to the Company, if at all, or (c) any operations acquired will be successfully integrated or that such operations will ultimately have a positive impact on the Company. See "Item 9: Management's Discussion and Analysis of Financial Condition and Results of Operations--Liquidity and Capital Resources."

Customers and Applications

STMicroelectronics designs, develops, manufactures and markets over 3,000 main types of products that it sells to approximately 800 direct customers. The Company also sells its products through distributors. To many of its key customers the Company provides a wide range of products, including dedicated products, discrete devices, memory products and programmable products. The Company's position as a strategic supplier of application-specific products to certain customers fosters close relationships that provide it with opportunities to supply such customers' requirements for other products, including discrete devices, programmable products and memory products.

The following table sets forth certain of the Company's significant customers and certain applications for its products:

Telecommunications	5				
Customers:	Alcatel Bosch	Italtel Lucent Technologies			
Applications:	Ericsson Motorola Central office switching systems Digital cellular telephones Wireless networking (Bluetooth)		Philips Siemens Telephone terminals (corded and cordle: Internet access (xDSL) Data transport (routing, switching for electronic and optical networks)		
Computer Systems Customers:	ACER	Creative Technology	Maytor	Socrato	
customers.		Hewlett-Packard	Olivetti	Seagate 3D Labs	
	Compaq	IBM	Quantum	Western Digital	
		Logitech	Samsung	-	
Applications:	Data storage		Webcams		
	Monitors and display	S	Printers		
	Graphics		Imaging Power management		
Automotive					
Customers:	Bosch	Denso		Valeo	
	DaimlerChrysler	Kenwood		VDO	
	Delphi	Marelli	Siemens	Visteon	
Applications:	Airbags		Engine managemen injection)	t systems (ignition and	
	Antiskid braking sys	tems	Multiplex wiring	kits	
	Car radio		Global positioni		
	Body and chassis ele	ctronics	Car multimedia		
Consumer Products					
Customers:	Bose Corporation	Luckv Goldstar	Pace	Scientific Atlanta	
		Matsushita		Sony	
	2	Nokia	Pioneer	Thomson Multimedia	
	Kenwood		Samsung		
Applications:	Audio processing (CD	, DVD, Hi-Fi)	DVDs		
	Digital cameras Digital music player	a	Set-top boxes Analog TVs		
	Digitial TVs	5	VCRs		
	2				
Industrial and Oth					
Customers:	Astec			Schneider	
		Giescke & Devrient Liton	2	SCI Siemens	
	Delta	Nagra	Schlumberger		
Applications:	Battery chargers		Motor controller		
	Smartcards ICs		Power supplies		
		n and control systems	Switch mode powe	r supplies	
	Intelligent power				
	switches	mp hallacta)			
	Lighting systems (la	mp pallasts)			

In 1999, the Company's largest customer, Nokia, represented approximately 11% of the Company's net revenues. No other single customer accounted for more than 10% of the Company's net revenues. Sales to the Company's top ten customers accounted for approximately 45% of the Company's net sales in 1999 (43% in 1998). The Company has several large customers, certain of whom have entered into strategic alliances with the Company. Many of the Company's key customers operate in cyclical businesses and have in the past, and may in the future, vary order levels significantly from period to period. In addition, as in 1998, approximately 18% of the Company's net revenues in 1999 were made through distributors. There can be no assurance that such customers or distributors, or any other customers, will continue to place orders with the Company in the future at the same levels as in prior periods. The loss of one or more of the Company's customers or distributors, reduced bookings or product returns by its key customers or distributors, could adversely affect the Company's operating results. In addition, in a declining market the Company has been in the past and may in the future be driven to lower prices in response to competitive pressures and may expect a higher number of order cancellations, particularly by distributors and for commodity products.

Products and Technology

STMicroelectronics designs, develops, manufactures and markets a broad range of products used in a wide variety of microelectronic applications, including telecommunications systems, computer systems, consumer goods, automotive products and industrial automation and control systems. The Company's products include standard commodity components, full custom devices, semicustom devices and ASSPs for analog, digital and mixed-signal applications. Historically, the Company has not produced DRAMs or x86 microprocessors.

In 1999, the Company had four principal products groups, Telecommunications Peripherals and Automative, Consumer and Microcontroller, Memory Products and Discrete and Standard ICs. Certain information with respect to revenues for these product groups for 1999 is shown in the table below. For a breakdown of the Company's net revenues by Group and geography for the last three years, see "Item 9: Management's Discussion and Analysis of Financial Condition and Results of Operations--Results of Operations." Revenues for future periods will be calculated according to the new groups described below.

			1999 Group Revenues by Region				
		Total (% of total		(percenta	ge of Group ne	t revenues)	
	Total (in millions)	(* OI LOCAI net revenues)	Europe	North America	Asia Pacific(1)	Region Five	Japan
Telecommunications, Peripherals and Automotive Consumer and Microcontroller	. \$ 2,305.5	45.6%	31.0%	23.3%	38.7%	2.6%	4.4%
Memory Products Discrete and Standard ICs	. 835.9	17.4 16.5 18.4	32.4 46.6 38.5	29.6 18.8 20.7	29.7 20.9 34.6	5.0 2.5 4.6	3.3 11.2 1.6

 Many of the products sold in the Asia Pacific region are sold to U.S.-based original equipment manufacturers located in the region.

At the beginning of 1999, the Company implemented organizational changes to better orient its products groups to end use applications. Its products are now organized into the following principal product groups: Telecommunications, Peripherals and Automotive (formerly Dedicated Products), Consumer and Microcontroller (formerly Programmable Products), Memory Products and Discrete and Standard ICs. As part of its activities outside the principal product groups, the Company also has a New Ventures Group, which identifies and develops new business opportunities to complement the Company's existing businesses, and a Subsystem Product Group, which produces subsystems for industrial and other applications.

Telecommunications, Peripherals and Automotive Groups

The Dedicated Products Groups was reorganized into the Telecommunications Group, which has two applications divisions, and the Automotive and Peripherals Group, which has four divisions. The video products which formed part of the former Dedicated Products Group are today encompassed within the Consumer and Microcontroller Groups. The Groups also have two support divisions (i) digital signal processing and microcontrollers cores and (ii) digital and mixed analog/digital semi-custom. The Telecommunications, Peripherals and Automative Groups are responsible for the design, development and manufacture of application-specific products using advanced bipolar, CMOS, BiCMOS mixed-signal and power technologies as well as mixed analog/digital semicustom devices. The Groups offer complete system solutions to customers in several application markets. All of the Groups' products are ASSPs, full-custom or semicustom devices that may also include DSP and micro-controllers cores. The Telecommunications, Peripherals and Automotive Groups work closely with customers to develop application-specific products using STMicroelectronics' technologies and manufacturing capabilities. The breadth of the Groups' customer and application base provides it with a source of stability in the cyclical semiconductor market. In addition, the Company's position as a strategic supplier of application-specific products fosters close relationships that provides them with opportunities to supply such customers' requirements for other products, including discrete devices, microcontrollers and memory products.

The Telecommunications, Peripherals and Automotive Groups particularly emphasize dedicated ICs for automotive, computer peripherals and industrial application segments, as well as for communication, computing and networking application segments.

The Telecommunications Group has two divisions:

- (i) Wireline Telecommunications Products. The Company's telecommunications products are used in telephone sets, modems, subscriber line interface cards (SLICs) for digital central office switching equipment and high speed electronic and optical communications networks. During 1999, significant developments included the introduction of a modem chip set for Asymmetric Digital Subscriber Loop (ADSL) and the delivery of approximately 1,000,000 full-rate ADSL chip sets to leading equipment manufacturers. The Company also announced a joint development program with Virata for a complete ethernet/USB reference design for ADSL. The Company also demonstrated a chip set jointly developed with Telia Research AB for a Very high bit-rate Digital Subscriber Loop (VDSL), a system supporting broadband communications facilities for interactive multimedia Internet access, video-on-demand, and other advanced services, and which will be compatible with DMT-ADSL currently on the market. In early 2000, the Company acquired an equity interest of approximately 16% in Netergy Networks, (formerly 8x8) to reinforce its position in VoIP.
- Wireless Telecommunications Products. In wireless (ii) telecommunications, the Company focuses its product offerings on cellular phones, pagers and wireless local loop applications, serving the major OEMs in each of these areas with differentiated ICs. In cellular phones, the Company is supplying products for both the analog and digital market segments (including GSM and CDMA) and reinforcing its leading position in energy management (91 million phones equipped in 1999), audio CODEC (44 million phones equipped in 1999), and RF/IF ICs (83 million phones equipped in 1999). The Company has gained experience and know-how with the major silicon components of cellular phone applications, and is developing system and software capabilities to provide full solutions for specifically targeted applications, particularly in the baseband processor, where in 1999 the Company shipped approximately 7 million units and pursued the development of its new ST100 DSP core which it has licensed to Alcatel Microelectronics for various applications including VoIP.

The Peripherals and Automotive Group has four divisions:

- Data Storage. STMicroelectronics produces ICs for several data (i) storage applications, in particular disk drives with advanced solutions for read and write digital channels, controllers, host interfaces, digital power processing and micromachinery. The group is working actively on super-integrating these macro-functions into system chip solutions. In 1999, the Company completed its acquisition from Adaptec of Peripheral Technology Solutions Group which is specialized in the design of products for the hard disk drive market. The acquisition complements the Company's activities with respect to (i) product line, giving the Company access to leading disk controller products and know-how, (ii) design teams, contributing Adaptec's designers with CMOS read channel product design expertise, (iii) geography, providing the Company a base in Silicon Valley, and (iv) customer base, adding customers in Asia Pacific and Japan. The Company has developed a one-chip solution for the optical storage market (DVD ROM) that will be launched in 2000.
- Printers. STMicroelectronics is focusing on inkjet printer components and is an important supplier of pen chips, motor drivers, head drivers, high performance photo quality applications

and digital color copiers. The Company is an important partner of Hewlett-Packard for technology development and manufacturing and is currently developing printer system on chip platforms.

(iii) Audio and Automotive Products. STMicroelectronics' audio products include audio power amplifiers, audio processors and graphic equalizer ICs. In the second half of 1999, the Company launched a digital music player platform for MP3, with more than one million units shipped in the first three months of 2000. The Company's automotive products include alternator regulators, airbag controls, antiskid braking systems, ignition circuits, injection circuits, multiplex wiring kits and products for body and chassis electronics, engine management, instrumentation systems and car multimedia. The Company believes it is the leader in the manufacturing of car radio components. The Company is currently developing solutions for global positioning systems (GPS) and multi-media in the car. In 1999, the Company signed a strategic alliance for car entertainment systems with Pioneer Electronics of Japan. Due to its super-integration know-how, the Company has successfully expanded its presence beyond Europe to the United States and Japan, further accessing key customers such as Mitsubishi and Denso.

In 1999, the Company achieved volume production and gained design wins for 8.16 and 32 bit automotive graded embedded Flash microcontrollers in 0.5, 0.35 and 0.18 micron technologies.

(iv) Industrial and Power Supplies. STMicroelectronics designs and manufactures products for industrial automation systems, lighting applications (lamp ballast), battery chargers and switch mode power supplies (SMPS). Its key products are power ICs for motor controllers and read/write amplifiers, intelligent power ICs for spindle motor control and head positioning in computer disk drives and battery chargers for portable electronic systems, particularly mobile telephone sets.

The Groups also have two support divisions (i) digital signal processing and microcontroller cores and (ii) digital and mixed analog/digital semicustom. These two divisions are centers of excellence to develop key competences in the field of semicustom (digital and analog) as well as in DSP and microcontrollers cores. The Company is currently developing superintegrated solutions using its broad range of technologies (CMOS, BiCMOS, BCD) and its expertise in microcontrollers/DSP cores, dedicated IC megacells and embedded memory capability for hard disk drive applications. The same methodology is being applied to develop ICs for other computer peripherals such as monitors and inkjet printers.

Consumer and Microcontroller Groups

The Consumer and Microcontroller Groups are the successors to the Programmable Products Group and are responsible for the design, development and manufacture of microcomponents (including microcontrollers and digital signal processors), digital semicustom devices, graphic controllers and MPEG decoder ICs and image processing semicustom devices for many diverse products targeted at high growth digital applications, including information technology, automotive and multimedia.

The Consumer and Microcontroller Groups are divided into the Consumer Group and the Microcontrollers Group, each further divided into several divisions.

The Consumer Group has four divisions:

Digital Video. Emerging digital video technologies offer a (i) number of advantages over traditional analog video, including the ability to compress video data for transmission and storage, to transmit and reproduce video data without perceptible image degradation and to randomly access and edit video data. In 1999, the digital consumer market grew mainly due to the strong growth of digital TV satellite broadcasting in the United States and Western Europe. This division delivers large volumes of MPEG decoder ICs suitable for several applications, including set-top boxes (cable, satellite and terrestrial), DVDs and digital TVs. The majority of these products implement the MPEG2 standard. In 1999, STMicroelectronics reached volume production of the STi55 Omega chip, a family of highly integrated devices that combine an MPEG2 audio/video decoder with a 32-bit microprocessor and other functions to create a complete set-top box or DVD back-end

section on a single chip. In the set-top box business, the Company is preparing solutions for interactive and high-end boxes based on the ST40 advanced microcontroller and the STG4003 3D graphic ships, a product being co-developed with Imagination Technologies, a U.K. company. In the DVD business, the Company has started developing a one chip dip DVD and an MPEG2 encoder that will provide recording capability.

- (ii) Consumer Broad Band Division. This division develops chip sets for the front-end section of all major digital video applications. For example, this division designs and manufactures semi-custom products for data input from compact disc-audio and digital video players, digital broadcast and data exchange on cable as well as for the IEEE 1394 serial digital interface. The division provides Front-end solutions for satellite and cable set-top boxes in relation to which it has entered into partnership agreements with Netergy Networks of the U.S. in the field of VoIP and Scientific Atlanta of the U.S. in the field of digital cable modem.
- (iii) TV, Monitor and Camera Division. This division targets analog and digital television, video camera recorders, monitors and flat panel displays and image capturing and transmission. In 1999, the Company finalized the acquisition of Vision Group plc, a U.K. company based in Edinburgh, Scotland, which has developed a technology for production of CMOS sensors. CMOS sensors significantly reduce the cost of digital cameras; it is thus possible to produce the principal features of a camera on a single IC, which is significantly cheaper than using a multi-component chip set based on traditional Charge Coupled Devices (CCD) technology. The company is actively pursuing applications in webcam and digital still camera business and has started a research and development program for mobile phone cameras. The Company is today supplying manufacturers of High Definition Television (HDTV) and plans to pursue other business opportunities for the next generation of products.
- (iv) Graphics Products. In early 1999, the Company entered into a partnership agreement with Imagination Technologies, (formerly Videologic) of the United Kingdom for developing the next generation 3D accelerator aimed at the PC and digital consumer market. The first prototypes are expected in the middle of 2000.

The Microcontroller Group has one division and two support groups:

(i) Microcontroller Division. This division provides competitive, high-volume 8-bit microcontrollers for all major application segments and 16-bit DSP for the mass market. This family of products has been developed with a wide portfolio of processes capable of embedding nonvolatile memories such as EPROM, EEPROM and flash memories.

Within the support groups, the Microcontroller Core Development group develops 32- and 64-bit microcontroller cores. Current products include the successful ST20 and ST40 products. The Company has entered an agreement with Hitachi to co-develop a 64-bit microcontroller core (ST50) based on Hitachi original Super H architecture and STMicroelectronics know-how in 64-bit microprocessors for interactive set-top boxes, digital video products, car multimedia systems and other consumer oriented products.

The Microcontroller Development Tools group is concerned with software and hardware development tools for microcontroller cores and with software methodology for the microcontrollers and application divisions.

Memory Products Group

The Memory Products Group designs, develops and manufactures a broad range of semiconductor memory products but does not produce DRAMs. According to published industry data, on the basis of 1999 revenues, STMicroelectronics was the leading producer of EPROMs, with a 48.0% market share, and the second leading supplier of EEPROMS.

According to published industry data, the total market for memory devices in 1999 was approximately 32.3 billion including DRAMs (64.1%), SRAMs (14.9%) and nonvolatile memories (21%).

The Company's Memory Products Group is organized into the following divisions: (i) EPROMs; (ii) flash memories; (iii) smartcard products; (iv) EEPROMs and application-specific memories; and (v) NVRAMs.

EPROMs. STMicroelectronics produces a broad range of EPROMs, from 16 Kbit to 32 Mbit. According to published industry data, STMicroelectronics consolidated its world's leading market position for EPROMS in 1999, with revenues of \$206 million or approximately 48% of worldwide EPROM sales. The Company currently produces EPROMS using 0.40 micron CMOS technologies.

The EPROM market is relatively mature, and worldwide sales declined in 1999 according to published industry data. The Company has succeeded in maintaining its market leadership because of its EPROM technology, which has allowed the Company to build one of the broadest product portfolios currently offered in the market. At the same time, this technology has permitted continuous improvement of manufacturing yields and reduction of die size, giving the Company an advantageous cost position. Efficient manufacturing in its Singapore assembly plant together with STMicroelectronics' sales and distribution channels have contributed to the exploitation of the Company's technological advantage.

Flash Memories. The Company currently supplies single voltage (down to 1.8 volt) NOR cell structure flash memory products up to 32 Mbit, and is introducing into production a family of multi-level flash memories operating at 3.0 volt and manufactured using 0.18 micron technology. The market for flash memories is growing fast, according to published industry data, driven by cellular phones and digital consumer applications growth. The Company aims to increase market share in flash memories by continuing investments in advanced process technologies, new products development and state-of-the-art manufacturing facilities in order to address a market which, according to published industry data, is growing fast, driven by a broad range of high volume applications such as cellular phones, networking and set top boxes. The Company is also leveraging its strong network of customer alliances to enter several long-term agreements to supply flash memories.

Smartcard Products. Smartcards are credit card-like devices containing integrated circuits that store data and provide an array of security capabilities. They are used in a wide and growing variety of applications, including public pay telephone systems (primarily in France and Germany), cellular telephone systems and bank cards (primarily in Europe), as well as pay television systems (primarily in the United States, United Kingdom and France). Other applications include medical record applications, card-access security systems, toll-payment secure transactions over the Internet and ID cards applications. According to market estimates from independent analysts, the Company's market share for microcontroller-based smartcard ICs in units was 46% in 1999. On this basis, the Company believes to have maintained its leading position in this market segment. In 1999, the Company achieved ISO 15408 certification for its ST 19 platform of microcontroller-based smartcard, continuing its leadership in terms of independent security certification. The Company also recently announced a 32 bit RISC microcontroller for multi-application cards optimized for fast and secure execution of JavaCard(TM) applets. The Company is currently developing biometric solutions based on fingerprint recognition.

EEPROMs and Application-Specific Memories. The Company offers serial EEPROMs up to 512 Kbit and parallel EEPROMs up to 1 Mbit. Serial EEPROMs are the most popular type of EEPROMs and are generally used in computer, automotive and consumer applications. Parallel EEPROMs account for a smaller portion of the EEPROM market, being used mainly in telecommunications equipment. The Company intends to work closely with its key customers and strategic allies to identify and develop added-value application-specific memories. In 1999, the sales of this division represented, according to trade association data, approximately 23.2% of the world market for EEPROM and other nonvolatile memory compared to approximately 16.9% in 1998.

NVRAMS. The Company focuses on producing nonvolatile SRAMs (battery back-up) used in computers and telecommunications equipment. According to independent market analysts, the Company was the world's second largest supplier of NVRAMs in 1999, with an estimated market share of 26.0%.

Discrete and Standard ICs Group

The Discrete and Standard ICs Group designs, develops and manufactures discrete power devices, power transistors, standard linear and logic ICs, and RF products. According to published industry data, based on 1999 revenues, STMicroelectronics is the second supplier of thyristors and triacs and among the leading suppliers of power transistors, rectifiers, voltage regulators and amplifiers. Based on trade association data, the Company believes it is the leader in protection diodes.

The Group's discrete and standard products are manufactured using mature technological processes. Although such products are less capital intensive than the Company's other principal products, the Company is continuously improving product performance and developing new product features. The Group has a diverse customer base, and a large percentage of the Group's products are sold through distributors.

Discrete Power Devices. STMicroelectronics manufactures and sells a variety of discrete power devices, including rectifiers, protection devices and thyristors (SCRs and triacs). The Company's devices are used in various applications, including in particular telecommunications systems (telephone sets, modems and line cards), household appliances and industrial systems (motor control and power control devices). More specifically, rectifiers are used in voltage converters and voltage regulators, protection devices are used to protect electronic equipment from power supply spikes or surges, and thyristors are used to vary current flows through a variety of electrical devices, including lamps and household appliances. The Company offers a highly successful range of standard products built with its proprietary Application Specific Discretes (ASDTM) technology, which allows a variety of discrete structures to be merged into a single device optimized for specific applications such as EMI filtering for cellular phones. The Company has recently started development of electronic devices integrating both passive and active components on the same chip (IFAD: Integrated Passive and Active Devices).

Power Transistors. STMicroelectronics designs, manufactures and sells power transistors, which (like the Company's discrete power devices) operate at high current and voltage levels in a variety of switching and pulse mode systems. The Company has three power transistor divisions: bipolar transistors, power MOSFETs (metal-oxide-silicon field effect transistors) and new power transistors such as IGBTs.

The Company's bipolar power transistors are used in a variety of high-speed, high-voltage applications, including SMPS (switch mode power supply) systems, television/monitor deflection circuits and lighting systems. According to published industry data, on the basis of 1999 revenues, STMicroelectronics is among the leading suppliers of bipolar transistors, including RF power transistors.

The Company also offers a family of VIPower (vertical integration power) products, as well as omnifets and application-specific devices. VIPower products exhibit the operating characteristics of power transistors while incorporating full thermal, short circuit and overcurrent protection and allowing logic level input. VIPower products are used in consumer goods (lamp ballasts) and automotive products (ignition circuits, central locking systems and transmission circuits). Omnifets are power MOSFETs with fully integrated protection devices that are used in a variety of sophisticated automotive and industrial applications. Application-specific devices are semicustom ICs that integrate diodes, rectifiers and thyristors on the same chip, thereby providing cost-effective and space-saving components with a short design time.

Standard Logic and Linear ICs. The Company produces a variety of bipolar and HCMOS logic devices, including clocks, registers, gates and latches. Such devices are used in a wide variety of applications, including increasingly in portable computers, computer networks and telecommunications systems. The Company also offers standard linear ICs covering a variety of applications, including amplifiers, comparators, decoders, detectors, filters, modulators, multipliers and voltage regulators.

Radio Frequency Products. The Company supplies components for RF transmission systems used in television broadcasting equipment, radar systems, telecommunications systems and avionic equipment. The Company is targeting new applications for its RF products, including two-way wireless communications systems (in particular, cellular telephone systems) and commercial radio communication networks for business and government applications.

Sales, Marketing and Distribution

In 1999, the Company derived approximately 82% of its revenues from sales directly to customers through its regional sales organizations (compared to approximately 82% in 1998) and 18% of its net revenues from sales through distributors (compared to approximately 18% in 1998). The Company operates regional sales organizations

in Europe, North America, the Asia Pacific region, Japan and, since January 1, 1998, in "Region Five" which includes emerging markets such as South America, Africa, Eastern Europe, the Middle East and India. In 1999, approximately 36.3% of the Company's revenues originated in Europe (compared to approximately 41.6% in 1998), while 22.9% originated in the Americas (compared to approximately 22.1% in 1998), 32.8% originated in the Asia Pacific region (compared to approximately 29.4% in 1998), 4.7% originated in Japan (compared to approximately 4.3% in 1998) and 3.3% originated in Region Five (compared to approximately 2.6% in 1998). In 1999, the Company's largest customer, Nokia, represented approximately 11% of the Company's net revenues. No other single customer accounted for more than 10% of the Company's net revenues. Sales to the Company's top ten customers accounted for approximately 45% of the Company's net sales in 1999 (43% in 1998).

The European region is divided into five businesses units: automotive, communities, consumer and computers, industrial and smartcards, six geographically configured units to cover mid-sized OEM customers (France and the Benelux, Central Europe, Northern Europe, Southern Europe, Scandinavia and Finland), and six regions (United Kingdom, France, Central Europe, Southern Europe, Scandinavia and Finland) addressed through distributors.

In North America, the sales and marketing team is organized into five business units that are located near major centers of activity for either a particular application or geographic region: automotive (Detroit, Michigan), industrial and consumer (Chicago, Illinois), computer and peripheral equipment (San Jose, California and Longmont, Colorado following the acquisition of Adaptec), communications (Dallas, Texas) and distribution (Boston, Massachusetts). Each business unit has a sales force that specializes in the relevant business sector, providing local customer service, market development and specialized application support for differentiated system oriented products. This structure allows STMicroelectronics to monitor emerging applications, to provide local design support, and to identify new products for development in conjunction with the various product divisions as well as to develop new markets and applications with its current product portfolio. A central product marketing operation in Boston provides product support and training for standard products for the North America region, while a logistics center in Phoenix supports just-in-time delivery throughout North America. In addition, a comprehensive distribution business unit provides product and sales support for the nationwide distribution network.

In the Asia Pacific region, sales and marketing is organized by country and is managed from the Company's regional sales headquarters in Singapore. The Company has sales offices in Taiwan, Korea, China, Hong Kong, Malaysia, Thailand and Australia. The Singapore sales organization provides central marketing, customer service, technical support, shipping, laboratory and design services for the entire region. In addition, there are design centers in Taiwan, Korea, Hong Kong and Shenzhen.

In Japan, the large majority of the Company's sales are made through distributors, as is typical for foreign suppliers to the Japanese market. However, the Company's sales and marketing engineers in Japan work directly with the customers as well as with the distributors to meet customers' needs. The Company provides marketing and technical support services to customers through sales offices in Tokyo and Osaka. In addition, the Company has established a design center and application laboratory in Tokyo. The design center designs custom ICs for Japanese clients, while the application laboratory allows Japanese customers to test STMicroelectronics' products in specific applications.

Region Five was created as of January 1, 1998 and includes emerging markets such as South America, Africa, Eastern Europe, the Middle East and India. Prior to that time, these markets had been covered, where appropriate, by the other existing sales and marketing organizations. Region Five also includes the design center in India, which employs 428 people in a wide range of activities. The Company intends to increase its focus on the new sales and marketing region to enhance its presence in these new markets.

The Company is pursuing the Gold Standard program, a long-term commitment to excellence in standard products. The program consists of manufacturing and offering standard products at the same price level as the market but with a superior level of quality, service and lead time. The related initiatives included worldwide advertising, promotional task forces in all regions, special distribution initiatives and worldwide training of salespeople and marketing personnel. In 1999, the Company launched the "Mare Nostrum" program for Europe which involves (i) focusing on customers and applications, (ii) using the Company's standard product portfolio

through technical support, (iii) product marketing and sales to develop an application kit approach, (iv) encouraging a one stop shopping approach, as well as (v) improving market coverage through a customer interface team.

Each of the five regional sales organizations operate dedicated distribution organizations. To support the distribution network, STMicroelectronics operates logistic centers in Saint Genis, France; Phoenix, Arizona; and Singapore, and has made considerable investments in warehouse computerization and logistics support.

The Company also uses distributors and representatives to distribute its products around the world. Typically, distributors handle a wide variety of products, including products that compete with STMicroelectronics' products, and fill orders for many customers. Most of the Company's sales to distributors are made under agreements allowing for price protection and/or the right of return on unsold merchandise. The Company recognizes revenues when it ships products to distributors. Sales representatives generally do not offer products that compete directly with the Company's products, but may carry complementary items manufactured by others. Representatives do not maintain a product inventory; instead, their customers place large quantity orders directly with STMicroelectronics and are referred to distributors for smaller orders.

Research and Development

Management believes that research and development is critical to the Company's success and is committed to increasing research and development expenditures in the future. Despite significant cost reductions following the Company's formation in 1987, 1990 and 1991 when the Company experienced losses, and during the recent industry downturn in 1997 and 1998, management did not reduce research and development spending. This commitment to research and development continues unabated, with the Company spending \$836 million or 16.5% of net revenues on research and development in 1999. The table below sets forth information with respect to the Company's research and development spending since 1994 (not including design center, process engineering, pre-production or industrialization costs):

	Year ended December 31,					
	1995	1996	1997	1998	1999	
			(in millions, exce	ept percentages)		
Expendituresas a percentage of net revenues	\$440.3 12.4%	\$532.3 12.9%	\$610.9 15.2%	\$689.8 16.2%	\$836.0 16.5%	

As a result of the history of the Company, approximately 81% of the Company's research and development expenses in 1999 were incurred in Europe, primarily in France and Italy. See "--Public Funding." As of December 31, 1999, approximately 5,350 employees were employed in research and development activities.

Central research and development units conduct research on the basic VLSI technologies, packaging technologies and design tools that are used by all product groups and the front-end manufacturing organization. STMicroelectronics central research and development activities are conducted in Crolles, France; Agrate, Italy; Carrollton, Texas; Phoenix, Arizona; Berkeley, California; and Noida, India. The central research and development units participate in several strategic partnerships. The Company's manufacturing facility at Crolles, France houses a research and development center that is operated in the legal form of a French Groupement d'interet economique ("GIE") pursuant to a partnership agreement in effect until the end of 1998 between the Company and France Telecom R&D, the research laboratory of France Telecom, an indirect shareholder of the Company. This center has developed submicron process technologies and is currently working on the development of 0.18 micron and future generation technologies, including copper interconnect, low k dielectric, silicon germanium, embedded RAMs and RF options. The Company and France Telecom R&D have decided to extend the GIE named Centre Commun de Microelectronique de Crolles to include as a member the Laboratoire d'Electronique de Technologie d'Instrumentation ("LETI"), a research laboratory of CEA-Industrie, one of the indirect shareholders of the Company. The objectives of the cooperation are to develop know-how on innovative aspects of VLSI technology evolution which can be transferred to industrial applications, and to address the development of innovative process steps and process modules to be used in sub 0.18 micron technologies with a view to preparing the technology to begin production of 12-inch wafers and associated wafer fabrication processes. The tripartite cooperation is intended to last until the end of 2002 The Company is also cooperating with Philips Semiconductors to jointly develop sub-micron CMOS logic processes in Crolles, France under an agreement which has been extended through

the year 2000. In April 2000, the Company announced its decision to build an advanced 12 inch wafer pilot line in Crolles, France, which will be funded and operated jointly with Philips Semiconductors.

A technical center in Noida, India, develops design software and CAD libraries and tools. At the Agrate, Italy site, the Company is developing nonvolatile memory technologies and programmable logic processes using a pilot line which is being upgraded to 8-inch with a capability of 0.25 micron and below. See "Item 13: Interest of Management in Certain Transactions." The Company has developed a wide network of cooperation with several universities in the United Kingdom (Bristol and Newcastle), Italy (Bologna, Catania, Milan, Pavia and Turin), France (Grenoble, Marseille, Toulouse and Tours), in the United States (Carnegie Mellon, Stanford, Berkeley and UCLA) and Singapore for basic research projects on design and process development.

In addition to central research and development, each operating division also conducts independent research and development activities on specific processes and products.

Public Funding

The Company participates in certain programs established by the European Commission and individual countries in Europe (France and Italy).

The main European programs in which the Company is involved include: (i) the Micro-Electronics Development for European Application ("MEDEA") cooperative research and development program, (ii) European Union research and development projects such as ESPRIT (European Strategic Programme for Information Technology) and RACE (Research and Development in Advanced Communications Technologies for Europe), (iii) national programs for research and development and industrialization in the electronics industries, and (iv) investment incentive programs for the economic development of certain regions. The pan-European programs are generally open to eligible companies operating and investing in Europe and cover a period of several years. In Italy, both electronics and economic development programs are open to eligible companies regardless of their ownership or country of incorporation.

The MEDEA cooperative research and development program was launched in June 1996 by the Eureka Conference and is designed to bring together many of Europe's top researchers in a 12,000 man-year program that will cover the period 1997-2000. The MEDEA program replaced the joint European research program called JESSI, which was a European cooperative project in microelectronics among several countries that covered the period 1988 through 1996 and involved more than 80 companies. In Italy, the Programma Nazionale per 1a Microelettronica has 18 participants, and various programs for intervention in the Mezzogiorno (southern Italy) are open to eligible companies, including non-European companies, operating in the region and regulated by specific laws. Italian programs often cover several years, but funding is typically subject to annual budget appropriation. In France, support for microelectronics is provided to over 30 companies manufacturing or using semiconductors. The amount of support under French programs is decided annually and subject to budget appropriation.

The Company has also entered into funding agreements with France and Italy which set forth the parameters of state support under certain national programs and require, among other things, compliance with European Commission ("EC") regulations and approval by EU authorities and annual and project-by-project reviews and approvals.

Funding of programs in France and Italy is subject to annual appropriation, and if such governments were unable to provide anticipated funding on a timely basis or if existing government-funded programs were curtailed or discontinued, such an occurrence could have a material adverse effect on the Company's business, operating results and financial condition. From time to time the Company has experienced delays in the receipt of funding under these programs. As the availability and timing of such funding are substantially outside the Company's control, there can be no assurance that the Company will continue to benefit from such government support, that funding will not be delayed from time to time, that sufficient alternative funding would be available if necessary or that any such alternative funding would be provided on terms favorable to the Company as those previously provided.

Public authority funding for research and development is reported in "Other Income and Expenses" in the Company's consolidated statements of income. See Note 17 to the consolidated audited financial statements for

each of the years in the three-year period ended December 31, 1999, including the Notes thereto (collectively, the "Consolidated Financial Statements") included elsewhere in this annual report on Form 20-F. Such funding has totaled \$55.3 million, \$63.5 million and \$60.4 million in the years 1997, 1998 and 1999, respectively. Public funding for industrialization costs (which include certain costs incurred to bring prototype products to the production stage) is offset against expenses in computing cost of sales, and has the effect of increasing the Company's gross profit. Such funding of industrialization costs has totaled \$6.2 million, \$3.1 million and \$2.4 million in 1997, 1998 and 1999, respectively. See Note 17 to the Consolidated Financial Statements. Government support for capital expenditures funding has totaled \$30.2 million, \$182.4 million and \$53.4 million in the years 1997, 1998 and 1999, respectively. Such funding has been used to support the Company's capital investment; while receipt of these funds is not directly reflected in the Company's results of operations, the resulting lower amounts recorded in property, plant and equipment reduce the level of depreciation recognized by the Company.

Low interest financing has been made available (principally in Italy) under programs such as the Italian Republic's Fund for Applied Research, established in 1968 for the purpose of supporting Italian research projects meeting specified program criteria. At year-end 1997, 1998 and 1999, the Company had \$63.7 million, \$49.4 million and \$48.8 million respectively of indebtedness outstanding under state-assisted financing programs at an average interest cost of 2.1%, 2.1% and 1.6%, respectively.

Due to change in legislation and/or review by the competent administrative or judicial bodies, there can be no assurance that government funding granted to the Company may not be revoked or challenged or discontinued in whole or in part, by any competent state or European authority, until the legal time period for challenging or revoking such funding has fully lapsed.

Intellectual Property

Intellectual property rights which apply to various Company products include patents, copyrights, trade secrets, trademarks and maskwork rights. STMicroelectronics owns more than 19,000 patents or pending patent applications corresponding to more than 11,000 original inventions, most of which have been registered in several countries around the world. In 1999, the Company filed 751 patent applications around the world. Management believes that its intellectual property represents valuable property and intends to protect the Company's investment in technology by enforcing all of its intellectual property rights. The Company has entered into several patent cross-licenses with several major semiconductor companies.

The Company's success depends in part on its ability to obtain patents, licenses and other intellectual property rights covering its products and their design and manufacturing processes. To that end, the Company has acquired certain patents and patent licenses and intends to continue to seek patents on its inventions and manufacturing processes. The process of seeking patent protection can be long and expensive, and there can be no assurance that patents will issue from currently pending or future applications or that, if patents are issued, they will be of sufficient scope or strength to provide meaningful protection or any commercial advantage to the Company. In addition, effective copyright and trade secret protection may be unavailable or limited in certain countries. Competitors may also develop technologies that are protected by patents and other intellectual property rights and therefore such technologies may be unavailable to the Company or available to the Company subject to adverse terms and conditions. Litigation, which could demand financial and management resources, may be necessary to enforce patents or other intellectual property rights of the Company.

Also, there can be no assurance that litigation will not be commenced in the future against the Company regarding patents, maskworks, copyrights, trademarks or trade secrets, or that any licenses or other rights to necessary intellectual property could be obtained on acceptable terms. The failure to obtain licenses or other intellectual property rights, as well as the expense or outcome of litigation, could adversely affect the Company's results of operations or financial condition. The Company has from time to time received, and it may in the future receive, communications alleging possible infringement of certain patents and other intellectual property rights of others. Regardless of the validity or the successful assertion of such claims, the Company could incur significant costs with respect to the defense thereof which could have a material adverse effect on the Company's results of operations or financial condition. The Company's sales are made primarily pursuant to standard purchase orders that are generally booked from one to twelve months in advance of delivery. Quantities actually purchased by customers, as well as prices, are subject to variations between booking and delivery to reflect changes in customer needs or industry conditions. During periods of industry overcapacity and declining selling prices, customer orders are not generally made as far in advance of the scheduled shipment date as during periods of capacity constraint. Such reduced lead time can reduce management's ability to forecast production levels and revenues. During periods of industry undercapacity, which is the case today, the backlog can exceed the Company's manufacturing capacity.

Our backlog has increased steadily in 1999 to a record backlog for the first quarter of 2000, with the highest level of incoming order rates in the Company's history. In order to meet this backlog, the Company is aggressively ramping up production at the new 8-inch facility at Rousset and Agrate facilities and is increasing its use of front-end external foundry services.

STMicroelectronics also sells certain products to key customers pursuant to frame contracts. Frame contracts are annual fixed-price contracts with customers setting forth the terms of purchase and sale of specific products that may be ordered in the future. These contracts allow the Company to schedule production capacity in advance and allow customers to manage their inventory levels consistent with just-in-time principles while shortening the cycle times required to produce ordered products. Orders under frame contracts are also subject to risks of price reduction, order cancellation and modifications as to quantities actually ordered.

Competition

Markets for the Company's products are intensely competitive. While only a few companies compete with STMicroelectronics in all of the Company's product lines, the Company faces significant competition in each of its product lines. STMicroelectronics competes with major international semiconductor companies, some of which have substantially greater financial and other resources than the Company with which to pursue engineering, manufacturing, marketing and distribution of their products. Smaller niche companies are also increasing their participation in the semiconductor market, and semiconductor foundry companies have expanded significantly, particularly in Asia. Competitors include manufacturers of standard semiconductors, application-specific ICs and fully customized ICs, including both chip and board-level products, as well as customers who develop their own integrated circuit products and foundry operations. Some of the Company's competitors are also its customers.

In 1999, the Company gained market share in 1999 versus the SAM, while its market position remained unchanged versus the TAM. The Company's net sales grew 19.0% while the TAM increased 18.9% and the SAM increased 14.9%, according to trade association data. The Company gained market share in 1995 and 1996 against both the TAM and the SAM although it lost market share against both the TAM and the SAM in 1997. The Company does not manufacture DRAMs, which are commodity memory products sold in high volumes that have experienced severe price cutting in 1996, 1997 and in 1998. The Company gained market share against both the TAM and the SAM in the first quarter of 2000, when the Company's revenues grew 52.9% compared to first quarter 1999 while the TAM grew 33.8% and the SAM grew 33.2%.

According to published industry data and other industry sources, investment in worldwide semiconductor fabrication capacity totaled approximately \$40 billion in 1997, \$28 billion in 1998 and \$32 billion in 1999, or approximately 29%, 22 % and 21.5%, respectively, of the TAM for such years. Such capacity investment is made not only by international semiconductor companies, but also companies specializing in operating semiconductor foundries, particularly in Asia such as UMC, TSMC and Chartered Semiconductors.

The primary international semiconductor companies which compete with the Company include Advanced Micro Devices, Hitachi, Intel Corporation, Lucent Technologies, Mitsubishi Electric Corporation, Motorola, National Semiconductor Corporation, Nippon Electric Company, Philips Semiconductors, Samsung, Infineon Technology, Texas Instruments and Toshiba.

The Company competes in different product lines to various degrees on the basis of price, technical performance, product features, product system compatibility, customized design, availability, quality and sales and technical support. In particular, standard products may involve greater risk of competitive pricing, inventory imbalances and severe market fluctuations than differentiated products. The Company's ability to compete successfully depends on elements both within and outside of its control, including successful and timely development of new products and manufacturing processes, product performance and quality, manufacturing yields and product availability, customer service, pricing, industry trends and general economic trends.

Employees

At December 31, 1999, the Company employed approximately 34,500 people, of whom approximately 7,200 were employed in France, 7,650 were employed in Italy, 850 were employed in the rest of Europe, 3,250 were employed in the United States, 6,000 were employed in Malta and Morocco and 9,550 were employed in Singapore, Malaysia, Japan and the rest of Asia. As of December 31, 1999 approximately 5,350 employees were engaged in research and development, 1,900 in marketing and sales, 23,800 in manufacturing, 1,800 in administration and general services and 1,650 in divisional functions.

The Company's future success, in particular in a period of strong increased demand, like the current one, will also depend on its ability to continue to attract, retain and motivate highly qualified technical, marketing, engineering and management personnel. Unions are present in France, Italy, Malta, Morocco and Singapore. The Company has not experienced any significant strikes or work stoppages in recent years, other than in connection with national strikes in Italy, and management believes that the Company's employee relations are good.

As part of its commitment to the principles of TQEM, the Company decided in July 1994 to develop an internal education organization called "ST University", responsible for organizing training courses to executives, engineers, technicians and sales personnel within the Company and coordinating all training for STMicroelectronics' employees. In 1999, ST University organized over 96,006 hours of training for 3,600 employees and 10,000 hours for training for external individuals.

Environmental Matters

The Company's manufacturing operations use many chemicals and gases and the Company is subject to a variety of governmental regulations related to the use, storage, discharge and disposal of such chemicals and gases and other emissions and wastes. Consistent with the Company's TQEM principles, the Company has established proactive environmental policies with respect to the handling of such chemicals and gases and emissions and waste disposals from its manufacturing operations. The Company has engaged outside consultants to audit its environmental activities and has created environmental management teams, information systems, education and training programs, and environmental assessment procedures for new processes and suppliers. All of the Company's plants are validated for the Eco-Management and Audit Scheme ("EMAS") and have also obtained ISO 14001 certification.

Although the Company has not suffered material environmental claims in the past and believes that its activities conform to presently applicable environmental regulations, in all material respects, environmental claims or the failure to comply with present or future regulations could result in the assessment of damages or imposition of fines against the Company, suspension of production or a cessation of operations.

Item 2: Description of Property

Manufacturing

STMicroelectronics currently operates 17 main manufacturing facilities around the world. In June 2000, the Company acquired a 6-inch microconductor manufacturing facility owned by Nortel Networks in Ottawa, Canada. The table below sets forth certain information with respect to STMicroelectronics' current manufacturing facilities, products and technologies. Front-end manufacturing facilities are wafer fabrication plants and back-end facilities are assembly, packaging and final testing plants.

Location	Products	Technologies
Front-end Facilities:		
Crolles, France	Semicustom devices, microcontrollers and dedicated products	Fab: 8-inch 0.35/0.18 micron CMOS and 0.7/0.25 micron BiCMOS; R&D on VLSI submicron technologies in conjunction with France Telecom R&D and Philips Semiconductors
Phoenix, Arizona	Dedicated products	Fab: 8-inch 0.5/0.35 micron CMOS, 0.5/0.35 micron BiCMOS
Agrate, Italy	Nonvolatile memories, microcontrollers and dedicated products	Fab 1: 6-inch 2.0/0.5 micron CMOS, BiCMOS and BCD Fab 2: 8-inch 0.35/0.18 micron CMOS, R&D on nonvolatile memories
Rousset, France	Microcontrollers, nonvolatile memories and smartcard ICs	Fab: 6-inch 0.8/0.5 micron CMOS
Catania, Italy	Power transistors, smart power ICs and nonvolatile memories	Fab 1: 5-inch 3 micron bipolar power - RF Fab 2: 6-inch 4/1 micron MOS power Fab 3: 6-inch 4/1 micron pilot line Fab 4: 8-inch 0.35/0.25 CMOS
Rennes, France	Dedicated and power products	Fab: 6-inch 2 micron BiCMOS, BCD and bipolar
Castelletto, Italy Tours, France	Smart power BCD Protection thyristors, diodes and application - specific discretes-power transitors	Fab: 6-inch 4.0/0.8 micron BCD pilot line Fab 1: 5-6-inch discrete Fab 2: 6-inch discrete
Ang Mo Kio, Singapore	Dedicated products, microcontrollers, power transistors and commodity products	Fab 1: 5-inch power MOS, bipolar transitor, bipolar bipolar ICs, standard linear 1.5 micron CMOS
Carrollton, Texas	Memories, microcontrollers, dedicated products and semicustom devices products and semicustom devices	Fab: 6-inch 1.2/0.6 micron BiCMOS, BCD and CMOS
Rancho Bernardo, California Back-end Facilities:	Dedicated products	Fab: 6-inch 1.0 micron BCD
Muar, Malaysia	Dedicated and standard products, microcontrollers	
Kirkop, Malta	Dedicated products, microcontrollers, semicustom devices	
Toa Payoh, Singapore Ain Sebaa, Morocco Shenzhen, China (jointly operated with Shenzhen Electronics Group)	Nonvolatile memories and power ICs Discrete and standard products Nonvolatile memories, discrete and standard products	
Bouskoura, Morocco	Subsystems, RF	

STMicroelectronics has expanded its diversified manufacturing infrastructure while improving the cost, quality and flexibility of its operations. In 1999, STMicroelectronics has applied recent investments in its manufacturing facilities to bring to full capacity and expand the 8-inch front-end manufacturing facility in Crolles, France and Catania, Italy, to continue the ramp up of an 8-inch front-end manufacturing facilities in Phoenix, Arizona and Catania, Italy, and to build an equip the new 8-inch front-end facilities in Rousset, France and Agrate, Italy, which are today starting production, to expand 6-inch front-end facilities in Carrollton, Texas and Rancho Bernardo, California, to purchase a 6-inch facility in Singapore, to convert from 5 to 6-inch the front-end facilities in Tours and Rennes, France and Catania, Italy and to expand its back-end facilities in Morocco, Malta, Malaysia, Singapore and China.

The Company currently expects capital spending for 2000 to exceed \$2.5 billion, significantly higher than in 1998 and 1999 to pursue and, in some cases, complete those projects mentioned above, as well as to start construction of a new 8-inch wafer fabrication facility in Catania, Italy that is planned to be operational by the year 2002 and a new 300 millimeter, 12-inch wafer research fabrication and pilot line at Crolles, France. As of December 31, 1999, the Company had commitments of approximately \$1.2 billion for equipment purchases. The

Company will continue to monitor its level of capital spending, however taking into consideration factors such as trends in the semiconductors market, capacity utilization and announced additions.

Although each fabrication plant is dedicated to specific processes, the Company's strategy is to develop local presences, better serve customers and mitigate manufacturing risks by having key processes operated in different manufacturing plants. The Company is also seeking to take advantage of current industry capacity limitations by purchasing from subcontractors both wafer foundry and back-end services and thereby minimizing its capital expenditure needs.

The Company's manufacturing processes are highly complex, require advanced and costly equipment and are continuously being modified in an effort to improve yields and product performance. Impurities or other difficulties in the manufacturing process can lower yields, interrupt production or result in losses of products in process. As system complexity has increased and sub-micron technology has become more advanced, manufacturing tolerances have been reduced and requirements for precision have become even more demanding. Although the Company's increased manufacturing efficiency has been an important factor in its improved results of operations, the Company has from time to time experienced production difficulties that have caused delivery delays and quality control problems, as is common in the semiconductor industry. No assurance can be given that the Company will be able to increase manufacturing efficiency in the future to the same extent as in the past or that the Company will not experience production difficulties in the future.

STMicroelectronics is fostering a corporate-wide TQEM culture that defines a common set of objectives and performance measurements for employees in all geographic regions, at every stage of product design, development, production and consignment for all product lines. TQEM in STMicroelectronics is based on five key principles: management commitment, employee empowerment, continuous improvement, management by fact and customer focus. TQM has become an integral part of the STMicroelectronics' culture and it is designed to develop a self-directed work force with a common set of values, objectives and problem-solving processes. Since 1987, the Company has improved average AIQ (electrical) status levels. Most of the Company's manufacturing facilities have been certified to conform to ISO international quality standards and EMAS. Several major customers, including Hewlett-Packard, Nokia, Sharp, DaimlerChrysler and Sanyo, have recognized STMicroelectronics' commitment to quality and have honored the Company with quality awards in the recent past.

STMicroelectronics' manufacturing processes use many raw materials, including silicon wafers, lead frame, mold compound, ceramic packages and chemicals and gases. The Company obtains its raw materials and supplies from diverse sources on a just-in-time basis. Although supplies for the raw materials used by the Company are currently adequate, shortages could occur in various essential materials due to interruption of supply or increased demand in the industry.

As is common in the semiconductor industry, the Company has from time to time experienced difficulty in ramping up production at new facilities or effecting transitions to new manufacturing processes and, consequently, has suffered delays in product deliveries or reduced yields. There can be no assurance that the Company will not experience manufacturing problems in achieving acceptable yields, product delivery delays or interruptions in production in the future as a result of, among other things, capacity constraints, construction delays, ramping up production at new facilities, upgrading or expanding existing facilities, changing its process technologies, or contamination or fires, storms, earthquakes or other acts of nature, any of which could result in a loss of future revenues. In addition, the development of larger fabrication facilities such as 8-inch or larger capabilities and require state-of-the-art submicron technology has increased the potential for losses associated with production difficulties, imperfections, or other causes of defects. In the event of an incident leading to an interruption of production at a fab, the Company may not be able to shift production to other facilities on a timely basis or the customer may decide to purchase products from other suppliers, and in either case the loss of revenues and impact on the Company's relationship with its customers could be significant. The Company's operating results could also be adversely affected by the increase in fixed costs and operating expenses related to increases in production capacity if revenues do not increase commensurately. Finally, in periods of high demand, the Company is increasing its reliance on external contractors for foundry and back-end service. Any failure to perform by such subcontractors could impact the relationship of the Company with its customers and could materially affect its results of operations.

The Company has its headquarters and executive office located in the vicinity of Geneva Airport at Route de Pre-Bois 20, ICC Bloc A, 1215 Geneva 15, Switzerland. The Company has its corporate legal seat and is domiciled in Amsterdam, The Netherlands. The Company also operates nine research and development centers and 31 design centers. The Company maintains regional sales headquarters in Geneva, Switzerland, Boston, Massachusetts, Singapre and Tokyo, Japan, and has 71 sales offices in 26 countries throughout Europe, North America, Japan, the Asia Pacific region and Region Five. In general, the Company owns its manufacturing facilities and leases most of its sales offices.

Item 3: Legal Proceedings

As is the case with many companies in the semiconductor industry, the Company has from time to time received communications alleging possible infringement of certain intellectual property rights of others. Irrespective of the validity or the successful assertion of such claims, the Company could incur significant costs with respect to the defense thereof which could have a material adverse effect on the Company's results of operations or financial condition.

The Company is currently involved in certain legal proceedings; however, the Company does not believe that the ultimate resolution of pending legal proceedings will have a material adverse effect on its financial condition.

On July 7, 1999 a judge for preliminary hearing in Catania, Sicily, dismissed all charges against the members of the Board of Directors of Corimme brought by the Public Prosecutor in Catania. This decision finally concluded the criminal prosecution started in 1995 by the public prosecutor against certain persons relating to alleged unauthorized use of public funds for research and development. The judge stated that the charges against such persons for alleged unauthorized use of public funds, had no legal basis and ordered that the files relating to this matter be archived on the grounds that no factual basis existed for any investigation. The Public Prosecutor did not file an appeal.

Furthermore, in relation to the various tax proceedings started in parallel by the tax authorities in Catania against Corimme for alleged unauthorized VAT deductions and irregular invoicing, in a ruling dated March 2000, the Commissione Tributaria Centrale confirmed the previous decisions favorable to Corimme entered by the Commissione Tributaria Provinciale and the Commissione Tributaria Regionale, with respect to the years 1988 and 1989. This decision is also final.

The Commissione Tributaria Provinciale of Milan has also ruled in favor of STMicroelectronics Italy on the various income tax proceedings for the period 1990-1992. The tax authorities have accepted these rulings by waiving their right of appeal.

The Company believes that the various criminal and judicial proceedings previously disclosed regarding Corimme have now been finally concluded.

Item 4: Control of Registrant

Principal Shareholders

The following table sets forth certain information with respect to the ownership of the Company's Common Shares as of May 5, 2000.

Shareholders	Common Sh	ares Owned (1)
	Number	%
STMicroelectronics Holding II B.V. ("ST Holding II")	389,483,280	43.91

 Following the 2:1 stock split and 3:1 stock split effected by the Company on June 16, 1999, and May 5, 2000, respectively.

ST Holding is 50% owned by a group of French shareholders that are indirectly controlled by the French government and 50% owned by a group of Italian shareholders that are indirectly controlled by the Italian government. The group of French shareholders is comprised of France Telecom, the French state-controlled telephone company, and CEA-Industrie, a corporation controlled by the French atomic energy commission, who hold through FT1CI. The group of Italian shareholders is represented by Finmeccanica (following the merger with MEI-Microelettronica Italiana s.r.l. ("MEI") which became effective on December 31, 1999), an Italian holding company owned by Istituto per la Ricostruzione Industriale-IRI S.p.A. ("I.R.I.", the holding company for Italian state-owned industrial and commercial interests), by the Italian Ministry of Treasury (following the transfer, as of June 18, 1999, of the interest previously held by Comitato per l'intervento nella SIR ed in settori ad alta tecnologia) and the public. Following the sale of a substantial portion of the shareholding interest of I.R.I. in Finmeccanica as part of a public offering of shares of Finmeccanica, I.R.I. will transfer a sufficient number of shares to the Italian Ministry of Treasury to ensure that the Italian Ministry of Treasury maintains a minimum equity participation of 30% in Finmeccanica. The shares of France Telecom are listed on the ParisBourse and the New York Stock Exchange. Certificats d'investissement of CEA-Industrie are listed on the ParisBourse. The shares of Finmeccanica are listed on the Milan Stock Exchange.

The officers and directors of the Company as a group do not own a material number of Common Shares.

The chart below illustrates the current shareholding structure as of May 5, 2000, prior to the previously mentioned sale of shares of Finmeccanica by I.R.I. to the public:

 $$\operatorname{This}$ information was represented by an organizational chart in the original document.

Description of Shareholding Structure: STMicroelectronics N.V. is owned 43.91% by STMicroelectronics Holding II B.V. and 56.09% by the public. STMicroelectronics Holding II B.V. is a wholly-owned subsidiary of STMicroelectronics Holding N.V. which is 50% owned by a group of French shareholders and 50% owned by a group of Italian shareholders. The French shareholder, FT1CI, is owned 51% by CEA-Industrie and 49% by France Telecom, respectively. The Italian shareholder, Finmeccanica, is owned 54.2% by I.R.I., 28.9% by the Italian Ministry of Treasury and 16.9% by the public.

(1) Ministero del Tesoro del Bilancio e della Programmazione Economica-Dipartimento del Tesoro.

In connection with the formation of the Company, Thomson-CSF and STET, as shareholders of the Company, entered into a shareholders agreement on April 30, 1987. In connection with the formation of ST Holding in 1989, which coincided with the acquisition by Thorn EMI of its interest in the Company, the shareholders agreement (as amended, the "Holding Shareholders Agreement") was amended to apply to the parties' ownership in ST Holding. The rights and obligations of Thomson-CSF and STET under the Holding Shareholders Agreement were subsequently transferred to or assumed by, as the case may be, FT2CI for Thomson-CSF, and Finmeccanica and MEI for STET. As a result of the merger of FT1CI and FT2CI, the rights and obligations of FT2CI under the Holdings Shareholders Agreement have been transferred to FT1CI. In connection with the transfer by Finmeccanica of its interest in ST Holding to MEI, the rights and obligations of Finmeccanica under the Holding Shareholders Agreement were transferred to or assumed by, as the case may be, MEI. Finally, following the merger of MEI into Finmeccanica (effective on December 31, 1999), Finmeccanica acquired all of the obligations and rights of MEI under the Holding Shareholders Agreement.

The Holding Shareholders Agreement contemplates that the parties shall agree upon common proposals and jointly exercise their powers of decision and their full control of the strategies and actions of ST Holding and the Company. Under the Holding Shareholders Agreement, the Supervisory Board of ST Holding, which is composed of three representatives of the French Owner and three representatives of the Italian Owner, and the Supervisory Board of the Company, each one within its respective sphere of competence, must give their respective prior approval before ST Holding, the Company, or any subsidiary of the Company may: (i) modify its articles of incorporation; (ii) change its authorized share capital, issue, acquire or dispose of its own shares, change any shareholder rights or issue any instruments granting an interest in its capital or profits; (iii) be liquidated or dispose of all or a substantial and material part of its assets or any shares it holds in any of its subsidiaries; (iv) enter into any merger, acquisition or joint venture agreement (and, if substantial and material, any agreement relating to intellectual property) or form a new company; (v) approve such company's draft consolidated balance sheets and financial statements or any profit distribution by such company; or (vi) enter into any agreement with any of the direct or indirect French or Italian Owners outside the normal course of business. The Holding Shareholders Agreement also provides that long-term business plans and annual budgets of the Company and its subsidiaries, as well as any significant modifications thereto, shall be approved in advance by the Supervisory Board of ST Holding and of the Company, each one within its respective sphere of competence. In addition, the Supervisory Board of ST Holding shall also decide upon operations of exceptional importance contained in the annual budget even after financing thereof shall have been approved.

Such agreement also provides that similar and adequate levels of research, development and technological innovation shall be achieved by the Company and its subsidiaries in France and Italy and that there shall be no substantial discrepancy in the percentage of state financing compared to research, development and technological innovation expenditures by the Company and its subsidiaries in each such country. See "Item 1: Description of Business--Public Funding." Pursuant to the terms of the Holding Shareholders Agreement, ST Holding and the Company are not permitted, as a matter of principle, to operate outside the field of semiconductor products. The parties to the Holding Shareholders Agreement also undertake to refrain directly or indirectly from competing with the Company in the area of semiconductor products, subject to certain exceptions, and to offer the Company opportunities to commercialize or invest in any semiconductor product developments by them. Any financing or capital provided by the parties to ST Holding or the Company is intended to be provided pro rata based on the parties' respective shareholdings in ST Holding. In the Holding Shareholders Agreement, the parties state that it is of the utmost importance that the French and Italian governments grant sufficient and continuous financial support for research and development, and undertake to take suitable actions with a view to obtaining such funding. See "Item 1: Description of Business--Public Funding."

The admission of a third party to the share capital of ST Holding, whether through the sale of ST Holding's outstanding shares or through the issue by ST Holding of new shares, or by any other means, must be unanimously agreed upon. In the event of a disagreement that cannot be resolved between the parties as to the conduct of the business and actions contemplated by the Holding Shareholders Agreement, each party has the right to offer its interest in ST Holding to the other, which then has the right to acquire, or to have a third party acquire, such interest. If neither party agrees to acquire or have acquired the other party's interest, then together the parties are obligated to try to find a third party to acquire their collective interests, or such part thereof as is suitable to change the decision to terminate the agreement. The Holding Shareholders Agreement otherwise terminates in the event that one of the parties thereto ceases to hold shares in ST Holding.

Pursuant to the terms of the Holding Shareholders Agreement and for the duration of such agreement, FT1CI (the "French Owner"), on the one hand, and Finmeccanica (the "Italian Owner") on the other hand, have agreed to maintain equal interests in the Share capital of the Company.

The Company has been informed that the shareholders of FT1CI have also entered into a separate shareholder agreement that requires the consent of the Board of Directors, with a two-thirds majority, for certain actions taken by ST Holding, the Company and its subsidiaries. These agreements provide for the management of the interests of CEA-Industrie and France Telecom in ST Holding and the Company, with the object of defining between them the positions, strategies and decisions to be taken by the French Owner in ST Holding affecting the management of ST Holding, and the Company and its subsidiaries. The Company is not a party to such agreement.

The agreement between the shareholders of FT1CI (CEA-Industrie and France Telecom) provides that the following acts with respect to ST Holding or the Company must be approved by three-quarters of the Board of Directors of FT1CI (which consists of five directors, three of whom are chosen by CEA-Industrie and two of whom are chosen by France Telecom): (i) any modification of the articles of association of ST Holding or the Company, (ii) any change in the capital of ST Holding or the Company, or issuance, purchase or sale by ST Holding or the Company of their shares or rights attached thereto, or the issuance of any securities giving rights to a share in the capital or profits of ST Holding or the Company, (iii) the liquidation or dissolution of ST Holding or the Company or the sale of all or an important and material part of the business or assets of ST Holding or the Company representing at least \$10,000,000 of the consolidated shareholders' equity of the Company, (iv) any merger, acquisition, partnership in interest or the execution of any material agreement relating to intellectual property rights, in each case in which ST Holding or the Company participates or in which a proposal is made to participate, or the establishment by ST Holding or the Company of new companies or groups, (v) approval of the balance sheets and consolidated accounts of ST Holding, the Company and its subsidiaries as well as the policies of distributions of profits among the group, (vi) any agreement between ST Holding and/or the Company and the shareholders of FT1CI which is out of the ordinary course of business, (vii) the approval of, or material modifications to, shareholders agreements with the Italian Owner with respect to ST Holding or the Company and (viii) approval of strategic multi-year plans and annual consolidated budgets of ST Holding and the Company. Transfers of shares in FTICI to third parties are subject to the approval of at least four members of the Board of Directors, and are subject to a right of first refusal of the other shareholders, as well as other provisions. In the event CEA-Industrie proposes to sell its interest in FT1CI, in whole or in part, France Telecom has the right to require the acquirer to purchase its interest as well. The FT1CI shareholders agreement terminates upon the termination of FT1CI.

As is the case with other companies controlled by the French Government, the French Government has appointed a Commissaire du Gouvernement and a Controleur d'Etat for FTICI. Pursuant to Decree No. 94-214, dated March 10, 1994, these Government representatives have the right (i) to attend any board meeting of FTICI, and (ii) to veto any board resolution or any decision of the president of FTICI within 10 days of such board meeting (or, if they have not attended the meeting, within 10 days of the receipt of the board minutes or the notification of such president's decision); such veto lapses if not confirmed within one month by the Ministry of the Economy or the Secretariat d'Etat a l'Industrie (Secretary of Industry). FTICI is subject to certain points of the arrete of August 9, 1953 pursuant to which the Ministry of the Economy and any other relevant ministries (a) have the authority to approve decisions of FTICI relating to budgets or forecasts of revenues, operating expenses and capital expenditures, and (b) may set accounting principles and rules of evaluation of fixed assets and amortization.

Pursuant to the principal Italian privatization law, certain special government powers may be introduced into the by-laws of firms considered strategic by the Italian government. In the case of Finmeccanica, these powers were established by decrees adopted by the Minister of the Treasury on November 8, 1999 and Finmeccanica's by-laws were subsequently amended on November 23, 1999. The special powers of the Minister of the Treasury (who will act in agreement with the Minister of Industry) include (i) the approval or disapproval of the acquisition of material interests in Finmeccanica's share capital, (ii) approval of material shareholders' agreements relating to Finmeccanica's share capital, (iii) appointment of members of Finmeccanica's board of directors and board of statutory auditors, and (iv) veto powers to veto resolutions to dissolve Finmeccanica, transfer its business, merge, conduct spin-offs, sell businesses or lines of business, including the transfer of equity participations in subsidiaries or affiliates, transfer its registered office outside of Italy, change Finmeccanica's corporate purposes or amend or modify any of the Minister of the Treasury's special powers.

In connection with the Initial Public Offering, ST Holding II and the Company entered into a registration rights agreement pursuant to which the Company agreed that, upon request from ST Holding II, the Company will file a registration statement under the Securities Act of 1933, as amended, to register Common Shares held by ST Holding II, subject to a maximum number of five requests in total as well as a maximum of one request in any twelve-month period. Subject to certain conditions, the Company will grant ST Holding II the right to include its Common Shares in any registration statements covering offerings of Common Shares by the Company. ST Holding II will pay a portion of the costs of any requested or incidental registered offering based upon its proportion of the total number of Common Shares being registered, except that ST Holding II will pay any underwriting commissions relating to Common Shares that it sells in such offerings and any fees and expenses of its separate advisors, if any. Such registration rights agreement will terminate upon the earlier of December 15, 2004 and such time as ST Holding II and its affiliates own less than 10% of the Company's outstanding Common Shares.

The French and Italian shareholders of ST Holding have agreed in a document dated August 31, 1999, to continue to manage their interest in the Company through ST Holding until at least December 31, 2000, and accordingly they have undertaken (i) to jointly hold 100% of ST Holding's capital and voting rights, (ii) to maintain equality between the shareholdings of the French and Italian shareholders, (iii) to ensure that ST Holding maintains more than 40% of the Company's share capital and voting rights on a fully diluted basis after exercise or conversion of all stock options and convertible securities, and (iv) to jointly exercise their decision-making powers and monitor strategies and actions as part of ST Holding's management bodies. Both the French and Italian governments have the authority to veto certain decisions of the French and Italian shareholders, respectively, as explained above.

The Company has been informed that Finmeccanica has agreed not to sell its indirect shareholding in the Company for a period of 90 days from the closing of the public offering of Finmeccanica's shares by I.R.I. or to issue any securities convertible into or exchangeable for shares of the Company, without the prior consent of the joint global coordinators of the Finmeccanica offering.

On May 31, 1999, the Company's shareholders at the annual general meeting approved the creation of 180,000,000 Preference Shares (540,000,000 Preference Shares, as adjusted for the 3:1 stock split implemented in May 2000). These Preference Shares entitle a holder to full voting rights at any meeting of shareholders and to a preferential right to dividends. On May 31, 1999, the Company entered into an option agreement with ST Holding II, which provides that Preference Shares shall be issued to ST Holding II upon request subject to the adoption of a resolution of the Supervisory Board of the Company recognizing that a hostile takeover or similar action exists and giving its consent to the exercise of the option and upon payment of at least 25% of the par value of the Preference Shares to be issued. The option is contingent upon ST Holding II retaining at least 33% of the issued share capital of the Company.

Item 5: Nature of Trading Market

Common Shares

Since 1994, the Common Shares have been traded on the New York Stock Exchange under the symbol "STM" and on the ParisBourse and were quoted on SEAQ International. On June 5, 1998, the Common Shares were also listed for the first time on the Italian Stock Exchange, where they have been traded since that date.

The Common Shares have been included in the CAC 40, the principal index published by ParisBourseSBF SA (the "SBF"), since November 12, 1997. The CAC 40 is derived daily by comparing the total market capitalization of 40 stocks included in the monthly settlement market of the ParisBourse to a baseline established on December 31, 1987. Adjustments are made to allow for expansion of the sample due to new issues. The CAC 40 indicates the trends in the French stock market as a whole and is one of the most widely followed stock price indices in France.

Since June 5, 1998, the Common Shares have also been listed on the Italian Stock Exchange.

The table below indicates the range of the high and low prices in U.S. dollars for the Common Shares on the New York Stock Exchange and the high and low prices in euros for the Common Shares on the ParisBourse and

the Italian Stock Exchange during each quarter in 1998, 1999 and, to date in 2000. In December 1994, the Company completed the Initial Public Offering of 21,000,000 Common Shares at an initial price to the public of \$22.25 per share. On June 16, 1999, the Company effected a 2:1 stock split and on May 5, 2000, the Company effected a 3:1 stock split. The table below has been adjusted to reflect the split.

	Exchan per Com	rk Stock ge Price mon Share	ParisBo Price Common S	per Share(1)	Italian Stock Exchange Price per Common Share	(2)
Calendar Period	High	Low	High	Low	High	Low
1998						
First quarter	\$39 3/8	\$ 25 5/8	EUR 37.24	EUR 23.63	-	-
Second quarter(3)	1	\$ 32 1/4	EUR 42.46	EUR 29.42	EUR 32.79	EUR 30.38
Third quarter	\$36 1/4	\$ 22	EUR 33.26	EUR 18.37	EUR 32.53	EUR 19.92
Fourth quarter	\$41 7/16	\$ 17 15/16	EUR 34.99	EUR 15.02	EUR 34.77	EUR 15.73
1999						
First quarter	\$53 13/16	\$ 40 1/4	EUR 48.50	EUR 34.40	EUR 46.53	EUR 34.96
Second quarter		\$ 16 5/16	EUR 23.00	EUR 14.83	EUR 23.33	EUR 14.83
Third guarter	\$27 1/8	\$ 21 1/4	EUR 26.07	EUR 20.03	EUR 26.15	EUR 20.27
Fourth quarter	\$51 5/16	\$ 25	EUR 51.67	EUR 23.05	EUR 51.67	EUR 23.17
2000						
First quarter	\$73 7/8	\$ 40 11/16	EUR 76.93	EUR 39.53	EUR 76.67	EUR 40.35
Second quarter (through June 21)	\$69 1/4	\$ 51 9/16	EUR 74.33	EUR 56.00	EUR 74.10	EUR 56.98

(1) For periods prior to January 1, 1999, the share prices on the ParisBourse have been converted into euro at the official exchange rate of EUR 1.00 = FF 6.55957.

- (2) For periods to January 1, 1999, the share prices on the Italian Stock Exchange have been converted into euro at the official exchange rate of EUR 1.00 = Lit. 1,936.27.
- (3) The shares have been listed on the Italian Stock Exchange since June 5, 1998.

At December 31, 1999, there were 289,808,140 Common Shares issued and outstanding, of which 31,042,387 or 10.7% were registered in the Common Share registry maintained on the Company's behalf in New York.

Dividends

On April 26, 2000, the Company's shareholders approved the payment of a cash dividend with respect to the year ended December 31, 1999 of \$0.09 per Common Share payable as of May 4, 2000 to shareholders of record on April 28, 2000.

1998 Liquid Yield OptionTM Notes

The 1998 Liquid Yield OptionTM Notes ("LYONs") of the Company are traded on the New York Stock Exchange and the ParisBourse. The table below indicates the range of the high and low prices on the New York Stock Exchange and the high and low prices for the LYONs on the ParisBourse, in both cases as a percentage of principal amount at maturity, during each quarter in 1999 and to date in 2000.

	New York Stock Exchange Price per LYON		ParisBourse Price per LYON	
Calendar Period	High	Low	High	Low
1998				
Second quarter (since June 5)	85.13%	83.50%	99%	85.50%
Third quarter	85.13%	80%	88.50%	72.10%
Fourth quarter	83%	80%	89%	75%
1999				
First quarter	94%	84%	97.50%	90%
Second quarter	130%	94%	122.10%	101.30%
Third quarter	154%	122%	157%	124%
Fourth quarter	277%	145%	278%	146%
2000				
First quarter	390%	225%	445%	210%
Second quarter (through June 21)	367%	282%	443%	332%

1999 Liquid Yield OptionTM Notes

The 1999 Liquid Yield OptionTM Notes ("LYONs") of the Company are traded on the New York Stock Exchange and the ParisBourse. The table below indicates the range of the high and low prices on the New York Stock Exchange and the high and low prices for the LYONs on the ParisBourse, in both cases as a percentage of principal amount at maturity, during each quarter in 1999 and to date in 2000.

	New York Exchange Pri			.sBourse per LYON
Calendar Period	High	Low	High	Low
1999 Third quarter (since September 16) Fourth quarter		81.56% 78.48%	80.83% 129%	76.46% 78.48%
2000 First quarter Second quarter (through June 21)		119% 138%	206% 198%	126% 156%

The securities of most large public companies are listed on the Premier Marche with the Second Marche available for small and medium-sized companies. Both the Premier Marche and the Second Marche are operated by the SBF. Securities are also traded on the Marche Libre-OTC which is also operated by the SBF.

The Common Shares are listed on the Premier Marche. Shares listed on the ParisBourse are placed in one of four categories depending on the volume of transactions. The Common Shares are listed in the category known as Continu A, which includes the most actively traded shares (with a minimum daily trading volume of FF 250,000 or twenty trades).

Official trading of listed securities on the ParisBourse is transacted through providers of investment services (investment companies and other financial institutions) and takes place continuously on each business day from 9:00 a.m. to 5:00 p.m., with a pre-opening session from 7:30 a.m. to 9:00 a.m. and a closing auction at 5:35 p.m. Any trade effected after the close of a stock exchange session will be recorded, on the next ParisBourse trading day, at the closing price for the relevant security at the end of the previous day's session. The SBF publishes a daily Official Price List that includes price information on each listed security. The ParisBourse has introduced continuous trading by computer for most listed securities.

Trading in the listed securities of an issuer may be suspended by the SBF if quoted prices exceed certain price limits defined by the regulations of the SBF. In particular, if the quoted price of a Continu A security varies by more than 10 percent from the previous day's closing price, trading may be suspended for up to 15 minutes. Further suspensions for up to 15 minutes are also possible if the price again varies by more than five percent. The SBF may also suspend trading of a listed security in certain other limited circumstances, including, for example, the occurrence of unusual trading activity in such security.

Trades of securities listed on the Premier Marche of the ParisBourse are settled in either of two ways: in the cash settlement market or the monthly settlement market. The Common Shares are settled in the marche a reglement mensuel (monthly settlement market). In the monthly settlement market, the purchaser may elect to settle on the third trading day following the trade (reglement immediat or immediate settlement) or decide on the determination date (date de liquidation), which is the fifth trading day prior to the end of the month) either (i) to settle the trade no later than on the last trading day of such month or (ii) upon payment of an additional fee, to extend to the determination date of the following month the option either to settle no later than the last trading day of such month or to postpone further the selection of a settlement date until the next determination date (a procedure known as report). Such purchaser may decide to renew its option on each subsequent determination date upon payment of an additional fee. The majority of transactions in equity securities on the ParisBourse are settled on the monthly settlement market. In accordance with French securities regulation, any sale of shares executed on the monthly settlement market during the month of a dividend payment date is deemed to occur after payment of the dividend, and the purchaser's account will be credited with an amount equal to the dividend paid and the seller's account will be debited in the same amount.

Securities Trading in Italy

The Mercato Telematico Azionario (the "MTA"), the Italian automated screen-based guotation system on which the Company's Common Shares are listed. is organized and administered by Borsa Italiana S.p.A. ("Borsa Italiana") subject to the supervision and control of CONSOB, the public authority charged, inter alia, with regulating investment companies, securities markets and public offerings of securities in Italy to ensure the transparency and regularity of dealings and protect investors. Borsa Italiana was established to manage the Italian regulated financial markets (including the MTA) as part of the implementation in Italy of the EU Investment Services Directive pursuant to Legislative Decree No. 415 of July 23, 1996 (the "Eurosim Decree") as modified by Legislative Decree 58 of February 24, 1998 (the "Financial Act"). Borsa Italiana became operative in January 1998, replacing the administrative body Consiglio di Borsa, and has issued rules governing the organization and the administration of the Italian stock exchange, futures and options markets as well as the admission to listing on and trading in these markets. The shareholders of Borsa Italiana are primarily financial intermediaries.

A three-day rolling cash settlement period applies to all trades of equity securities in Italy effected on a regulated market. Any person, through an authorized intermediary, may purchase or sell listed securities following (i) in the case of sales, deposit of the securities; and (ii) in the case of purchases, deposit of 100% of such securities' value in cash, or deposit of listed securities or government bonds of an equivalent amount. No "closing price" is reported for the electronic trading system, but an "official price", calculated for each security as a weighted average of all trades effected during the trading day net of trades executed on a "cross-order" basis, and a "reference price", calculated for each security as a weighted average of the last 10% of the trades effected during such day, are reported daily.

If the opening price of a security (established each trading day prior to the commencement of trading based on bids received) differs by more than 10% (or such other amount established by Borsa Italiana) from the previous day's reference price, trading in that security will not be permitted until Borsa Italiana authorizes it. If in the course of a trading day the price of a security fluctuates by more than 5% from the last reported sale price (or 10% from the previous day's reference price), an automatic five minute suspension in the trading of that security will be declared. In the event of such a suspension, orders already placed may not be modified or cancelled and new orders may not be processed. Borsa Italiana has the authority to suspend trading in any security, among other things, in response to extreme price fluctuations. In urgent circumstances, CONSOB may, where necessary, adopt measures required to ensure the transparency of the market, orderly trading and protection of investors.

Italian law requires that trading of equity securities, as well as any other investment services, may be carried out on behalf of the public only by registered securities dealing firms and banks (with minor exceptions). Banks and investment services firms organized in a member nation of the EU are permitted to operate in Italy provided that the intent of the bank or investment services firm to operate in Italy is communicated to (i) Bank of Italy and to (ii) Bank of Italy and CONSOB, respectively, by the competent authority of the member state. Non-EU banks and non-EU investment services firms may operate in Italy subject to a specific authorization granted by a decree of the Italian Ministry of Treasury and a resolution of the CONSOB, respectively.

The settlement of stock exchange transactions is facilitated by Monte Titoli, a centralized securities clearing system owned by the Banca d'Italia and certain major Italian banks and financial institutions. Almost all Italian banks and some registered securities dealing firms have securities accounts with Monte Titoli. Beneficial owners of shares may hold their interests through specific deposit accounts with any depositary having an account with Monte Titoli. Beneficial owners of shares held with Monte Titoli may transfer their shares, collect dividends, create liens and exercise other rights with respect to those shares through such accounts.

Participants in Euroclear and Cedelbank may hold their interests in shares and transfer the shares, collect dividends and exercise their shareholders' rights through Euroclear and Cedelbank. A holder may require Euroclear and Cedelbank to transfer its shares to an account of such holder with an Italian bank or any authorized broker having an account with Monte Titoli.

> Item 6: Exchange Controls and Other Limitations Affecting Security Holders

None.

Item 7: Taxation

Certain Dutch tax consequences for holders of Common Shares

This summary describes the tax consequences that will generally apply in case of an investment in Common Shares under Dutch and United States tax laws in force and in effect as of the date of this annual report on Form 20-F, and is subject to changes in Dutch or U.S. law, including changes that could have retroactive effect. Not every potential tax consequence of such investment under the laws of The Netherlands or the United States will be addressed. PROSPECTIVE INVESTORS SHOULD CONSULT THEIR TAX ADVISERS REGARDING THEIR PARTICULAR PERSONAL TAX CONSEQUENCES OF ACQUIRING, OWNING AND DISPOSING OF COMMON SHARES.

This section "Dutch taxation of non-resident shareholders" describes certain Dutch tax consequences for a holder of Common Shares who is neither resident, nor deemed to be resident in The Netherlands for purposes of Dutch taxation (a "Non-Resident Shareholder").

Withholding tax

Dividends distributed by the Company generally are subject to a withholding tax imposed by The Netherlands at a rate of twenty five per cent. The expression "dividends distributed by the Company" used in this section includes, but is not limited to:

i. distributions in cash or in kind, deemed and constructive distributions and repayments of paid-in capital not recognized for Dutch dividend withholding tax purposes;

ii. liquidation proceeds, proceeds of redemption of Common Shares or, as a rule, consideration for the repurchase of Common Shares by the Company in excess of the average paid-in capital recognized for Dutch dividend withholding tax purposes;

iii. the par value of Common Shares issued to a holder of Common Shares or an increase of the par value of Common Shares, as the case may be, to the extent that it does not appear that a contribution, recognized for Dutch dividend withholding tax purposes, has been made or will be made; and

iv. partial repayment of paid-in capital, recognized for Dutch dividend withholding tax purposes, if and to the extent that there are net profits (zuivere winst), unless (a) the general meeting of shareholders of the Company has resolved in advance to make such repayment; and (b) the par value of the Common Shares concerned has been reduced by an equal amount by way of an amendment of the articles of association.

If a double taxation convention is in effect between The Netherlands and the country of residence of a Non-Resident Shareholder, such Non-Resident Shareholder may, depending on the terms of that double taxation convention, be eligible for a full or partial exemption from, or refund of, Dutch dividend withholding tax.

U.S. Shareholders. Under the Tax Convention of December 18, 1992, concluded between the United States and The Netherlands (the "Convention"), the withholding tax on dividends paid by the Company to a resident of the United States (as defined in the Convention) who is entitled to the benefits of the Convention under Article 26 may be reduced to 15% pursuant to Article 10 of the Convention. Dividends paid by the Company to U.S. pension funds and U.S. exempt organizations may be eligible for an exemption from dividend withholding tax.

Relief/refund Procedure. If the 15% rate, or an exemption in case of a qualifying U.S. pension fund, is applicable pursuant to the Convention, the Company is allowed to pay out a dividend under deduction of 15%, or respectively without any deduction, if, at the payment date, the relevant shareholders have submitted the duly signed form IB 92 USA, which form includes a banker's affidavit. Holders of Common Shares through DTC will initially receive dividends subject to a withholding rate of 25%. An additional 10% of the dividend will be paid to holders upon receipt by the dividend disbursing agent of notification from the Participants in DTC that such holders are eligible for the reduced rate under the Convention. Only where the applicant has not been able to claim full or partial relief at source, will he be entitled to a refund of the excess tax withheld. In that case he should mention in the Form IB 92 USA the circumstances that prevented him from claiming relief at source.

Qualifying U.S. exempt organizations can only ask for a full refund of the tax withheld by using the Form IB 95 USA, which form also includes a banker's affidavit.

A Non-Resident Shareholder will not be subject to any Dutch taxes on income or capital gains in respect of dividends distributed by the Company (other than the withholding tax described above) or in respect of any gain realized on the disposal of Common Shares, provided that:

- (i) such Non-Resident Shareholder does not have an enterprise or an interest in an enterprise that is, in whole or in part, carried on through a permanent establishment or a permanent representative in The Netherlands and to which enterprise or part of an enterprise, as the case may be, the Common Shares are attributable; and
- (ii) such Non-Resident Shareholder does not have a substantial interest or a deemed substantial interest in the Company or, if such holder does have such an interest, it forms part of the assets of an enterprise.

Generally, a holder of Common Shares will not have a substantial interest if he, his spouse, certain other relatives (including foster children) or certain persons sharing his household, do not hold, alone or together, whether directly or indirectly, the ownership of, or certain other rights over, shares representing five per cent or more of the total issued and outstanding capital (or the issued and outstanding capital of any class of shares) of the Company, or rights to acquire shares, whether or not already issued, that represent at any time (and from time to time) five per cent or more of the total issued and outstanding capital (or the issued and outstanding capital of any class of shares) of the Company or the ownership of certain profit participating certificates that relate to five per cent or more of the annual profit of the Company and/or to five per cent or more of the liquidation proceeds of the Company. A deemed substantial interest is present if (part of) a substantial interest has been disposed of, or is deemed to have been disposed of, on a non-recognition basis.

Net wealth tax

A Non-Resident Shareholder will not be subject to Dutch net wealth tax in respect of the Shares, provided that such Non-Resident Shareholder is not an individual or, if he is an individual, provided that such Non-Resident Shareholder does not have an enterprise or an interest in an enterprise that is, in whole or in part, carried on through a permanent establishment or a permanent representative in The Netherlands and to which enterprise or part of an enterprise, as the case may be, the Common Shares are attributable.

Gift and inheritance taxes

No gift or inheritance taxes will arise in The Netherlands with respect to an acquisition of Common Shares by way of a gift by, or on the death of, a Non-Resident Shareholder, unless:

(i) such Non-Resident Shareholder at the time of the gift has or at the time of his death had an enterprise or an interest in an enterprise that is or was, in whole or in part, carried on through a permanent establishment or a permanent representative in The Netherlands and to which enterprise or part of an enterprise, as the case may be, the Common Shares are or were attributable; or

(ii) in the case of a gift of Common Shares by an individual who at the time of the gift was a Non-Resident Shareholder, such individual dies within 180 days after the date of the gift, while being resident or deemed to be resident in The Netherlands.

For purposes of Dutch gift and inheritance tax, an individual who holds the Dutch nationality will be deemed to be resident in The Netherlands if he has been resident in The Netherlands at any time during the ten years preceding the date of the gift or his death. For purposes of Dutch gift tax, an individual not holding the Dutch nationality will be deemed to be resident in The Netherlands if he has been resident in The Netherlands at any time during the twelve months preceding the date of the gift.

Capital tax

Dutch capital tax will be payable by the Company at a rate of 0.9 per cent of any contribution made in respect of the Common Shares.

Other taxes and duties

No Dutch registration tax, transfer tax, stamp duty or any other similar documentary tax or duty will be payable in The Netherlands in respect of or in connection with the subscription, issue, placement, allotment or delivery of the Common Shares.

United States Taxation

The following discussion is a summary of certain U.S. federal income tax consequences of the ownership of Common Shares by U.S. Holders, as defined below. This summary applies only to a beneficial owner of Common Shares (a) who owns, directly or indirectly, less than 10% of the voting stock of the Company, (b) who is (i) a citizen or resident of the United States for U.S. federal income tax purposes, (ii) a U.S. domestic corporation or (iii) otherwise subject to U.S. federal income taxation on a net income basis in respect of the Common Shares, (c) who holds the Common Shares as capital assets, (d) whose functional currency is the U.S. dollar, (e) who is a resident of the United States and not also a resident of The Netherlands for purposes of the Convention, (f) who is entitled under the "limitation on benefits" provisions contained in the Convention to the benefits of the Convention and (g) who does not have a permanent establishment or fixed base in The Netherlands (a "U.S. Holder"). Certain holders (including, but not limited to, United States expatriates, tax-exempt organizations, persons subject to the alternative minimum tax, securities broker-dealers and certain other financial institutions, persons holding the Common Shares in a hedging transaction or as part of a straddle or conversion transaction or holders whose functional currency is not the U.S. dollar) may be subject to special rules not discussed below. Because this is a general summary, prospective purchasers are advised to consult their own tax advisors with respect to the U.S. federal, state, local and applicable foreign tax consequences of the purchase, ownership and disposition of Common Shares.

This summary is based on the Internal Revenue Code of 1986, as amended (the "Code"), the Convention, judicial decisions, administrative pronouncements and existing and proposed Treasury regulations as of the date hereof, all of which are subject to change, possibly with retroactive effect.

Dividends

For U.S. federal income tax purposes, the gross amount of distributions made by the Company with respect to the Common Shares (including the amount of any Netherlands taxes withheld therefrom) will generally be includable in the gross income of a U.S. Holder in the year received as foreign source dividend income to the extent that such distributions are paid out of the Company's current or accumulated earnings and profits as determined under U.S. federal income tax principles. To the extent, if any, that the amount of any such distribution exceeds the Company's current or accumulated earnings and profits, it will be treated first as a tax-free return of the U.S. Holder's tax basis in the Common Shares (thereby increasing the amount of any gain or decreasing the amount of any loss realized on the subsequent sale or disposition of such Common Shares) and thereafter as capital gain. No dividends received deduction will be allowed with respect to dividends paid by the Company. The amount of any distribution paid in Dutch guilders will be equal to the U.S. dollar value of such Dutch quilders on the date of distribution, regardless of whether the payment is in fact converted into U.S. dollars at that time. Gain or loss, if any, realized on the sale or other disposition of such Dutch guilders will be U.S. source ordinary income or loss. The amount of any distribution of property other than cash will be the fair market value of such property on the date of distribution.

Subject to certain limitations, Netherlands taxes withheld from a distribution at the rate provided in the Convention will be eligible for credit against a U.S. Holder's U.S. federal income tax liability. Under current Dutch law, the Company under certain circumstances may be permitted to deduct and retain from such withholding a portion of the amount that would otherwise be required to be remitted to the taxing authorities in The Netherlands. This amount generally may not exceed 3% of the total dividend distributed by the Company. To the extent that the Company has withheld an amount from dividends paid to shareholders which it then is not required to remit to any

taxing authority in The Netherlands, such amount in all likelihood would not qualify as a creditable tax for U.S. tax purposes. The Company will endeavor to provide to U.S. Holders information concerning the extent to which it has applied the reduction described above to dividends paid to U.S. Holders. The limitation on foreign taxes eligible for credit is calculated separately with respect to specific classes of income. For this purpose, dividends distributed by the Company with respect to the Common Shares will generally constitute "passive income" or, in the case of certain U.S. Holders, "financial services income." The rules relating to the determination of the U.S. foreign tax credit are complex and holders should consult their tax advisors to determine whether and to what extent a credit would be available. U.S. Holders that do not elect to claim a foreign tax credit may instead claim a deduction for all foreign taxes paid in the taxable year.

Sale or other disposition of Common Shares

Upon a sale or other disposition of Common Shares, a U.S. Holder will recognize gain or loss for U.S. federal income tax purposes in an amount equal to the difference between the amount realized and the U.S. Holder's tax basis in such Common Shares. Such gain or loss will be capital gain or loss. Any such gain or loss, if any, will generally be U.S. source gain or loss. In the case of a U.S. Holder who is an individual, any capital gain generally will be subject to U.S. federal income tax at preferential rates if specified minimum holding periods are met.

U.S. information reporting and backup withholding

Dividend payments with respect to Common Shares and proceeds from the sale, exchange or redemption of Common Shares may be subject to information reporting to the Internal Revenue Service ("IRS") and possible U.S. backup withholding at a 31% rate. Backup withholding will not apply, however, to a holder who furnishes a correct taxpayer identification number or certificate of foreign status and makes any other required certification or who is otherwise exempt from backup withholding. Persons required to establish their exempt status generally must provide such certification on IRS Form W-9 (Request for Taxpayer Identification Number and Certification) in the case of U.S. persons and on IRS Form W-8 (Certificate of Foreign Status) in the case of non-U.S. persons. Finalized Treasury regulations have generally expanded the circumstances under which information reporting and backup withholding may apply for payments made after December 31, 2000. Holders of Common Shares should consult their tax advisors regarding the application of the information reporting and backup withholding rules, including the finalized Treasury regulations.

Amounts withheld as backup withholding may be credited against a holder's U.S. federal income tax liability, and a holder may obtain a refund of any excess amounts withheld under the backup withholding rules by filing the appropriate claim for refund with the IRS and furnishing any required information.

Item 8: Selected Consolidated Financial Data

Reference is made to the information appearing under the caption "Selected Consolidated Financial Data" on page 34 of the Company's 1999 Annual Report submitted as a Report on Form 6-K to the Securities and Exchange Commission on June 19, 2000 (the "1999 Annual Report"), which information is hereby incorporated by reference.

Item 9: Management's Discussion and Analysis of Financial Condition and Results of Operations

Reference is made to the information appearing under the caption "Management's Discussion and Analysis of Financial Condition and Results of Operations" on pages 35 through 43 of the 1999 Annual Report, which information is hereby incorporated by reference.

Item 9A: Quantitative and Qualitative Disclosures About Market Risk

The Company is exposed to changes in financial market conditions in the normal course of business due to its operations in different foreign currencies and its ongoing investing and financing activities. Market risk is the uncertainty to which future earnings or asset/liability values are exposed due to operating cash flows denominated in foreign currencies and various financial instruments used in the normal course of operations. The Company has established policies, procedures and internal processes governing its management of market risks and the use of financial instruments to manage its exposure to such risks.

The Company is exposed to changes in interest rates primarily as a result of its borrowing activities which include long-term debt used to fund business operations. The Company borrows in U.S. dollars as well as in other currencies from banks and other sources. The Company primarily enters into debt obligations to support general corporate and local purposes including capital expenditures and working capital needs. The nature and amount of the Company's long-term debt can be expected to vary as a result of future business requirements, market conditions, and other factors. The principal interest rate risks to which the Company is exposed relate to the Company's investment portfolio and long-term debt obligations. The Company primarily utilizes fixed-rate debt and does not expect changes in interest rates to have a material effect on income or cash flows in 2000.

The functional currency of the Company's subsidiaries is generally the local currency. The Company's operating cash flows are denominated in various foreign currencies as a result of its international business activities and certain of its borrowings are exposed to changes in foreign exchange rates. The Company continually evaluates its foreign currency exposure based on current market conditions and the business environment. In order to mitigate the impact of changes in foreign currency exchange rates, the Company enters into forward exchange contracts. The magnitude and nature of such activities are explained further in Note 22 to the Consolidated Financial Statements.

The Company places its cash and cash equivalents with high credit quality financial institutions. The Company manages the credit risks associated with financial instruments through credit approvals, investment limits and centralized monitoring procedures but does not normally require collateral or other security from the parties to the financial instruments with off-balance sheet risk. The Company is averse to principal loss and manages the safety and preservation of its invested funds by limiting default risk, market risk and reinvestment risk.

The Company enters into forward contracts and foreign currency options to protect against the volatility of foreign currency exchange rates and to cover a portion of both its probable anticipated, but not firmly committed, transactions and transactions with firm foreign currency commitments. The risk of loss associated with purchased options is limited to premium amounts paid for the option contracts. The risk of loss associated with forward contracts is equal to the exchange rate differential from the date the contract is made until the time it is settled.

Forward contracts outstanding as of December 31, 1999 have remaining terms of one to 13 months, maturing mainly during first quarter 2000. The notional amounts of foreign exchange forward contracts totaled \$611,567 at December 31, 1999, and \$634,870 at December 31, 1998. The principal currencies covered are the Italian lira, the Japanese yen, the Euro, the British pound and the Swiss franc.

The Company does not anticipate any material adverse effect on its financial position, result of operations or cash flows resulting from the use of the Company's instruments in the future. There can be no assurance that these strategies will be effective or that transaction losses can be minimized or forecasted accurately. The Company does not use financial instruments for speculative or trading purposes.

The information below summarizes the Company's market risks associated with cash equivalents, debt obligations, and other significant financial instruments as of December 31, 1999. The information below should be read in conjunction with Notes 13 and 22 to the Consolidated Financial Statements.

The table below presents principal amounts and related weighted-average interest rates by year of maturity for the Company's investment portfolio and debt obligations (in thousands of U.S. dollars, except percentages):

	2000	2001	2002	2003	2004	Thereafter	TOTAL	Fair value at December 31, 1999
Assets: Cash equivalents Average interest rate Long-term debt:	1,823,086 6.18%						1,823,086 6.18%	1,823,086
Fixed rate Average interest rate	96,669 4.97%	86,976 5.54%	87,168 5.68%	9,688 4.25%	10,795 3.97%	1,153,850 2.20%	1,445,146 2.82%	2,845,234

	Amounts in thousands of U.S. dollars
Long-term debt by currency as of December 31, 1999: U.S. dollar Italian lira French franc Other currencies	1,157,366 192,432 82,993 12,355
TOTAL in U.S. dollars	1,445,146
	Amounts in thousands of U.S. dollars
Long-term debt by currency as of December 31, 1998: U.S. dollar Italian lira French franc Other currencies	455,885 231,752 98,628 14,844
TOTAL in U.S. dollars	801,109

The following table provides information about the Company's foreign exchange forward contracts at December 31, 1999 (in thousands of U.S. dollars):

Buy	Sell	Notional Amount	Average Contractual Forward Exchange Rat	
Foreign currency forward currencies:	exchange contracts to buy 1	U.S. dollars for foreign		
U.S. dollar U.S. dollar U.S. dollar	Euro British pound Italian lira	50,373 34,790 144,066	1.02 1.62 1,785.35	(943) 61 8,062
U.S. dollar	Malaysian ringgit	131,760	3.79	185
Total		360,989		7,365
Foreign currency forward currencies:	exchange contracts to buy :	Singapore dollars for foreign		
Singapore dollar	Euro	4,968	1.68	31
Singapore dollar	Japanese yen (1)	36,186	1.61	(410)
Singapore dollar	U.S. dollar	77,600	1.66	180
Total		118,754		(199)
Foreign currency forward	exchange contracts to buy 1	French francs for foreign		
currencies: French franc	U.S. dollar	43,000	6.43	(547)
FIGHCH ITANC	U.S. dollar	43,000	0.43	(347)
Total		43,000		(547)
Foreign currency forward currencies:	exchange contracts to buy a	Japanese yen for foreign		
Japanese yen	Euro	19,558	104.92	460
Japanese yen(1)	French franc	17,015	6.16	696
Total		36,573		1,156
Foreign currency forward Euro	exchange contracts to buy 1 Malaysian ringgit	Euro for foreign currencies: 781	3.85	(2)
Euro	U.S. dollar	23,000	1.02	379
Total		23,781		377
Foreign currency forward	exchange contracts to buy :			
currencies:	chonange concraces to baj	anios franco for foreign		
Swiss franc	French franc	2,706	4.09	(2)
Swiss franc	U.S. dollar	16,345	1.58	(236)
Total		19,051		(238)
	exchange contracts to buy :	Swedish kroners for foreign		
currencies: Swedish kroner	U.S. dollar	7,000	8.43	(56)
Total		7,000		(56)

Foreign currency forward exchange contracts to buy British pounds for foreign currencies:

British pound French franc	2,419 10.19	81
Total	2,419	81
TOTAL	611 , 567	7,939
 Forward exchange rate for 100 Japanese ye 		

Buy	Sell	Notional Amount	Average Contractual Forward Exchange Rate	Fair Value
		.S. dollars for foreign currencies		
		-		
U.S. dollar U.S. dollar	German mark Euro	47,910 1,757	1.70 1.19	(827) 26
U.S. dollar	French franc	10,000	5.53	118
U.S. dollar	Italian lira	121,832	1,738.98	(10,124)
U.S. dollar	Japanese yen	1,304	121.55	(79)
U.S. dollar U.S. dollar	Malaysian ringgit Spanish peseta	10,142 2,337	3.80 144.50	0(41)
Total	Spanion peseea	 195,282	111.00	(10,927)
IOCAL				
Foreign currency forward e currencies:	exchange contracts to buy Fi	rench francs for foreign		
French franc	Singapore dollar	1,136	0.30	(4)
French franc	U.S. dollar	130,000	5.60	(418)
Total		131,136		(422)
Poroign gurrongy forward o	exchange contracts to buy It			
currencies:	-	2		
Italian lira(1)	Singapore dollar	565	1.00	(5)
Italian lira Italian lira(1)	U.S. dollar Malaysian ringgit	115,000 62	1,662.10 2.35	187 0
	narayoran ringgre		2.00	
Total		115,627		182
	exchange contracts to buy Si	ingapore dollars for foreign		
currencies: Singapore dollar	Japanese yen(2)	25,653	1.39	(839)
Singapore dollar	U.S. dollar	78,000	1.64	(274)
Total		103,653		(1,113)
Foreign currency forward e currencies:	exchange contracts to buy Sw	wiss francs for foreign		
Swiss franc	French franc	2,851	4.11	(8)
Swiss franc	Italian lira	731	1,218.50	2
Swiss franc	Singapore dollar	202	1.23	(5)
Swiss franc	U.S. dollar	40,205	1.36	(404)
Total		43,989		(415)
Foreign currency forward e	exchange contracts to buy Ge	erman marks for foreign		
currencies:				
German marks German marks	Malaysian ringgit Singapore dollar	396 4,138	2.28	0 114
German marks	U.S. dollar	14,000	1.62	132
Total		18,534		246
-	exchange contracts to buy Eu			
Euro	French franc	8,503	6.58	(30)
Total		8,503		(30)
Poroign gurrongy forward o	exchange contracts to buy Ja			
currencies:	exchange contracts to buy of	apanese yen for foreign		
Japanese yen	French franc	5,652	21.69	380
Japanese yen	Italian lira	1,739 104	14.41 3.20	32 0
Japanese yen(2)	Malaysian ringgit		3.20	
Total		7,495		412
	exchange contracts to buy Ma	alaysian ringgit for foreign		
currencies: Malaysian ringgit	U.S. dollar	5,470	3.80	0
	-			
Total		5,470		0
	exchange contracts to buy Br	ritish pounds for foreign		
currencies: British pound	French franc	3,510	9.44	(32)
- <u>-</u>		-,		()

E	British pound	Italian lira	1,671	2,730.00	19
1	Total		5,181		(13)
2	TOTAL		634,870		(12,080)
(1) (2)		e for 1000 Italian lira e for 100 Japanese yen.			

Supervisory Board

The management of the Company is entrusted to the Management Board under the supervision of the Supervisory Board. The Supervisory Board advises the Management Board and is responsible for supervising the policies pursued by the Management Board and the general course of affairs of the Company and its business. In fulfilling their duties under Dutch law, the members of the Supervisory Board must serve the interests of the Company and its business.

The Supervisory Board consists of such number of members as is resolved by the general meeting of shareholders upon proposal of the Supervisory Board, with a minimum of six members. The members of the Supervisory Board are appointed upon proposal of the Supervisory Board by the general shareholders' meeting by a majority of the votes cast at a meeting where at least one-third of the outstanding share capital is present or represented.

Pursuant to various shareholders agreements, the membership of the Supervisory Board of the Company must include three members designated by the French shareholders from the Board of Directors of FT1CI (following the merger of FT2CI and FT1CI, a corporation owned by CEA-Industrie and France Telecom), and three members designated by the Italian shareholder. See "Item 4: Control of Registrant--Shareholder Agreements." The Supervisory Board of the Company currently includes two members who are not affiliated with ST Holding and its direct and indirect shareholders.

The members of the Supervisory Board appoint a chairman and vice chairman of the Supervisory Board from among the members of the Supervisory Board (with approval of at least three-quarters of the members of the Supervisory Board) and may appoint one or more members as a delegate supervisory director to communicate on a regular basis with the Management Board. Resolutions of the Supervisory Board require the approval of at least three-quarters of its members. The Supervisory Board must meet upon request by two or more of its members or by the Management Board. The Supervisory Board has adopted internal regulations to clarify the manner by which it carries out the supervisory duties imposed upon it by law, the Company's Articles of Association and resolutions of the shareholders and the Supervisory Board itself. By such resolution the Supervisory Board has authorized (i) the establishment of a secretariat (headed by an individual approved by it and appointed for a one-year renewable term) whose functions are to: (a) assist the Chairman and Vice Chairman of the Supervisory Board in the operations of the Board, (b) implement and oversee the execution within the Company of decisions adopted by the Supervisory Board, and (c) cooperate in and contribute to the execution of the functions of the designated Secretary and Assistant Secretary of the Supervisory Board; (ii) (a) the possibility of the appointment by the members of the Supervisory Board of assistants and (b) the appointment by such board of two controllers to exercise operational and financial control over the operations of the Company who, with assistants, will also review operation reports and the implementation of Supervisory Board decisions; and (iii) the establishment by the Supervisory Board of advisory committees. In addition, the Supervisory Board has established procedures for the preparation of Supervisory Board resolutions and the setting of the Board's calendar.

Members of the Supervisory Board must retire no later than at the ordinary general meeting of shareholders held after a period of three years following their appointment, but may be re-elected. A member of the Supervisory Board must retire at the ordinary general meeting of shareholders held in the year in which he reaches the age prescribed by Dutch law for retirement of a supervisory director (currently at age 72). Members of the Supervisory Board may be suspended or dismissed by the general meeting of shareholders. The Supervisory Board may make a proposal to the general meeting of shareholders for the suspension or dismissal of one or more of its members. The members of the Supervisory Board may receive compensation if authorized by the general meeting of shareholders.

The shareholders agreement between the group of French shareholders and the group of Italian shareholders, as shareholders of ST Holding, also includes certain provisions requiring the approval of the Supervisory Board of ST Holding for certain actions by ST Holding, the Company and its subsidiaries. In addition, pursuant to the shareholders agreement among the group of French shareholders and a decree issued by certain Ministries of The Republic of France, the approval by members of the Supervisory Board appointed by the French shareholders of certain actions to be taken by the Company or its subsidiaries requires the approval of the Board of Directors of FT1CI and is subject to a veto by certain Ministries of The Republic of France. These requirements for the prior approval of various actions to be taken by the Company and its subsidiaries may give rise to a conflict of interest between the interests of the Company and the individual shareholders approving such actions, and may result in a delay in the ability of the Management Board to respond as quickly as may be necessary in the rapidly changing environment of the semiconductor industry. Such approval process is subject to the provisions of Dutch law requiring members of the Supervisory Board to act independently in the supervision of the management of the Company.

The members of the Supervisory Board are:

Name	Position	Year Appointed	Age
Jean-Pierre Noblanc	Chairman	1994	61
Bruno Steve	Vice Chairman	1989	58
Tom de Waard	Member	1998	53
Remy Dullieux	Member	1993	49
Riccardo Gallo	Member	1997	56
Francis Gavois	Member	1998	64
Alessandro Ovi	Member	1994	56
Robert M. White	Member	1996	61

Jean-Pierre Noblanc has been the Chairman of the Supervisory Board since May 31, 1999, and has been a member of the Supervisory Board since 1994. He served as Vice Chairman of the Supervisory Board from June 1996 to May 31, 1999. Mr. Noblanc is presently General Manager of the Components Sector of CEA Industrie. Prior to joining CEA Industrie, Mr. Noblanc served at CNET, the Research Center of France Telecom, as Director of the Applied Research Center of Bagneux and of the Microelectronics Center of Grenoble. Mr. Noblanc holds a degree in engineering from the Ecole Superieure d'Electricite and a doctoral degree in physical sciences from the University of Paris. Mr. Noblanc is an Associate Member of the Committee on Applications of the French Academy of Sciences and a director of Thomson S.A. Mr. Noblanc also serves on the Board of Directors of CEA Industrie, FTICI and Picoqiqa S.A.

Bruno Steve has been a member of the Company's Supervisory Board since 1989 and its Chairman until May 31, 1999. He served as Vice Chairman of the Supervisory Board from 1989 to July 1990. From July 1990 to March 1993, Mr. Steve served as Chairman of the Supervisory Board. He has been with I.R.I., Finmeccanica's parent company, Finmeccanica and other affiliates of I.R.I. in various senior positions for over 17 years. Mr. Steve is currently President of the board of statutory auditors of Alitalia S.p.a., Italia Express S.p.a. and Iritecna S.p.a. in liquidazione and member of statutory auditors of Stretto di Messina S.p.A. and Sigma S.p.A. Until December 1999, he served as Chairman of MEI. He served as the Chief Operating Officer of Finmeccanica from 1988 to July 1997 and Chief Executive Officer from May 1995 to July 1997. He was Senior Vice President of Planning, Finance and Control of I.R.I. from 1984 to 1988. Prior to 1984, Mr. Steve served in several key executive positions at Telecom Italia, I.R.I.'s holding company for the telecommunications sector.

Tom de Waard was appointed to the Supervisory Board in 1998. Mr. de Waard is a partner of Clifford Chance, a leading English law firm, since March 2000. Prior to that, he was a partner at Stibbe, Simont, Monahan, & Duhot, where he has held several positions since 1979 and has gained extensive experience working with major international companies, particularly with respect to corporate finance. He is a member of the Amsterdam bar and received his law degree from Leiden University in 1979.

Remy Dullieux has been a member of the Supervisory Board since 1993. He is a graduate of the Ecole Polytechnique. Since June 1996, Mr. Dullieux has served as a France Telecom Executive Manager for the Northern and Eastern areas of France. From 1991 to June 1996, Mr. Dullieux served as Group Executive Vice President for Strategic Procurement and Development of France Telecom. From 1985 to 1988, Mr. Dullieux served as Regional Manager of Creteil. Mr Dullieux also serves on the Board of Directors of FTICI.

Riccardo Gallo was appointed to the Supervisory Board in 1997. He is Associate Professor of Industrial Economics at the Engineering Faculty of "La Sapienza" University in Rome. He has also been a member of the board of directors of Comitato Sir from 1981 until the present. From 1982 to 1991, he served as Director General at the Italian Ministry of the National Budget. In the early 1990s, he served as Vice Chairman of I.R.I. In 1994, he was appointed by the Italian Minister of Industry as Extraordinary Commissioner of Fidia, a research-oriented pharmaceutical company.

Francis Gavois was appointed to the Supervisory Board in 1998. Mr. Gavois is the Chairman of the Supervisory Board of ODDO et Cie. He is also a member of the Board of Directors of Plastic Omnium, FT1CI and the Supervisory Board of the Consortium de Realisation (CDR). From 1984 to 1997, Mr. Gavois held several positions, including Chairman of the Board of Directors and President of Banque Francaise du Commerce Exterieur (BFCE). Prior to that time Mr. Gavois held positions in the French government. He is Inspecteur des Finances and a graduate of the Institut d'Etudes Politiques de Paris and the Ecole Nationale d'Administration.

Alessandro Ovi has been a member of the Supervisory Board since 1994. He received a doctoral degree in Nuclear Engineering from the Politecnico in Milan and a masters degree in operations research from Massachusetts Institute of Technology. He currently serves on the boards Italtel, Carnegie Mellon University and Corporation Development Committee of the Massachusetts Institute of Technology. Until April 2000, Mr. Ovi was the Chief Executive Officer of Tecnitel S.p.a., a subsidiary of Telecom Italia Group. Prior to joining Tecnitel S.p.A., Mr. Ovi was the Senior Vice President of International Affairs and Communications at I.R.I.

Robert M. White was appointed to the Supervisory Board in June 1996. Mr. White is a University Professor and Director of the Data Storage Systems Center at Carnegie Mellon University and serves as a member of several corporate boards, including those of Ontrack Data Systems, Inc., and Read-Rite, Inc. He is a member of the U.S. National Academy of Engineering. From 1990 to 1993, Mr. White served as Under Secretary of Commerce for Technology in the United States Government. Prior to 1990, Mr. White served in several key executive positions at Xerox Corporation, Control Data Corporation and MCC. He received a doctoral degree in physics from Stanford University and graduated with a degree in physics from Massachusetts Institute of Technology.

The Supervisory Board has established an Audit Committee currently chaired by Mr. de Waard and also comprised of Messrs. Gavois, Ovi and White, a Compensation Committee comprised of the Chairman (Mr. Noblanc), the Vice Chairman (Mr. Steve) and an independent director (Mr. White) and a Strategic Committee comprised of Messrs. Noblanc and Steve.

Management Board

The management of the Company is entrusted to the Management Board under the supervision of the Supervisory Board. Under the Articles of Association, the Management Board must obtain prior approval from the Supervisory Board for (i) all proposals to be submitted to a vote at the general meeting of shareholders; (ii) the formation of all companies, acquisition or sale of any participation, and conclusion of any cooperation and participation agreement; (iii) all multi-year plans of the Company and the budget for the coming year, covering investment policy, policy regarding research and development, as well as commercial policy and objectives, general financial policy, and policy regarding personnel; and (iv) all acts, decisions or operations covered by the foregoing and constituting a significant change with respect to decisions already taken by the Supervisory Board. The Management Board must seek approval from the general meeting of shareholders for decisions relating to (i) the sale of all or of an important part of the Company's assets or concerns; and (ii) all mergers, acquisitions or joint ventures which the Company wishes to enter into and which the Supervisory Board considers to be of material significance. In addition, under the Articles of Association, the Supervisory Board may specify by resolution certain actions by the Management Board that require its prior approval. Following the adoption of such a resolution, the actions by the Management Board requiring such prior approval include the following: (i) modification of its Articles of Association; (ii) change in its authorized share capital, issue, acquisition or disposal of its own shares, change in any shareholder rights or issue of any instruments granting an interest in its capital or profits; (iii) liquidation or disposal of all or a substantial and material part of its assets or any shares it holds in any of its subsidiaries; (iv) entering into any merger, acquisition or joint venture agreement (and, if substantial and material, any agreement relating to intellectual property) or formation of a new company; (v) approval of such company's draft consolidated balance sheets and financial statements or any profit distribution by such company; (vi) entering into any agreement with any of the direct or indirect French or Italian shareholders outside the normal course of business; (vii) submission of documents reporting on (a) approved policy, expected progress and results and (b) strategic long-term business plans and consolidated annual budgets or any modifications to such; (viii) preparation of long-term business plans and annual budgets; (ix) adoption and implementation of such long-term business plans and

annual budgets; (x) approval of all operations outside the normal course of business, including operations already provided for in the annual budget; and (xi) approval of the quarterly, semi-annual and annual consolidated financial statements prepared in accordance with internationally accepted accounting principles. Such resolution also requires that the Management Board obtain prior approval from the Supervisory Board for (i) the appointment of the members of the statutory management, administration and control bodies of the Company's French and Italian subsidiaries; and (ii) the nomination of the statutory management, administration and control bodies of the Company and each of the Company's other direct and indirect subsidiaries followed by confirmation to the Supervisory Board of such nominees' appointments. The general meeting of shareholders may also specify certain actions of the Management Board that require shareholder approval. The Company's Articles of Association provide that the Management Board must obtain shareholder approval prior to (i) the sale of all or an important part of the Company's assets and concerns; and (ii) all mergers, acquisitions or joint ventures which the Company wishes to enter into and which the Supervisory Board considers to be of material significance. See "Item 1: Description of Business" and "Item 13: Interest of Management in Certain Transactions.'

The Management Board shall consist of such number of members as resolved by the general meeting of shareholders upon the proposal of the Supervisory Board. The members of the Management Board are appointed for three year terms upon proposal by the Supervisory Board at the general shareholders' meeting by a majority of the votes cast at a meeting where at least one-third of the outstanding share capital is present or represented. The Supervisory Board appoints one of the members of the Management Board to be chairman of the Management Board (upon approval of at least three-quarters of the members of the Supervisory Board). Resolutions of the Management Board require the approval of a majority of its members. Mr. Pasquale Pistorio, the Company's President and Chief Executive Officer, is currently the sole member of the Management Board. His term expires in 2002.

The general meeting of shareholders may suspend or dismiss one or more members of the Management Board at a meeting at which at least one-half of the outstanding share capital is present or represented. No quorum is required if a suspension or dismissal is proposed by the Supervisory Board. The Supervisory Board may suspend members of the Management Board, but a general meeting of shareholders must be convened within three months after such suspension to confirm or reject the suspension. The Supervisory Board shall appoint one or more persons who shall, at any time, in the event of absence or inability to act of all the members of the Management Board, be temporarily responsible for the management of the Company. Upon delegation from the Supervisory Board, the Compensation Committee determines the compensation and other terms and conditions of employment of the members of the Management Board.

Executive Officers

The executive officers of the Company support the Management Board in its management of the Company, without prejudice to the Management Board's ultimate responsibility. The Company is organized in a matrix structure with geographical regions interacting with product divisions, bringing all levels of management closer to the customer and facilitating communication among research and development, production, marketing and sales organizations. The executive officers of the Company are:

Name	Position	Years with Company(1)	Years in Semiconductor Industry	Age
Pasquale Pistorio	President and Chief Executive Officer	20	36	64
Georges Auguste	Corporate Vice President, Total Quality and Environmental Management	13	26	51
Laurent Bosson	Corporate Vice President, Front-end Manufacturing	17	17	57
Carlo Bozotti	Corporate Vice President, Memory Products Group	23	23	47
Salvatore Castorina	Corporate Vice President, Discrete and Standard ICs Group	18	34	63

Name	Position	Years with Company(1)	Semiconductor Industry	Age
Alain Dutheil	Corporate Vice President, Strategic Planning and Human Resources	17	30	55
Philippe Geyres	Corporate Vice President, Consumer and Microcontroller Group	16	24	48
Maurizio Ghirga	Corporate Vice President, Chief Financial Officer	17	17	62
Jean-Claude Marquet	Corporate Vice President, Asia/Pacific Region	14	33	58
Pier Angelo Martinotti	Corporate Vice President, New Ventures Group	19	32	59
Joel Monnier	Corporate Vice President, Central Research and Development	17	26	54
Piero Mosconi	Corporate Vice President, Treasurer	36	36	60
Carmelo Papa	Corporate Vice President, Region Five	16	16	51
Richard Pieranunzi	Corporate Vice President, Americas Region	19	34	61
Aldo Romano	Corporate Vice President, Telecommunications, Peripherals and Automotive Group	35	35	59
Giordano Seragnoli	Corporate Vice President, Back-end Manufacturing and Subsystems Products Group	35	37	63
Keizo Shibata	Corporate Vice President, Japan Region	8	35	63
Enrico Villa	Corporate Vice President, European Region	32	32	59

Years in

(1) Including years with Thomson Semiconducteurs or SGS Microelettronica.

Pasquale Pistorio has more than 36 years of experience in the semiconductor industry. After graduating in Electrical Engineering from the Polytechnical University of Turin in 1963, he started his career selling Motorola products. Mr. Pistorio joined Motorola in 1967, becoming Director of World Marketing in 1977 and General Manager of the International Semiconductor Division in 1978. Mr. Pistorio joined SGS Microelettronica as President and Chief Executive Officer in 1980 and became President and Chief Executive Officer of the Company upon its formation in 1987.

Georges Auguste has served as Corporate Vice President, Total Quality and Environmental Management since 1999. Mr. Auguste received a degree in engineering from the Ecole Superieure d'Electricite (SUPELEC) in 1974 and a diploma in business administration from the Caen University in 1976. Prior to joining the Company, Mr. Auguste worked with Philips Components from 1974 to 1986, in various positions in the field of manufacturing. From 1990 to 1997 he headed the Company's operations in Morocco and from 1997 to 1999 Mr. Auguste served as director of Total Quality and Environmental Management.

Laurent Bosson has served as Corporate Vice President, Front-end Manufacturing and VLSI Fabs since 1989 and from 1992 to 1996 he was given additional responsibility as President and Chief Executive Officer of the Company's operations in the Americas. Mr. Bosson received a Masters degree in Chemistry from the University of Dijon in 1969. He joined Thomson-CSF in 1964 and has held several positions in engineering and manufacturing. In 1982, Mr. Bosson was appointed General Manager of the Tours and Alencon facilities of Thomson Semiconducteurs. In 1985, he joined the French subsidiary of SGS Microelettronica as General Manager of the Rennes, France manufacturing facility.

Carlo Bozotti has served as Corporate Vice President, Memory Products since August 1998. Mr. Bozotti joined SGS Microelettronica in 1977 after graduating in Electronic Engineering from the University of Pavia. Mr. Bozotti served as Product Manager for the Industrial, Computer Peripheral and Telecom divisions and as Product

Manager for the Monolithic Microsystems' Telecom business unit from 1986 to 1987. He was appointed Director of Corporate Strategic Marketing and Key Accounts for the Headquarters Region in 1988 and became Vice President, Marketing and Sales, Americas Division in 1991. Mr. Bozotti has served as Corporate Vice President, Memory Products since August 1998, after having served as Corporate Vice President, Europe and Headquarters Region from 1994 to 1998.

Salvatore Castorina has served as Corporate Vice President, Discrete and Standard ICs Group since 1989. Mr. Castorina received his engineering degree in Electronics from the Polytechnical University of Turin and began his career as a teacher of electrical and electronic technologies prior to joining Thomson-CSF in Milan in 1965. In 1967, he joined Motorola Semiconductors and held various positions in sales and marketing. In 1981, Mr. Castorina joined the Company as General Manager of Transistors in Catania and became the General Manager of the Company's Discrete Division in 1989.

Alain Dutheil has served as Corporate Vice President, Strategic Planning and Human Resources since 1994 and 1992, respectively. Mr. Dutheil is also President of the Company's French subsidiary. After graduating in Electrical Engineering from the Ecole Superieure d'Ingenieurs de Marseilles (ESIM), Mr. Dutheil joined Texas Instruments in 1969 as a Production Engineer, becoming Director for Discrete Products in France and Human Resources Director for Texas Instruments, France in 1980 and Director of Operations for Texas Instruments, Portugal in 1982. He joined Thomson Semiconducteurs in 1983 as General Manager of a plant in Aix-en-Provence, France and then became General Manager of the Company's Discrete Products Division. From 1989 to 1994, Mr. Dutheil served as Director for Worldwide Back-end Manufacturing, in addition to serving as Corporate Vice President for Human Resources from 1992 until the present.

Philippe Geyres has served as Corporate Vice President, General Manager Consumer and Microcontroller Group (formerly Programmable Products Group) since 1990. Mr. Geyres graduated from the Ecole Polytechnique in 1973 and began his career with IBM in France before joining Schlumberger Group in 1980 as Data Processing Director. He was subsequently appointed Deputy Director of the IC Division at Fairchild Semiconductors. Mr. Geyres joined Thomson Semiconducteurs in 1983 as Director of the Bipolar Integrated Circuits Division. He was appointed Strategic Programs Director in 1987 and, later the same year, became Corporate Vice President, Strategic Planning of the Company.

Maurizio Ghirga became Corporate Vice President, Chief Financial Officer in 1987, after having served as chief financial controller of SGS Microelettronica since 1983. Mr. Ghirga has a degree in Business Administration from the University of Genoa. He spent more than ten years of his career in various financial capacities at ESSO Company (an Exxon subsidiary in Italy) and prior to joining the Company was Financial Controller of one of the largest refinery plants in Italy and of an ESSO chemical subsidiary.

Jean-Claude Marquet has served as Corporate Vice President, Asia/Pacific Region since July 1995. After graduating in Electrical and Electronics Engineering from the Ecole Breguet Paris, Mr. Marquet began his career in the French National Research Organisation and later joined Alcatel. In 1969, he joined Philips Components. He remained at Philips until 1978, when he joined Ericsson, eventually becoming President of Ericsson's French operations. In 1985, Mr. Marquet joined Thomson Semiconducteurs as Vice President Sales and Marketing, France. Thereafter, Mr. Marquet served as Vice President Sales and Marketing for France and Benelux, and Vice President Asia Pacific and Director of Sales and Marketing for the region.

Pier Angelo Martinotti has served as Corporate Vice President, General Manager New Ventures Group since 1994. A graduate in Electronic Engineering from the Polytechnical University of Turin, Mr. Martinotti began his career at the Company in 1965 as an Application and Marketing Engineer. In 1968, he joined Motorola Semiconductors in the area of strategic marketing in Europe, and in 1975 became the Marketing (Sales) Director for Europe. From 1986 to 1990, Mr. Martinotti was Chief Executive Officer of Innovative Silicon Technology, a former subsidiary of the Company. Mr. Martinotti was appointed Director of Corporate Strategic Planning in 1990.

Joel Monnier has served as Corporate Vice President, Director of Central Research and Development since 1989. After graduating in Electrical Engineering from the Institut National Polytechnique of Grenoble, Ecole Nationale Superieure de Radio Electricite, Mr. Monnier obtained a doctoral degree in microelectronics at LETI/CENG. He began his career in the semiconductor industry in 1968 as a researcher with CENG, and subsequently joined the research and development laboratories of Texas Instruments in Villeneuve Loubet, France and Houston, Texas, eventually becoming Engineering Manager and Operation Manager at Texas Instruments. Mr. Monnier joined Thomson-CSF in 1983 as head of the research and manufacturing unit of Thomson Semiconducteurs. In 1987, he was appointed Vice President and Corporate Director of Manufacturing.

Piero Mosconi has served as Corporate Vice President, Treasurer since 1987. After graduating in accounting from Monza in 1960, Mr. Mosconi joined the faculty at the University of Milan. Mr. Mosconi worked with an Italian bank before joining the Foreign Subsidiaries Department at SGS Microelettronica in 1964 and becoming Corporate Director of Finance in 1980.

Carmelo Papa has served as Corporate Vice President, Region Five since January 2000. Mr . Papa received his degree in nuclear physics at Catania University. Mr. Papa joined the Company in 1983 and since 1986 has been Director of Product Marketing and Customer Service for Transistors and Standard ICs. During this time, he has overseen a substantial growth both in the product portfolio and the sales volume. He has also played a key role both in the expansion of the Company's facility in Catania, Italy, from its origin as a low-cost assembly plant to its present position as one of the Company's most important and dynamic centres, hosting advanced R&D in areas ranging from process technology to fuzzy logic and other "soft computing" disciplines, leading-edge wafer manufacturing and Sales and Marketing HQ for the Company's Discrete and Standard Circuits division.

Richard Pieranunzi has served as Corporate Vice President, Americas Region since August 1996. Mr. Pieranunzi received his BSEE from the University of Rhode Island, and started his career in process engineering. Later, he joined Motorola's international marketing organization, including in Europe where he held management positions in sales and strategic marketing and applications. Mr. Pieranunzi joined SGS Semiconducteurs in 1981 as Marketing and Sales Manager and, upon the formation of the Company in 1987, he became Vice President Marketing and Sales for the U.S. organization. For three years, Mr. Pieranunzi headed the Company's Corporate Strategic Marketing and Corporate Key Account programs.

Aldo Romano has served as Corporate Vice President, General Manager Telecommunications, Peripherals and Automotive Group (formerly Dedicated Products Group) since 1987. Mr. Romano is also Managing Director of the Company's Italian subsidiary. A graduate in Electronic Engineering from the University of Padua in 1963, Mr. Romano joined SGS Microelettronica in 1965 as a designer of linear ICs, becoming head of the linear IC design laboratory in 1968 and head of Marketing and Applications in 1976. Mr. Romano became Director of the Bipolar IC Division (which has evolved into the Dedicated Products Group) in 1980.

Giordano Seragnoli has served as Corporate Vice President, General Manager Subsystems Products Group since 1987 and since 1994, Director for Worldwide Back-end Manufacturing. After graduating in Electrical Engineering from the University of Bologna, Mr. Seragnoli joined the Thomson Group as RF Application Designer in 1962 and joined SGS Microelettronica in 1965. Thereafter, Mr. Seragnoli served in various capacities within the Company, including Strategic Marketing Manager and Subsystems Division Manager, Subsystems Division Manager (Agrate), Technical Facilities Manager, Subsystems Division Manager and Back-End Manager.

Keizo Shibata has served as Corporate Vice President and President of the Company's Japanese subsidiary since 1992. Mr. Shibata obtained bachelors and masters degrees in Engineering from Osaka University and has 31 years of experience in the semiconductor industry. Prior to joining the Company, Mr. Shibata was employed with Toshiba Corporation since 1964 in various capacities. From 1987 to 1988, Mr. Shibata served as Chairman of both World Semiconductor Trade Statistics and the Trade Policy Committee of the Electric Industry Association of Japan.

Enrico Villa has served as Corporate Vice President, Region Five since January 1, 1998. Mr. Villa has served in various capacities within the Company since 1968 after obtaining a degree in Business Administration from the University of Genoa and has 30 years of experience in the semiconductor industry. He is currently a member of the European Electronics Component Association ("EECA") for which he is now Chairman of the European Semiconductor Council as well as Chairman for Europe at the Joint Steering Committee of the World Semiconductor Council. As is common in the semiconductor industry, the Company's success depends to a significant extent upon, among other factors, the continued service of its key senior executives and research and development, engineering, marketing, sales, manufacturing, support and other personnel, and on its ability to continue to attract, retain and motivate qualified personnel. The competition for such employees is intense, and the loss of the services of any of these key personnel without adequate replacement or the inability to attract new qualified personnel could have a material adverse effect on the Company. The Company does not maintain insurance with respect to the loss of any of its key personnel.

Item 11: Compensation of Directors and Officers

The aggregate cash compensation payable for 1999 to the members of the Supervisory Board by the Company was approximately \$460,000. The amount of cash compensation for 1999 paid to the executive officers of the Company and members of the Management Board as a group by the Company and its subsidiaries was approximately \$8.5 million.

In 1989, the Company established a Corporate Executive Incentive Program (the "EIP") that entitles selected executives and members of the Management Board to a yearly bonus based upon the individual performance of such executives. The maximum bonus awarded under the EIP is based upon a percentage of the executive's or member's salary and is adjusted to reflect the overall performance of the Company. The participants in the EIP must satisfy certain personal objectives that are focused on customer service, profit, cash flow and market share.

The executive officers and the Management Board were also covered in 1999 under certain group life and medical insurance programs provided by the Company. The aggregate additional amount set aside by the Company in 1999 to provide pension, retirement or similar benefits for executive officers and the Management Board of the Company as a group is estimated to have been approximately \$3.3 million.

Item 12: Options to Purchase Securities from Registrant or Subsidiaries

Stock Option Plans

The following description of the Company's stock options plans has been adjusted for the 2:1 stock split effected on June 16, 1999 and the 3:1 stock split effected on May 5, 2000. Taking into account these stock splits, the total options outstanding as of May 27, 2000 give the right to acquire 19,945,300 Common Shares by its employees and 319,500 Common Shares by members and professionals of the Supervisory Board.

All options to purchase Common Shares under the Company's first stock option plan (the "1989 Stock Option Plan") expired on December 18, 1999.

On October 20, 1995, the shareholders of the Company approved resolutions authorizing the Supervisory Board for a period of five years to adopt and administer a new stock option plan which provides for the granting to managers and professionals of the Company of options to purchase up to a maximum of 33.0 million Common Shares (the "1995 Stock Option Plan"). The Company has granted options to acquire a total of 23,851,200 shares pursuant to the 1995 Stock Option Plan as follows:

- The Company granted options to purchase 7,200,000 Common Shares with an exercise price per Common Share of \$6.04. All such options will expire on March 1, 2004. As of May 27, 2000, options to purchase 3,352,910 shares were outstanding.
- The Company granted options to purchase 3,873,000 Common Shares with an exercise price per Common Share of \$14.23, which will expire on September 12, 2005. As of May 27, 2000, options to purchase 3,805,050 shares were outstanding.
- o The Company granted options to purchase 3,900,000 Common Shares with an exercise price per Common Share of \$12.03, which will expire on July 28, 2006. As of May 27, 2000, options to purchase 3,861,300 shares were outstanding.
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The Company granted options to purchase 8,878,200 Common Shares with an exercise price per Common Shares of \$24.88, which will expire on September 16, 2007. As of May 27, 2000, options to purchase 8,779,200 shares were outstanding.

The Company also made a special grant of options under the 1995 Stock Option Plan to former employees of Arithmos, a company which designs controller ICs for flat panel displays and LCD monitors with an exercise price of \$55.25 and which will expire on January 24, 2008. As of May 27, 2000, options to purchase 126,840 shares were outstanding pursuant to this grant.

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As of May 27, 2000, of the total options outstanding under the 1995 Stock Option Plan, options to purchase 4,868,280 shares were held by executive officers as a group.

In June 1996, the general meeting of shareholders approved the granting of options to members and professionals of the Supervisory Board which correspond to the right to purchase approximately 432,000 Common Shares of the Company over a period of three years, beginning in 1996. The following options have been granted:

- o In 1996, the Company granted to members and professionals of the Supervisory Board options to purchase 198,000 Common Shares with an exercise price per Common Share of \$9.00, which will expire on October 22, 2004. As of May 27, 2000, options to purchase 63,000 shares were outstanding.
- o In 1997, the Company granted to members and professionals of the Supervisory Board options to purchase 90,000 Common Shares with an exercise price per Common Share of \$14.23, which will expire on September 12, 2005. As of May 27, 2000, options to purchase 31,500 shares were outstanding.
- o In 1998, the Company granted to members and professionals of the Supervisory Board options to purchase 90,000 Common Shares with an exercise price per Common Share of \$12.03, which will expire on July 28, 2006. As of May 27, 2000, options to purchase 45,000 shares were outstanding.

In 1999, the general meeting of the shareholders voted to renew the Supervisory Board Option Plan whereby members of the Supervisory Board may receive, during the three-year period 1999-2001, at least the same number of options as were granted during the first three-year period. The following options have been granted:

> o The Company granted options to members and professionals of the Supervisory Board to purchase 180,000 Common Shares with an exercise price per Common Share of \$24.88 which will expire on September 16, 2007. As of May 27, 2000, options to purchase 180,000 shares were outstanding.

Item 13: Interest of Management in Certain Transactions

The Company has formed a joint venture research and development center with France Telecom R&D in the form of a GIE. France Telecom R&D is a research laboratory that is wholly owned by France Telecom, one of the indirect shareholders of the Company. See "Item 1: Description of Business--Research and Development" and "Item 4: Control of Registrant." The research center is housed at the Company's Crolles, France manufacturing facility, and is developing submicron process technologies. The joint venture between the Company and France Telecom R&D was created in 1990 before France Telecom became an indirect shareholder of the Company.

The Company has signed an agreement providing for a research and development cooperation with GRESSI, the research and development GIE formed by France Telecom R&D and LETI, a research laboratory that is a department of CEA-Industrie, the parent of one of the indirect shareholders of the Company. See "Item 4: Control of Registrant." The objectives of the cooperation is to develop basic know-how on innovative aspects of VLSI technology evolution which can be transferred to industrial applications, and to address the development of innovative process steps and process modules to be used in future generations of VLSI products. The cooperation agreement was based upon a multi-year plan through 1998, of which the Company bore half of the total cost. The cooperation with GRESSI was superseded, as of January 1, 1999, by a tripartite cooperation arrangement between the Company, France Telecom R&D and LETT, within the framework of an extended GIE named Centre Commun de Microelectronique de Crolles. This cooperation is directed towards sub 0.18 micron technologies with a view to preparing the technology to begin production of 12-inch wafers and associated wafer fabrication processes. The tripartite cooperation is intended to last until the end of 2002.

The Company participates in certain programs sponsored by the French and Italian governments for the funding of research and development and industrialization through direct grants as well as low interest financing. See "Item 1: Description of Business--Public Funding." The shareholders of ST Holding, the corporate parent of the Company's principle shareholder, are controlled, directly or indirectly, by the governments of the Republics of France and Italy. See "Item 4: Control of Registrant."

Sales to shareholders of the Company and their affiliates totaled $19.0\ million$ in 1999.

PART II

Item 14: Description of Securities to be Registered

Not applicable.

PART III

Item 15: Default Upon Senior Securities

None.

Item 16: Changes in Securities and Changes in Security for Registered Securities and Use of Proceeds

On April 26, 2000, the Company's shareholders approved a 3:1 stock split, changing the par value of each Common Share to EUR 1.04. The changes became effective May 5, 2000. After these changes and as of May 27, 2000 the Company's authorized share capital was EUR 1,809,600,000 consisting of 1,200,000,000 Common Shares and 540,000,000 Preference Shares of EUR 1.04 nominal value each.

PART IV

Item 17: Financial Statements

Not applicable.

Item 18: Financial Statements

See "Item 19: Financial Statements and Exhibits" for a list of financial statements filed pursuant to this Item 18.

With the exception of the items incorporated by reference elsewhere in this annual report, the 1999 Annual Report is not deemed to be filed as part of this annual report.

(a) Financial Statements

The financial statements, together with the report thereon of PricewaterhouseCoopers N.V. dated January 25, 2000, appearing on pages 44-59 of the 1999 Annual Report, are incorporated herein by reference.

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±		
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or notes thereto.						
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(b) Exhibits

- 1.1 Articles of Association, as amended as of May 5, 2000, of the Company
- 2.1 Subsidiaries of the Company (see Note 3 to the Consolidated Financial Statements)
- 2.2 Consent of PricewaterhouseCoopers N.V.
- 99.1 Pages 34 to 59 of the 1999 Annual Report, submitted to the Securities and Exchange Commission as a Report on Form 6-K by STMicroelectronics N.V. on June 19, 2000. With the exception of the information on these pages, the 1999 Annual Report is not deemed filed as part of this annual report on Form 20-F.

ASD	application-specific discrete technology
ASIC	application-specific IC
ASSP	application-specific standard product
ATM	asynchronous transfer mode
BCD	bipolar, CMOS and DMOS process technology
BiCMOS	bipolar and CMOS process technology
CAD	computer aided design
CIM	computer integrated manufacturing
CMOS	complementary metal oxide silicon
DMOS	diffused metal oxide silicon
DRAMS	dynamic random access memory
DSP	digital signal processor
EMAS	The Eco-Management and Audit Scheme (EAMS) is the voluntary European
	Community scheme for companies performing industrial activities for the
	evaluation and improvement of environmental performance
EEPROM	electrically erasable programmable read-only memory
EPROM	erasable programmable read-only memory
GPS	global positioning system
HCMOS	high-speed complementary metal-oxide-silicon
IC	integrated circuit
IGBT	insulated gate bipolar transistors
ISDN	integrated services digital network
JavaCard(TM)applets	application software for smartcard developed on Java platform
Java	operating system developed by Sun Microsystems
Kbit	Kilobit
Mbit	Megabit
MCUs	microcontroller units
MIPS	million instructions per second
MOS	metal oxide silicon process technology
MOSFET	metal oxide silicon field effect transistor
MPEG	motion picture experts group
NVRAM	nonvolatile SRAM
OEM	original equipment manufacturer
ОТР	one-time programmable
PROM	programmable read-only memory
RAM	random access memory
RF	radio frequency
RISC	reduced instruction set computing
ROM	read-only memory
SAM	serviceable available market
SLIC	subscriber line interface card
SPC	statistical process control
SRAM	static random access memory
STB	set-top box
TAM	total available market
VLSI	very large scale integration
VoIP	Voice over Internet protocol

SIGNATURES

Pursuant to the requirements of Section 12 of the Securities Exchange Act of 1934, the registrant certifies that it meets all of the requirements for filing on Form 20-F and has duly caused this annual report to be signed on its behalf by the undersigned, thereunto duly authorized.

STMICROELECTRONICS N.V.

Date: June 27, 2000

STMICROELECTRONICS N.V. VALUATION AND QUALIFYING ACCOUNTS (Currency - Thousands of U.S. dollars)

Valuation and qualifying accounts	Balance as beginning	Translation	Charged to costs and		Balance at end of
deducted from the related asset accounts	of period	adjustment	expenses	Deductions	period
1999					
Inventories Accounts Receivable	53,955 10,494	(452)	42,137 1,662	(53,955) (114)	42,137 11,590
1998 Inventories Accounts Receivable	68,182 15,228	 89	53,955 (3,741)	(68,182) (1,082)	53,955 10,494
1997 Inventories Accounts Receivable	45,176 18,152	 (1,902)	68,182 7	(45,176) (1,029)	68,182 15,228

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Report of Independent Accountants on Financial Statement Schedule

To the Supervisory Board and Shareholders of STMicroelectronics N.V.

Our audits of the consolidated financial statements referred to in our report dated January 25, 2000 appearing on page 59 of the 1999 Annual Report to Shareholders of STMicroelectronics N.V. (which report and consolidated financial statements are incorporated by reference in this Annual Report on Form 20-F) also included an audit of the financial statement schedule listed in Item 19 of this Form 20-F. In our opinion, this financial statement schedule presents fairly, in all material respects, the information set forth therein when read in conjunction with the related consolidated financial statements.

PricewaterhouseCoopers N.V.

Amsterdam, The Netherlands January 25, 2000

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	Name	Page
1.1	Articles of Association, as amended as of May 5, 2000, of the Company	
2.2	Consent of PricewaterhouseCoopers N.V	
99.1	Pages 34 to 59 of the 1999 Annual Report, submitted to the Securities and Exchange Commission as a Report on Form 6-K by STMicroelectronics N.V. on June 19, 2000	

ARTICLES OF ASSOCIATION of: STMicroelectronics N.V., established in Amsterdam dated May 5, 2000

NAME, SEAT AND DURATION. _____ Article 1. _____ 1.1. The name of the company is: STMicroelectronics N.V. 1.2. The company is established at Amsterdam. 1.3. The company will continue for an indefinite period. OBJECTS. _____ Article 2. _____ The objects of the company shall be to participate or take in any manner any interests in other business enterprises, to manage such enterprises, to carry on the business in semi-conductors and electronic devices, to take and grant licenses and other industrial property interests, assume commitments in the name of any enterprises with which it may be associated within a group of companies, to take financial interests in such enterprises and to take any other action which in the broadest sense of the term, may be related or contribute to the aforesaid objects. SHARE CAPITAL. Article 3. _____ 3.1. The authorised capital of the company amounts to one billion eight hundred nine million six hundred thousand euro (EUR 1,809,600,000), consisting of

one billion two hundred million (1,200,000,000) ordinary shares and five hundred forty million (540,000,000) preference shares of one euro and four eurocents (EUR 1.04) each.

Where in these articles of association reference is made to shares and shareholders this shall include the shares of each class as well as the holders of shares of each class respectively, unless explicitly provided otherwise.

ISSUE OF SHARES.

Article 4.

4.1.	The supervisory board shall have the power to issue shares and to determine the terms and conditions of such issue if and in so far
	as the supervisory board has been designated by the general meeting
	of shareholders as the authorized body for this purpose. A
	designation as referred to above shall only take place for a
	specific period of no more than five years and may not be extended
	by more than five years on each occasion.
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- 4.2. If a designation as referred to in the first paragraph is not in force, the general meeting of shareholders shall have the power, upon the proposal of and on the terms and conditions set by the supervisory board to resolve to issue shares.
- 4.3. In the event of an issue of ordinary shares, shareholders shall have a pre-emptive right in proportion to the number of ordinary shares which they own, notwithstanding the provisions of the law. In respect of the issue of shares there shall be no pre-emptive right to shares issued against a contribution other than in cash or issued to employees of the company or of a group company. In the event of an issue of preference shares none of

the shareholders shall have a pre-emptive right. The supervisory board shall have the power to limit or debar the pre-emptive right accruing to shareholders, if and in so far as the supervisory board has also been designated by the general meeting of shareholders for this purpose as the authorized body for the period of such designation. The provisions in the second sentence of the first paragraph shall equally apply.

- 4.4. If a designation as referred to in the third paragraph is not in force, the general meeting of shareholders shall have the power, upon the proposal of the supervisory board to limit or debar the pre-emptive right accruing to shareholders.
- 4.5. A resolution of the general meeting of shareholders to limit or debar pre-emptive rights requires a majority of at least two-thirds of the votes cast in a meeting of shareholders in which at least fifty per cent (50 %) of the issued capital is present or represented.
- 4.6. Without prejudice to what has been provided in section 80, paragraph 2, Civil Code:2, shares shall at no time be issued below par.
- 4.7. Ordinary shares shall be issued only against payment in full; preference shares may be issued against partial payment, provided that the proportion of the nominal amount that must be paid on each preference share, irrespective of when it was issued, shall be the same and that at least one quarter of the nominal amount is paid up in full when the share is taken.
- 4.8. Payment must be made in cash to the extent that no other contribution has been agreed upon. If the company so allows, payment in cash can be made in a

	foreign currency. In the event of payment in a foreign currency the obligation to pay is for the amount which can be freely exchanged into Dutch currency. The decisive factor is the rate of exchange on the day of payment, or as the case may be after application of the next sentence, on the day mentioned therein. The company can require payment at the rate of exchange on a certain day within two months prior to the last day when payment shall have to be made provided the shares or depositary receipts for shares after having been
	issued - shall immediately be incorporated in the price list of an
	exchange abroad.
4.9.	This article shall equally apply to the granting of rights to take
	shares, but shall not apply to the issue of shares to someone who
	exercises a previously acquired right to take shares.
4.10.	The managing board shall determine, subject to approval by the supervisory board, when and in what amount payment is to be made in
	respect of partially paid preference shares. The managing board shall notify the shareholders concerned thereof in writing at least
	thirty days before the date on which the payment must finally be
	made.
4.11.	All notifications to shareholders will be made in accordance with
	the provisions relating to giving of notice to convene a general
	meeting as set out in article 27.2.
REPURCHASE O	F SHARES.

Article 5. -----5.1. The company may acquire, for valuable consideration, shares in its own share capital if and in so far as:

- a. its equity less the purchase price of these shares is not less than the aggregate amount of the paid up and called up capital and the reserves which must be maintained pursuant to the law;
- b. the par value of the shares in its capital which the company acquires, holds or holds in pledge, or which are held by a subsidiary company, amounts to no more than one-tenth of the issued share capital; and
- c. the general meeting of shareholders has authorized the managing board to acquire such shares, which authorization may be given for no more than eighteen months on each occasion,

notwithstanding the further statutory provisions. 5.2. The company may, without being authorized thereto by the general meeting of shareholders and notwithstanding to what is provided in paragraph 1 under a and b, acquire shares in its own share capital in order to transfer those shares to the employees of the company or a group company under a scheme applicable to such employees. 5.3. Shares thus acquired may again be disposed of. The company shall not acquire shares in its own share capital as referred to in paragraph 1 -if an authorization as referred to in such paragraph is in force- or as referred to in paragraph 2 without the prior approval of the supervisory board. The company shall also not dispose of shares in its own share capital -with the exception of shares in the company's own share capital acquired pursuant to paragraph 2- without the prior approval of the supervisory board.

If depositary receipts for shares in the company

have been issued, such depositary receipts shall for the application of the provisions of this paragraph and the preceding paragraph be treated as shares.

In the general meeting no votes may be cast in respect of (a) share(s) held by the company or a subsidiary company; no votes may be cast in respect of a share the depositary receipt for which is held by the company or a subsidiary company. However, the holders of a right of usufruct and the holders of a right of pledge on shares held by the company and its subsidiary companies, are nonetheless not excluded from the right to vote such shares, if the right of usufruct or the right of pledge was granted prior to the time such share was held by the company or a subsidiary company. Neither the company nor a subsidiary company may cast votes in respect of a share on which it holds a right of usufruct or a right of pledge.

Shares in respect of which voting rights may not be exercised by law or by the articles of association shall not be taken into account, when determining to what extent the shareholders cast votes, to what extent they are present or represented or to what extent the share capital is provided or represented.

Upon the proposal of the supervisory board the general meeting of shareholders shall have the power to decide (i) to cancel shares acquired by the company from its own share capital, and (ii) to cancel all preference shares against repayment of the amount paid up on those shares, all subject however to the statutory provisions concerned.

5.5.

5.4

SHARES, SHA	ARE CERTIFICATES, SHARE REGISTER.
Article 6.	
6.1. 6.2.	 Shares shall be in registered form. Ordinary shares shall be available: in the form of an entry in the share register without issue of a share certificate; shares of this type are referred to in these articles as type I shares; and - should the supervisory board so decide - in the form of an entry in the share register with issue of a certificate, which certificate shall consist of a main part without dividend coupon; shares of this type and share certificates of this type are referred to in these articles as type II shares.
	Preference shares shall only be made available in the form of type I shares.
6.3.	The supervisory board can decide that the registration of type I shares may only take place for one or more quantities of shares - which quantities are to be specified by the supervisory board - at the same time.
6.4.	Type II share certificates shall be available in such denominations as the supervisory board shall determine.
6.5.	All share certificates shall be signed by or on behalf of a managing director; the signature may be effected by printed facsimile. Furthermore type II share certificates shall, and all other share certificates may, be countersigned by one or more persons designated by the managing board for that purpose.
6.6.	All share certificates shall be identified by numbers and/or letters.

6.7. 6.8. Article 7.	The supervisory board can determine that for the purpose of effecting trading or transfer of shares at foreign exchanges share certificates shall be issued in such form as the supervisory board may determine, complying with the requirements set by said foreign exchange(s) and not provided with any dividend sheet. The expression "share certificate" as used in these articles shall include a share certificate in respect of more than one share.
7.1.	Upon written request from a shareholder, missing or damaged share certificates, or parts thereof, may be replaced by new certificates or by duplicates bearing the same numbers and/or letters, provided the applicant proves his title and, in so far as applicable, his loss to the satisfaction of the supervisory board, and further subject to such conditions as the managing board may deem fit.
7.2.	In appropriate cases, at its own discretion, the managing board may deem fit. In appropriate cases, at its own discretion, the managing board may stipulate that the identifying numbers and/or letters of missing documents be published three times, at intervals of at least one month, in at least three newspapers to be indicated by the managing board announcing the application made; in such a case new certificates or duplicates may not be issued until six months have expired since the last publication, always provided that the original documents have not been produced to the managing board before that time.
7.3.	The issue of new certificates or duplicates shall render the original document invalid.
Article 8.	-

8.1. Notwithstanding the statutory provisions in respect

	of registered shares a register shall be kept by or on behalf of the company, which register shall be regularly updated and, at the discretion of the managing board, may, in whole or in part, be kept in more than one copy and at more than one place. A part of the register may be kept abroad in order to meet requirements set out by foreign statutory provisions or provisions of the foreign
8.2.	exchange. Each shareholder's name, his address and such further data as the managing board deems desirable, whether at the request of a shareholder or not, shall be entered in the register.
8.3.	The form and the contents of the share register shall be determined by the managing board with due regard to the provisions of paragraphs 1 and 2 of this article.
	The managing board may determine that the records shall vary as to their form and contents according to whether they relate to type I shares or to type II shares.
8.4.	Upon request a shareholder shall be given free of charge a declaration of what is stated in the register with regard to the shares registered in his name, which declaration may be signed by one of the specially authorized persons to be appointed by the managing board for this purpose.
8.5.	The provisions of the last four paragraphs shall equally apply to those who hold a right of usufruct or of pledge on one or more registered shares, with the proviso that the other data required by law must be entered in the register.
Article 9.	· ··· ·· · · · · · · · · · · · · · · ·

9.1. Subject to the provisions of article 6, the holder of an entry in the share register for one or more

type I shares may, upon his request and at his option, have issued to him one or more type II share certificates for the same nominal amount.

- 9.2. Subject to the provisions of article 6, the holder of a type II share certificate registered in his name may, after lodging the share certificate with the company, upon his request and at his option, either have one or more type I shares entered in the share register for the same nominal amount.
- 9.3. A request as mentioned in this article shall, if the supervisory board so requires, be made on a form obtainable from the company free of charge, which shall be signed by the applicant. TRANSFER OF SHARES.

Article 10.

10.1.	The transfer of a registered share shall be effected either by service upon the company of the instrument of transfer or by written acknowledgement of the transfer by the company, subject however to the provisions of the following paragraphs of this article.
10.2.	Where a transfer of a type II share is effected by service of an instrument of transfer on the company, the company shall, at the discretion of the managing board, either endorse the transfer on the share certificate or cancel the share certificate and issue to the transferee one or more new share certificates registered in his

10.3. The Company's written acknowledgement of a transfer of a type II share shall, at the discretion of the managing board, be effected either by endorsement of the transfer on the share certificates or by the issue to the transferee of one or more new share

10.4.	certificates registered in his name to the same nominal amount. The provisions of the foregoing paragraphs of this article shall equally apply to the allotment of registered shares in the event of a judicial partition of any community of property or interests, the transfer of a registered share as a consequence of a judgement execution and the creation of limited rights in rem on a registered share.
	If a share certificate has been issued, the acknowledgement can only be effected either by putting an endorsement to that effect on this document, signed by or on behalf of the company, or by replacing this document by a new certificate in the name of the acquirer.
10.5.	The submission of requests and the lodging of documents referred to in articles 7 to 10 inclusive shall be made at a place to be indicated by the managing board and in any case the places where the company is admitted to a stock exchange. Different places may be indicated for the different classes and types of shares and share certificates.
10.6.	The company is authorized to charge amounts to be determined by the managing board not exceeding cost price to those persons who request any services to be carried out by virtue of articles 7 up to and including 10.
USUFRUCTUAF	RIES, PLEDGEES, HOLDERS OF DEPOSITARY RECEIPTS.

Article 11.

11.1. The usufructuary, who in conformity with the provisions of section 88, Civil Code:2 has no right to vote, and the pledgee who in conformity with the provisions of section 89, Civil Code:2 has no right

to vote, shall not be entitled to the rights which by law have been conferred on holders of depositary receipts for shares issued with the cooperation of the company.

Where in these articles of association persons are mentioned, entitled to attend meetings of shareholders, this shall include to holders of depositary receipts for shares issued with the cooperation of the company, and persons who in pursuance of paragraph 4 in section 88 or section 89, Civil Code:2 have the rights that by law have been conferred on holders of depositary receipts for shares issued with the cooperation of the company.

MANAGING BOARD. Article 12.

11.2.

12.1.	The company shall be managed by a managing board consisting of one or more managing directors under the supervision of the supervisory board. The number of members of the managing board shall be resolved upon by the general meeting of shareholders upon the proposal of the supervisory board. The members of the managing board shall be appointed for three years, a year being understood
	as meaning the period between two Annual General Meetings of Shareholders adopting the Accounts of the previous fiscal year or
12.2.	the meeting in which a postponement of this is granted. Managing directors shall be appointed by the general meeting of

^{2.2.} Managing directors shall be appointed by the general meeting of shareholders upon the proposal of the supervisory board for each vacancy to be filled.

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^{12.3.} Without prejudice to the provisions of article 28, paragraph 2, a proposal to make one or more

	appointments to the managing board may be placed on the agenda of a
	general meeting of shareholders by the supervisory board.
12.4.	The supervisory board shall determine the salary, the bonus, if
	any, and the other terms and conditions of employment of the managing directors.
12.5.	The general meeting of shareholders shall decide in accordance with the provisions of article 32, paragraph 1.
	Votes in respect of persons who have not been so nominated shall be invalid.
Article 13.	invalid.
13.1.	The general meeting of shareholders shall be entitled to suspend or dismiss one or more managing directors, provided that at least half
	of the issued share capital is represented at the meeting. No such quorum shall be required where the suspension or dismissal is
	proposed by the supervisory board.
13.2.	Where a quorum under paragraph 1 is required but is not present, a further meeting shall be convened, to be held within four weeks
	after the first meeting, which shall be entitled, irrespective of
	the share capital represented, to pass a resolution in regard to
	the suspension or dismissal.
13.3.	The managing directors can be jointly or individually suspended by
	the supervisory board. After suspension a general meeting of
	shareholders shall be convened within three months, at which
	meeting it shall be decided whether the suspension shall be

meeting it shall be decided whether the suspension shall be cancelled or maintained. The person involved shall be given the opportunity to account for his actions at that meeting. REPRESENTATION.

Article 14. _____ The entire managing board as well as each managing director may represent the company. 14.1. 14.2. The managing board may grant powers of attorney to persons, whether

	or not in the service of the company, to represent the company and shall thereby determine the scope of such powers of attorney and the titles of such persons.
14.3.	The managing board shall have power to perform legal acts as
	specified in section 2:94, paragraph 1, Civil Code in so far as such power is not expressly excluded or limited by any provision of these articles or by any resolution of the supervisory board.
Article 15.	
15.1.	The supervisory board shall appoint one of the managing directors as chairman of the managing board. Appointment of the chairman

13.1.	The supervisory board shall appoint one of the managing directors
	as chairman of the managing board. Appointment of the chairman
	shall be resolved with the majority mentioned in article 22,
	paragraph 1.
15.2.	Resolutions of the managing board shall be passed by simple
	majority of votes. In the event of a tie of votes the chairman of
	the managing board shall have a casting vote.

Article 16.

_____ 16.1.

- Without prejudice to provisions made elsewhere in these articles, the managing board shall require the prior express approval: from the supervisory board for decisions relating to: all proposals to be submitted to a vote at the (i)
 - 1. general meeting of the shareholders;
 - 2. the formation of all companies, acquisition or sale of any participation, and conclusion

- of any cooperation and participation agreement; all pluriannual plans of the company and the budget
- for the first coming year, covering the following matters:
 - investment policy;
 policy regarding r
 - policy regarding research and development,
 - as well as commercial policy and objectives;
 - general financial policy;
 - policy regarding personnel;
- 4. all acts, decisions or operations covered by the above list and constituting a significant change with respect to decisions already adopted by the supervisory board or not provided for in the above list and as specifically laid down by the supervisory board by resolution passed by it to that effect. from the general meeting of shareholders for
- (ii) from the general meetindecisions relating to:

З.

- sale of all or of an important part of the company's assets or business enterprise(s);
- entering into mergers, acquisitions or joint ventures, which the supervisory board considers of material significance,

the absence of the approval provided for above may not be raised by or against third parties.

Without prejudice to provisions made elsewhere in these articles, the managing board shall require the approval of the general meeting of shareholders according to the law and the provisions of these articles as well as such resolutions as are clearly defined by a resolution of the general meeting of

16.2.

shareholders to that effect.

Article 17.

In the event of the absence or inability to act of one of more managing directors the remaining managing directors or managing director shall temporarily be responsible for the entire management. In the event of the absence or inability to act of all managing directors, one or more persons appointed by the supervisory board for this purpose at any time shall be temporarily responsible for the management. SUPERVISORY BOARD.

Article 18.

18.1.	The supervisory board shall be responsible for supervising the policy pursued by the managing board and the general course of affairs of the company and the business enterprise which it
	operates. The supervisory board shall assist the managing board
	with advice relating to the general policy aspects connected with
	the activities of the company. In fulfilling their duties the
	supervisory directors shall serve the interests of the company and
	the business enterprise which it operates.
18.2.	The managing board shall provide the supervisory board in good time
	with all relevant information as well as the information the
	supervisory board requests, in connection with the exercise of its

Article 19.

duties.

19.1.

The supervisory board shall consist of at least six members, to be appointed by the general meeting of shareholders upon the proposal of the supervisory board for each vacancy to be filled. The number of supervisory directors shall without prejudice to the preceding sentence be resolved upon by the general meeting of shareholders upon the proposal

- of the supervisory board.
- 19.2. The general meeting of shareholders shall decide in accordance with the provisions of article 32 paragraph 1.
- 19.3. Without prejudice to the provisions of article 28, paragraph 2, a proposal to make one or more appointments to the supervisory board may be placed on the agenda of the general meeting of shareholders by the supervisory board.
- 19.4. The supervisory board shall appoint from their number a chairman and a vice-chairman of the supervisory board with the majority mentioned in article 22, paragraph 1.
 19.5. Upon the appointment of the supervisory directors the particulars
- 19.5. Upon the appointment of the supervisory directors the particulars as referred to in section 142, paragraph 3, Civil Code:2 shall be made available for prior inspection.

Article 20.

- 20.1. The supervisory board may appoint one or more of its members as delegate supervisory director in charge of supervising the managing board on a regular basis. They shall report their findings to the supervisory board. The offices of chairman of the supervisory board and delegate supervisory director are compatible.
 20.2. With due observance of these articles of association, the
- supervisory board may adopt rules regulating the division of its duties among its various supervisory directors.
- 20.3. The supervisory board may decide that one or more of its members shall have access to all premises of the company and shall be authorized to examine all books, correspondence and other records and to be fully informed of all actions which have taken

20.4.	place, or may decide that one or more of its supervisory directors shall be authorised to exercise a portion of such powers. At the expense of the company, the supervisory board may obtain such advice from experts as the supervisory board deems desirable for the proper fulfilment of its duties.
Article 21.	
21.1.	A supervisory director shall retire no later than at the ordinary general meeting of shareholders held after a period of three years following his appointment.
21.2.	A retired supervisory director may immediately be re-elected. A supervisory director shall retire at the annual general meeting of the year in which he reaches the age prescribed by law for retirement of a supervisory director.
21.3. 21.4.	The supervisory board may establish a rotation scheme. The supervisory directors may be suspended or dismissed by the general meeting of shareholders. The supervisory board may make a proposal to the general meeting of shareholders for the suspension or dismissal of one or more of its supervisory directors.
Article 22.	
22.1.	The supervisory board may pass resolutions by at least three quarters of the votes of the members in office. Each supervisory director has the right to cast one vote. In case of absence a supervisory director may issue a prove however only to another

supervisory director may issue a proxy, however, only to another supervisory director. The proxy should explicitly indicate in which way the vote must be

cast. The supervisory board may pass resolutions in writing without holding a meeting provided that the proposals for such resolutions have been communicated in writing to all supervisory directors and no supervisory director is opposed to this method of passing a resolution. 22.2. A certificate signed by two supervisory directors to the effect that the supervisory board has passed a particular resolution shall constitute evidence of such a resolution in dealings with third parties. 22.3. The managing directors shall attend meetings of the supervisory board at the latter's request. 22.4. The supervisory board shall meet whenever two or more of its members or the managing board so requests. Meetings of the supervisory board shall be convened by the chairman of the supervisory board, either on request of two or more supervisory directors or on request of the managing board, or by the supervisory directors requesting the meeting to be held. If the chairman fails to convene a meeting to be held within four weeks of the receipt of the request, the supervisory board members making the request are entitled to convene the meeting.

22.5. The supervisory board shall draw up standing orders regulating inter alia the manner of convening board meetings and the internal procedure at such meetings. These meetings may be held by telephone as well as by video.

Article 23.

The general meeting of shareholders determines the compensation to the members of the Supervisory Board or to one or more of its members. The meeting shall have

authority to decide whether such compensation will consist of a fixed amount and/or an amount that is variable in proportion to profits or any other factor. The Supervisory Board members shall be reimbursed for their expenses. INDEMNIFICATION.

Article 24.

24.1.

The company shall indemnify any person who was or is a party or is threatened to be made a party to any threatened, pending or completed action, suit or proceeding, whether civil, criminal, administrative or investigative (other than an action by or in the right of the company) by reason of the fact that he is or was a supervisory director, managing director, officer or agent of the company, or was serving at the request of the company as a supervisory director, managing director, officer or agent of another company, a partnership, joint venture, trust or other enterprise, against all expenses (including attorneys' fees) judgements, fines and amounts paid in settlement actually and reasonably incurred by him in connection with such action, suit or proceeding if he acted in good faith and in a manner he reasonably believed to be in or not opposed to the best interests of the company, and, with respect to any criminal action or proceeding, had no reasonable cause to believe his conduct was unlawful or out of his mandate. The termination of any action, suit or proceeding by a judgement, order, settlement, conviction, or upon a plea of nolo contendere or its equivalent, shall not, of itself, create a presumption that the person did not act in good faith and not in a manner which he reasonably believed to be in or not opposed to the best interests of the company, and, with respect to any criminal action or proceeding, had reasonable cause to believe that his conduct was unlawful.

The company shall indemnify any person who was or is a party or is threatened to be made a party to any threatened, pending or completed action or proceeding by or in the right of the company to procure a judgement in its favor, by reason of the fact that he is or was a supervisory director, managing director, officer or agent of the company, or is or was serving at the request of the company as a supervisory director, managing director, officer or agent of another company, a partnership, joint venture, trust or other enterprise, against expenses (including attorneys' fees) actually and reasonably incurred by him in connection with the defense or settlement of such action or proceeding if he acted in good faith and in a manner he reasonably believed to be in or not opposed to the best interests of the company and except that no indemnification shall be made in respect of any claim, issue or matter as to which such person shall have been adjudged to be liable for gross negligence or wilful misconduct in the performance of his duty to the company, unless and only to the extent that the court in which such action or proceeding was brought or any other court having appropriate jurisdiction shall determine upon application that, despite the adjudication of liability but in view of all the circumstances of the case, such person is fairly and reasonably entitled to indemnification against such expenses which the court in which such action or proceeding was brought or such other court having appropriate

24.2.

24.3.	jurisdiction shall deem proper. To the extent that a supervisory director, managing director, officer or agent of the company has been successful on the merits or otherwise in defense of any action, suit of proceeding, referred to in paragraphs 1 and 2, or in defense of any claim, issue or matter therein, he shall be indemnified against expenses (including attorney's fees) actually and reasonable incurred by him in connection therewith.
24.4.	<pre>Any indemnification by the company referred to in paragraphs 1 and 2 shall (unless ordered by a court) only be made upon a determination that indemnification of the supervisory director, managing director, officer or agent is proper in the circumstances because he had met the applicable standard of conduct set forth in paragraphs 1 and 2. Such determination shall be made: a. either by the supervisory board by a majority vote in a meeting in which a quorum as mentioned in article 22, paragraph 1, and consisting of supervisory directors who where not parties to such action, suit or proceeding, is present;</pre>
	 b. or, if such a quorum is not obtainable or although such a quorum is obtained if the majority passes a resolution to that effect, by independent legal counsel in a written opinion; c. or by the general meeting of shareholders.
24.5.	Expenses incurred in defending a civil or criminal action, suit or proceeding may be paid by the company in advance of the final disposition of such action, suit or proceeding upon a resolution of the supervisory board with respect to the specific case upon receipt of an undertaking by or on behalf of

the supervisory director, managing director, officer or agent to repay such amount unless it shall ultimately be determined that he is entitled to be indemnified by the company as authorized in this article.

24.6. The indemnification provided for by this article shall not be deemed exclusive of any other right to which a person seeking indemnification may be entitled under any by-laws, agreement, resolution of the general meeting of shareholders or of the disinterested supervisory directors or otherwise, both as to actions in his official capacity and as to actions in another capacity while holding such position, and shall continue as to a person who has ceased to be a supervisory director, managing director, officer or agent and shall also inure to the benefit of the heirs, executors and administrators of such a person. 24.7. The company shall have the power to purchase and maintain insurance on behalf of any person who is or was a supervisory director, managing director, officer or agent of the company, or is or was serving at the request of the company as a supervisory director, managing director, officer, employee or agent of another company, a partnership, joint venture, trust or other enterprise, against any liability asserted against him and incurred by him in any such capacity or arising out of his capacity as such, whether or not the company would have the power to indemnify him against such liability under the provisions of this article. 24.8. Whenever in this article reference is being made to the company, this shall include, in addition to the

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resulting or surviving company also any constituent company (including any constituent company of a constituent company) absorbed in a consolidation or merger which, if its separate existence had continued, would have had the power to indemnify its supervisory directors, managing directors, officers and agents, so that any person who is or was a supervisory director, managing director, officer or agent of such constituent company, or is or was serving at the request of such constituent company as a supervisory director, managing director, officer or agent of another company, a partnership, joint venture, trust or other enterprise, shall stand in the same position under the provisions of this article with respect to the resulting or surviving company as he would have with respect to such constituent company if its separate existence had continued.

GENERAL MEETING OF SHAREHOLDERS.

Article 25.

25.1.

The ordinary general meeting of shareholders shall be held each year within six months after the close of the financial year. At this general meeting shall be dealt with:

- a. the written report of the managing board on the course of business of the company and the conduct of its affairs during the past financial year, and the report of the supervisory board on the annual accounts;
- b. adoption of the annual accounts and the declaration of dividend in the manner laid down in article 37;
- c. filling vacancies on the managing board in accordance with the provisions of article 12;

- filling vacancies on the supervisory board in accordance with the provisions of article 19;
- e. the proposals placed on the agenda by the managing board or by the supervisory board, together with proposals made by shareholders in accordance with the provisions of these articles.

Article 26.

26.1.	Extraordinary general meetings of shareholders shall be held as often as deemed necessary by the supervisory board and shall be held if one or more shareholders and other persons entitled to attend the meetings of shareholders jointly representing at least one-tenth of the issued share capital make a written request to that effect to the managing board or supervisory board, specifying in detail the business to be dealt with.
26.2.	If the managing board or supervisory board fail to comply with a request under paragraph 1 above in such manner that the general meeting of shareholders can be held within six weeks after the request, the persons making the request may be authorized by the President of the Court within whose jurisdiction the company is established to convene the meeting themselves.
Article 27.	
27 1	Coneral meetings of shareholders shall be held at Amsterdam

- 27.1. General meetings of shareholders shall be held at Amsterdam, Haarlemmermeer (Schiphol Airport), Rotterdam or The Hague; the notice convening the meeting shall inform the shareholders and other persons entitled to attend the meetings of shareholders accordingly.
- 27.2. The notice convening a general meeting of shareholders shall be published by advertisement

which shall at least be published in a national daily newspaper and abroad in at least one daily newspaper appearing in each of these countries other than the United States, where, on the application of the company, the shares have been admitted for official quotation. In addition, holders of registered shares shall be notified by letter that the meeting is being convened. The notice convening the meeting shall be issued by the managing board, by the supervisory board or by those who according to the law or these articles are entitled thereto.

Article 28.

27.3.

28.1.	The notice convening the meeting referred to in the foregoing article shall be issued no later than on the twenty-first day prior to the meeting.
28.2.	The agenda shall contain such business as may be placed thereon by the person(s) entitled to convene the meeting, and furthermore such business as one or more shareholders, representing at least one-tenth of the issued share capital, have requested the managing
	board or supervisory board to place on the agenda at least five
	days before the date on which the meeting is convened. Nominations
	for appointment to the managing board and the supervisory board
	cannot be placed on the agenda by the managing board. No resolution
	shall be passed at the meeting in respect of matters not on the
	agenda.
20 2	Without projudice to the relevant provisions of law dealing with

28.3. Without prejudice to the relevant provisions of law, dealing with withdrawal of shares and amendments to articles of association, the notice convening the meeting shall either mention the business on the agenda or state that the agenda is open to inspection by the shareholders and other persons entitled to attend the meetings of shareholders at the office of the company.

Article 29.	
29.1.	General meetings of shareholders shall be presided over by the chairman of the supervisory board or in his absence by the vice-chairman of the supervisory board. In case of absence of the chairman and the vice-chairman of the supervisory board the meeting shall be presided by any other person nominated by the supervisory board.
29.2.	Minutes shall be kept of the business transacted at a general meeting of shareholders, which minutes shall be drawn up and signed by the chairman and by a person appointed by him immediately after the opening of the meeting.
29.3.	Where the minutes are drawn up before a civil law notary, the chairman's signature, together with that of the civil law notary, shall be sufficient.
Article 30.	
30.1.	All shareholders and other persons entitled to vote at general meetings of shareholders are entitled to attend the general meetings of shareholders, to address the general meeting of shareholders and to vote. The general meeting of shareholders may lay down rules regulating, inter alia, the length of time for which shareholders may speak. In so far as such rules are not applicable, the chairman may regulate the time for which shareholders may speak if he considers this to be desirable with a view to the orderly conduct of the meeting.
20.2	The second to be determined in the second in the

30.2. In order to exercise the rights mentioned in paragraph 1, the holders of registered shares shall notify the company in writing of their intention to

	do so no later than on the day and at the place mentioned in the notice convening the meeting, and also - in so far as type II shares are concerned - stating the serial number of the shares
	certificate. They may only exercise the said rights at the meeting for the shares registered in their name both on the day referred to above and on the day of the meeting.
30.3.	The company shall send a card of admission to the meeting to holders of registered shares who have notified the company of their intention in accordance with the provision in the foregoing paragraph.
30.4.	The provisions laid down in paragraphs 2 up to and including 4 are mutatis mutandis applicable to shares from which usufructuaries and pledgees who do not have the voting right attached to those shares derive their rights.
Article 31.	
31.1.	Shareholders and other persons entitled to attend meetings of shareholders may be represented by proxies with written authority to be shown for admittance to a meeting.
31.2.	All matters regarding the admittance to the general meeting, the exercise of voting rights and the result of votings, as well as any other matters regarding the affairs at the general meeting shall be decided upon by the chairman of that meeting, with due observance of the provisions of section 13, Civil Code:2.
Article 32.	
32.1.	Unless otherwise stated in these articles, resolutions shall be

.1. Unless otherwise stated in these articles, resolutions shall be adopted by simple majority of

votes of the shareholders having the right to vote in a meeting of shareholders where at least one/third of the issued capital is present or represented. Blank and invalid votes shall not be counted. The chairman shall decide on the method of voting and on the possibility of voting by acclamation. Where the voting concerns appointments, further polls shall, if necessary, be taken until one of the nominees has obtained a simple majority, such with due observance of the provision of paragraph 1 of this article. The further poll or polls may, at the chairman's discretion, be taken at a subsequent meeting.

32.3. Except as provided in paragraph 2, in case of an equality of the votes cast the relevant proposal shall be deemed to have been rejected.

Article 33.

32.2.

At the general meeting of shareholders each share shall confer the right to cast one vote.

MEETINGS OF HOLDERS OF SHARES OF A PARTICULAR CLASS.

Article 34. _____

34.1. A meeting of holders of preference shares shall be held whenever required by virtue of the provisions of these articles of association and further whenever the managing board and/or the supervisory board shall decide, and also whenever one or more holders of preference shares so request the managing board and/or the supervisory board in writing, stating the items of business to be transacted. If after receipt of a request as referred to in the preceding sentence neither the managing board nor the supervisory board has called a meeting in such

- 34.2. The managing directors and the supervisory directors shall have the right to attend meetings of holders of preference shares; in that capacity they shall have an advisory vote. Notice of a meeting of holders of preference shares shall be given by letters sent to all holders of preference shares. The notice shall state the items of business to be transacted.
- 34.3. Article 27, paragraphs 1 and 3, article 28, article 29, article 30, paragraph 1, article 31, article 32 and article 33 shall apply mutatis mutandis to meetings of holders of preference shares.
- 34.4. At a meeting of holders of preference shares at which the entire issued capital in shares of those class is represented, valid resolutions may be adopted, provided that they are passed by unanimous vote, even if the requirements in respect of the place of the meeting, the manner of notice, the term of notice and the stating in the notice of the items of business to be transacted, have not been observed.
- 34.5. All resolutions which may be adopted by the holders of preference shares at a meeting may also be adopted outside a meeting. Resolutions may be adopted outside a meeting only if all holders of preference shares and holders of a right of usufruct on preference shares entitled to vote have declared themselves in favour of the proposal by letter, by telegram, by telex

34.6. ANNUAL ACCO	communication or telecopier. The resolution shall be recorded in the minute book of the meeting of holders of preference shares by a managing director. A meeting of holders of ordinary shares shall be held whenever required by virtue of the provisions of these articles of association. Articles 27 up to and including 33 shall apply mutatis mutandis to meetings of holders of ordinary shares. UNTS, REPORT OF THE BOARD OF MANAGEMENT AND DISTRIBUTIONS.
Article 35.	
35.1.	The financial year shall run from the first day of January up to
35.2.	and including the thirty-first day of December. Each year the managing board shall cause annual accounts to be drawn up, consisting of a balance sheet as at the thirty-first day of December, of the preceding year and a profit and loss account in respect of the preceding financial year with the explanatory notes thereto.
35.3.	The managing board shall be bound to draw up the aforesaid annual accounts in accordance with established principles of business management.
35.4.	The supervisory board shall cause the annual accounts to be examined by one or more registered accountant(s) designated for the purposes by the general meeting of shareholders or other experts designated for the purpose in accordance with section 393, Civil Code:2, and shall report to the general meeting of shareholders on the annual accounts, notwithstanding the provisions of the law.

35.5. Copies of the annual accounts which have been made

up, of the report of the supervisory board, of the report of the managing board and of the information to be added pursuant to the law shall be deposited for inspection by shareholders and other persons entitled to attend meetings of shareholders, at the office of the company as from the date of serving the notice convening the general meeting of shareholders at which meeting those items shall be discussed, until the close thereof.

Article 36.

Adoption by the general meeting of shareholders of the annual accounts, referred to in article 35, shall fully discharge the managing board and the supervisory board from liability in respect of the exercise of their duties during the financial year concerned, unless a proviso is made by the general meeting of shareholders, and without prejudice to the provisions of sections 138 and 149, Civil Code:2. PROFIT AND LOSS.

Article 37.

37.1.	Distribution of profits pursuant to this article shall be made following approval of the annual accounts which show that the
	distribution is permitted.
	The company may only make distributions to shareholders and other
	persons entitled to distributable profits to the extent that its
	equity exceeds the total amount of its issued capital and the
	reserves which must be maintained by law.
	A deficit may only be offset against the reserves prescribed by law
	in so far as permitted by law.
37.2.	Upon proposal of the managing board, the supervisory board shall

determine what portion of the profit shall be retained by way of reserve, having regard to the legal provisions relating to obligatory reserves.

37.3. The portion of the profit that remains after application of paragraph 2, shall be at the disposal of the general meeting of shareholders, with due observance of the provisions of article 38, paragraph 2.

- 37.4. In case the general meeting of shareholders resolves upon distribution of profits made in the latest financial year, first, if possible, an amount equal to the percentage referred to below of the paid up part of their par value shall be paid as dividend on the preference shares. No further distributions shall be made on the preference shares. The percentage referred to above is equal to the average of the Euro Interbank Offered Rates applying to cash loans with a term of one year - weighted on the basis of the number of days for which these rates applied - during the financial year in respect of which the distribution takes place. If the amount to be paid on the preference shares has been reduced or, pursuant to a resolution for further payment, has been increased in the financial year in respect of which the distribution referred to above is made, the distribution on these shares shall be reduced or, as the case may be, increased if possible by an amount equal to the percentage referred to above of the amount of the reduction or, as the case may be, the increase, calculated from the time of the reduction or, as the case may be, from the time at which further payments become obligatory.
 - The general meeting of shareholders is empowered either to distribute the profits in cash or in kind or to withhold distribution of the said portion of

37.5.

the profit in whole or in part.

Article 38. 38.1. Upon the proposal of the supervisory board, the general meeting of shareholders shall be entitled to resolve to make distributions charged to the share premium reserve or charged to the other reserves shown in the annual accounts not prescribed by the law, with due observance of the provisions of paragraph 2. The supervisory board shall be entitled to resolve that 38.2. distributions, the amount of which distributions has been resolved upon by the general meeting of shareholders, to shareholders under article 37, article 38, paragraph 1 and article 39 may be made in full or partially in the form of the issue of shares in the share capital of the company. The distribution to a shareholder according to the preceding sentence shall be made to a shareholder in cash or in the form of shares in the share capital of the company, or partially in cash and partially in the form of shares in the share capital of the company, such, if the supervisory board so resolves, at the option of the shareholders. Article 39.

At its own discretion and subject to section 105, paragraph 4, Civil Code:2, the supervisory board may resolve to distribute one or more interim dividends on the shares before the annual accounts for any financial year have been approved and adopted at a general meeting of shareholders.

Article 40.

40.1.

Distributions under articles 37, 38 or 39 shall be payable as from a date to be determined by the

- 40.2. Distributions under articles 37, 38 or 39 shall be made payable at a place or places, to be determined by the supervisory board; at least one place shall be designated thereto in The Netherlands.
- 40.3. The supervisory board may determine the method of payment in respect of cash distributions on type I shares.
- 40.4. Cash distributions under articles $\overline{37}$, 38 or 39 in respect of shares for which a type II share certificate is outstanding shall, if such distributions are made payable only outside the Netherlands, be paid in the currency of a country where the shares of the company are listed on a stock exchange not being the Euro, converted at the rate of exchange determined by the European Central Bank at the close of business on a day to be fixed for that purpose by the supervisory board. If and in so far as on the first day on which a distribution is payable, the company is unable, in consequence of any governmental action or other exceptional circumstances beyond its control, to make payment at the place designated outside the Netherlands or in the relevant currency, the supervisory board may in that event designate one or more places in the Netherlands instead. In such event the provisions of the first sentence of this paragraph shall no longer apply.

40.5.

. The person entitled to a distribution under

articles 37, 38 or 39 on registered shares shall be the person in whose name the share is registered at the date to be fixed for that purpose by the supervisory board in respect of each distribution for the different types of shares.

- 40.6. Notice of distributions and of the dates and places referred to in the preceding paragraphs of this article shall at least be published in a national daily newspaper and abroad in at least one daily newspaper appearing in each of those countries other than the United States, where the shares, on the application of the company, have been admitted for official quotation, and further in such manner as the supervisory board may deem desirable.
- 40.7. Distributions in cash under articles 37, 38 or 39 that have not been collected within five years after they have become due and payable shall revert to the Company.
- 40.8. In the case of a distribution under article 38, paragraph 2, any shares in the company not claimed within a period to be determined by the supervisory board shall be sold for the account of the persons entitled to the distribution who failed to claim the shares. The period and manner of sale to be determined by the supervisory board, as mentioned in the preceding sentence, shall be notified according to paragraph 6. The net proceeds of such sale shall thereafter be held at the disposal of the above persons in proportion to their entitlement; distributions that have not been collected within five years after the initial distributions in shares have become due and payable shall revert to the Company. In the case of a distribution in the form of shares

40.9.

<pre>in the company under article 38, paragraph 2, on registered shares, those shares shall be added to the share register. A type II share certificate for a nominal amount equal to the number of shares added to the register shall be issued to holders of type II shares. 40.10. The provisions of paragraph 5 shall apply equally in respect of distributions - including pre-emptive subscription rights in the event of a share issue - made otherwise than under articles 37, 38 or 39, provided that in addition thereto in the "Staatscourant" (Dutch Official Gazette) shall be announced the issue of shares with a pre-emptive subscription right and the period of time within which such can be exercised. Such pre-emptive subscription right can be executed during at least two weeks after the day of notice in the "Staatscourant" (Dutch Official Gazette).</pre>
ALTERATIONS TO ARTICLES OF ASSOCIATION, WINDING UP, LIQUIDATION.
Article 41.

41.1.

A resolution to alter the articles of association or to wind up the company shall be valid only provided that:

- the proposal to such a resolution has been proposed to the general meeting of shareholders by the supervisory board;
- b. the full proposals have been deposited for inspection by shareholders and other persons entitled to attend meetings of shareholders, at the office of the company as from the day on which the notice is served until the close of that meeting.

41.2.

A resolution to amend the articles of association

	class as such are changed shall require the approval of the relevant class meeting.
Article 42.	
42.1.	If the company is wound up, the liquidation shall be carried out by any person designated for that purpose by the general meeting of shareholders, under the supervision of the supervisory board.
42.2.	In passing a resolution to wind up the company, the general meeting of shareholders shall upon the proposal of the supervisory board fix the remuneration payable to the liquidators and to those responsible for supervising the liquidation.
42.3.	The liquidation shall take place with due observance of the provisions of the law. During the liquidation period these articles of association shall, to the extent possible, remain in full force and effect.
42.4.	After settling the liquidation, the liquidators shall render account in accordance with the provisions of the law.
42.5.	After the liquidation has ended, the books and records of the company shall remain in the custody of the person designated for that purpose by the liquidators during a ten-year period.
Article 43.	

by which the rights conferred on holders of shares of a specific

From what is left of the company's assets after all creditors have been satisfied, first, if possible, all holders of preference shares shall have returned to them the paid up part of the nominal amount of their preference shares.

The residue shall be divided amongst the holders of ordinary shares pro rata to their respective holdings of ordinary shares.

Article 44.

Any amounts payable to shareholders or due to creditors which have not been claimed within six months after the last distribution was made payable, shall be deposited with the Public Administrator of Unclaimed Debts.

CONSENT OF INDEPENDENT ACCOUNTANTS

We hereby consent to the incorporation by reference in the Registration Statements on Form S-8 (No. 33-80797, No. 33-90616, No. 333-06390, No. 333-06862 and No. 333-07226) of STMicroelectronics N.V. of our report dated January 25, 2000 relating to the financial statements, which appears on page 59 of the Annual Report to Shareholders, which is incorporated in this Annual Report on Form 20-F. We also consent to the incorporation by reference of our report dated January 25, 2000 relating to the financial statement schedule, which appears in this Form 20-F.

PRICEWATERHOUSECOOPERS N.V. Amsterdam, The Netherlands June 22, 2000

Selected Consolidated Financial Data

The table below sets forth selected consolidated financial data for the Company for each of the years in the five-year period ended December 31, 1999. Such data have been derived from the consolidated financial statements of the Company. Consolidated audited financial statements for each of the years in the three-year period ended December 31, 1999, including the Notes thereto (collectively, the "Consolidated Financial Statements"), are included elsewhere in this annual report.

The following information should be read in conjunction with "Management's Discussion and Analysis of Financial Condition and Results of Operations" and the Consolidated Financial Statements and the related notes thereto included elsewhere in this annual report.

Year ended December 31, (in millions except per share					
and ratio data)	1995(1)	1996(1)	1997(1)	1998(1)	1999(1)
Consolidated Statement of Income Data:					
Net sales	¢ 2 520 7	¢ 4 070 2	¢ 2 0.60 0	\$ 4 210 G	¢ 5 022 1
Net sales Other revenues	33.7	44.1	\$ 5,909.0 49.4	37.2	33.2
Net revenues	3.554 4	4.122.4	4.019.2	4.247.8	5.056.3
Net revenues Cost of sales(2)	(2,096.0)	(2,414.7)	(2,457.4)	(2,623.0)	(3,054.5)
Gross profit(2) Operating expenses: Selling, general & administrative	1,458.4	1,707.7	1,561.8	1,624.8	2,001.8
(413.2) (421.1) Research and development(3) Restructuring costs	(454.3) (440.3)	(488.1) (532.3)	(534.2) (610.9) 	(689.8)	(836.0)
Restructuring costs Other income and expenses(3)	(13.0)	45.1	23.2	76.5	 39.9
Total operating expenses	(807.4)	(908.3)	(1,042.0)	(1,101.4)	(1,330.3)
Operating Income Net interest income (expense) Gain on disposal of investment	651.0 (16.8) 	799.4 (11.2) 7.3	519.8 (2.6)	523.4 8.7 	671.5 35.6
Income before income taxes and minority interests Income tax expense					
Income before minority interests Minority interests	525.9 0.6	623.9 1.6	404.2 2.4	411.7 (0.6)	549.9 (2.6)
Net income	\$ 526.5	\$ 625.5	\$ 406.6	\$ 411.1	\$ 547.3
Earnings per share (basic)(1)			\$ 1.46		
Earnings per share (diluted)(1)	\$ 2.00		\$ 1.45		\$ 1.87
Number of shares used in calculating earnings per share (basic)	261.3	277.4	278.2	281.7	286.4
Number of shares used in calculating earnings per share (diluted)	262.6	278.4	279.7	288.1	300.4
Ratio of earnings to fixed charges(4)			13.4		
Consolidated Balance Sheet Data (end of period): Cash, cash equivalents and					
marketable securities	\$ 758.4	\$ 556.4	\$ 702.2 443.5 5,445.7	\$ 1,100.7	\$ 1,823.1
Working capital(5) Total assets	41/.4	5,005.5	443.5 5,445.7	6,434.0	398.5 7,930.3
Short-term debt (including current portion of long-term debt)	492.8	428.2	424.6	191.2	123.2
Long-term debt (excluding current					
portion)(1) Shareholders' equity(1)	200.7 2,661.7	194.9 3,260.0	356.4 3,307.4	755.8 4,083.3	1,348.5 4,563.9
Consolidated Operating Data:					
Capital expenditures(6) Net cash provided by operating activities	\$ 1,001.9 825.1	\$ 1,125.2 980.7	\$ 1,035.4 983.8	\$ 947.3 1,012.5	\$ 1,347.5 1,469.3
Depreciation and amortization(6)	392.4	535.9	608.1	704.0	806.8

(1) All share information has been adjusted to reflect the 2-for-1 stock split effected in June 1999. Earnings per share have been restated to reflect the adoption in 1997 of Statement of Financial Accounting Standards No.128 "Earnings per share." See Note 2.10 and Note 11 to the Consolidated Financial Statements. On September 22, 1999, the Company completed an equity offering of 2,990,000 shares of capital stock at \$74.6250 per share ("1999 Share Offering"). The net proceeds to the Company in connection with the 1999 Share Offering were \$216.8 million. On September 22, 1999, the Company also completed a debt offering of \$720.9 million aggregate initial principal amount of zero-coupon convertible Liquid Yield OptionTM Notes due 2009 (the "1999 LYONS"), with yield to maturity of 2.4375% per annum (the "1999 LYONS Offering"). The net proceeds to the Company in connection with the 1999 LYONS Offering was \$708.3 million. On June 10, 1998, the Company completed an equity offering of 6,000,000 shares of capital stock at \$36.09 per share (after the 2-for-1 stock split) ("1998 Share Offering"). The net proceeds to the Company in connection with the 1998 Share Offering were \$208.8 million. On June 10, 1998, the Company also completed a debt offering of \$431.7 million aggregate initial principal amount of zero-coupon convertible Liquid Yield OptionTM Notes due 2008 (the "1998 LYONS"), with yield to maturity of 1.75% per annum (the "1998 LYONS Offering"). The net proceeds to the Company in connection with the 1998 LYONS Offering was \$421.8 million.

- (2) Cost of sales is net of certain funds received through government agencies for industrialization costs (which include certain costs incurred to bring prototype products to the production stage) included therein. See Note 17 to the Consolidated Financial Statements. For a discussion of certain significant charges reflected in cost of sales in 1996, 1997 and 1998, see "Management's Discussion and Analysis of Financial Condition and Results of Operations --Results of Operations."
- (3) Other income and expenses include, among other things, funds received through government agencies for research and development expenses, and the cost of new plant start-ups, as well as foreign currency gains and losses, and the costs of certain activities relating to intellectual property and goodwill amortization. The Company's reported research and development expenses do not include design center, process engineering, pre-production or industrialization costs.
- (4) For purposes of calculating the ratio of earnings to fixed charges, earnings consist of income before income taxes and minority interests, plus fixed charges. Fixed charges consist of interest expenses.
- (5) Working capital is calculated as current assets (excluding cash, cash equivalents and marketable securities) less current liabilities (excluding bank overdrafts, short-term debt and current portion of long-term debt).
- (6) Capital expenditures are net of certain funds received through government agencies, the effect of which is to decrease depreciation.

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Management's Discussion and Analysis of Financial Condition and Results of Operations

The following discussion should be read in conjunction with the Consolidated Financial Statements and Notes thereto included elsewhere in this annual report. The following discussion contains forward-looking statements within the meaning of Section 27A of the Securities Act of 1933, as amended. The Company's actual results may differ significantly from those projected in the forward-looking statements. Factors that might cause future actual results to differ materially from the Company's recent results or those projected in the forward-looking statements include, but are not limited to, those discussed in "Cautionary Statement Regarding Forward-Looking Statements," under the caption "Risk Factors" in the Company's Prospectuses dated September 16, 1999 and below. The Company assumes no obligation to update the forward-looking statements or such factors.

Overview

The semiconductor industry experienced a strong recovery in 1999, after a severe slowdown in 1998. According to preliminary trade association data, worldwide sales of semiconductor products (the total available market or "TAM") increased 18.9% in 1999 over 1998. According to preliminary trade association data, the estimated market for products produced by the Company (the serviceable available market or "SAM") (which consisted of the TAM without DRAMs and opto-electronic products) increased approximately 14.9% in 1999 over 1998.

While the semiconductor market in 1999 registered a significant increase, the Company's net revenues for 1999 increased 19.0% compared to net revenues for 1998 with an increase equivalent to the total semiconductor market. However, the Company's net revenues increased more than the SAM increased. The Company benefited from increased volumes in virtually all product families and an improved product mix, including sales of new products. During this period, however, the Company continued to experience increased competition and pricing pressure in its core product markets.

Despite difficult market conditions in recent years, from 1995 to 1999 the Company's net revenues increased from \$3,554.4 million to \$5,056.3 million, representing a compound annual growth rate of 9.2%. According to preliminary trade association data, the TAM increased from \$144.4 billion in 1995 to \$149.4 billion in 1999, representing a compound annual growth rate of 0.9%, while the SAM increased from \$99.2 billion in 1995 to \$122.9 billion in 1999, representing a compound annual growth rate of 5.5%. During the same period, the Company's share of the TAM increased from 2.4% to 3.4%, while the Company's share of the SAM increased from 3.5% to 4.1%. The Company's revenue growth from 1995 through 1999 was particularly significant for differentiated ICS (which the Company defines as being its dedicated products, semicustom devices and microcontrollers).

As a result of the Company's performance during the period 1995 to 1999, the Company not only gained market share against both the TAM and SAM, but, according to preliminary ranking by leading market analysts, became the eighth largest semiconductor company in the world during 1999, up from ninth in 1998. However, the Company believes that recent difficult market conditions have led certain of its competitors to redirect their marketing focus and manufacturing capacity toward products that compete with the Company's products. The Company believes increased competition in its core product markets is generating greater pricing pressure, increased competition for market share in the SAM and a generally more challenging market environment for the Company.

The Company continues to focus on differentiated ICs and analog ICs. Differentiated ICs accounted for approximately 63% of the Company's net revenues in 1999, compared to approximately 62% in 1998. Such products foster close relationships with customers, resulting in early knowledge of their evolving requirements and opportunities to access their markets for other products, and are less vulnerable to competitive pressures than standard commodity products. Analog ICs (including mixed signal ICs), the majority of which are also differentiated ICs, accounted for approximately 51% of the Company's net revenues in 1999 and 50% in 1998, while discrete devices accounted for approximately 12% of the Company's net revenues in 1999 and soft in 1998. In recent years, these families of products, in particular analog ICs, have experienced less volatility in sales growth rates and average selling prices than the overall semiconductor industry. However, the difficult competitive environment in the semiconductor market in more recent years has led to price pressures in these product families as well.

In order to reinforce the Company's presence in certain strategic business segments, the Company has recently completed the acquisition of Peripherals Technology Solutions (in the area of data storage), Vision Group and Arithmos (both in the imaging market).

The Company's gross profit margin decreased from 41.0% in 1995 to 38.3% in 1998 and recovered to 39.6% in 1999. Benefiting from a favorable environment in 1995 and 1996, the Company had a stable gross profit margin of approximately 41%. In 1997 and 1998, in an unfavorable industry environment, which generated lower margins due to the negative impact of pricing pressures, gross profit margin declined to slightly above 38%. This decline in gross profit margin coupled with a higher level of research and development expenditure, resulted in a lower operating income as a percentage of net revenues which, however,

remained above 12%. Benefiting from the market recovery in 1999, gross profit increased in 1999 to 39.6% while operating income as a percentage of net revenues was 13.3%.

There can be no assurance that the Company will experience revenue growth at or above the growth rate for the TAM or the SAM, or that increased competition in the Company's core product markets will not lead to further price erosion, lower revenue growth rates and lower margins for the Company. The tables below set forth information on the Company's net revenues by product group and by geographic region:

Year ended December 31, (in millions except per share and ratio data)

	1995	1996	1997	1998	1999
Net Revenues by Product Group: (1)					
Telecommunications, Peripherals and					
Automotive(1)(2)	\$1,250.4	\$1,614.0	\$1,606.9	\$1,855.2	\$2,305.5
Discrete and Standard ICs(1)				816.7	
Memory Products (2)	653.3	778.1 736.8 870.2	708.6	659.6	835.9
Consumer and Microcontrollers(1)	649.2	870.2	708.6 738.8	805.8	835.9 881.7
New Ventures Group and Others (3)	168.1	123.3	125.4	110.5	105.3
Total				\$4,247.8	
Net Revenues by Geographic Region: (4)					
Europe	\$1,593.8	\$1,788.5	\$1,753.3	\$1,768.9	\$1,833.6
North America	812.5	\$1,788.5 903.0	899.1	\$1,768.9 937.3	1,156.1
Asia Pacific	916.7	1,125.7	1,065.8	1,247.9	1,658.2
Japan				180.7	
Region Five (4)	76.0	77.0	86.5	113.0	168.7
	\$3,554.4	\$4,122.4	\$4,019.2	\$4,247.8	\$5,056.3
As a percentage of net revenues					
Net Revenues by Product Group:					
Telecommunications, Peripherals and					
Automotive(1)(2)		39.1%		43.6%	
Discrete and Standard ICs(1)	23.4	18.9	20.9	19.2	18.4
Memory Products(2)	18.4	17.9 21.1	17.6 18.4	15.5 19.0	16.5
Consumer and Microcontrollers(1)	18.3		18.4	19.0	17.4
New Ventures Group and Others(3)	4.7	3.0	3.1	2.7	2.1
Total				100.0%	
Net Revenues by Geographic Region: (4)					
Europe	44.8%	43.4% 21.9	43.6%	41.6%	36.3
North America	22.9			22.1	22.9
Asia Pacific	25.8	27.3	26.5	29.4	32.8
Japan	4.4	5.5	5.3	4.3	4.7
Region Five (4)	2.1	1.9	2.2	4.3 2.6	3.3
Total	100.0%	100.0%	100.0%	100.0%	100.0%

- (1) In January 1999, we implemented organizational changes to better orient our product groups to end-use applications. As a result, net revenues have been restated for prior periods to reflect these changes. In addition, the former Dedicated Products Group has become the Telecommunications, Peripherals and Automotive Groups, while the former Programmable Products Group has become the Consumer and Microcontrollers Groups. Revenues for the Dedicated Products Group and the Programmable Products Group have been restated in this "Management's Discussion and Analysis of Financial Condition and Results of Operations" for prior periods to reflect this change.
- (2) 1996 revenues for the Dedicated Products Group include \$5.6 million of revenues from certain foundry activities which were moved from the Memory Products Group in January 1996. Revenues for the Dedicated Products Group and the Memory Products Group have been restated for prior periods to reflect this change.
- (3) Includes revenues from sales of subsystems and other products and from the New Ventures Group, which was created in May 1994 to act as a center for the Company's new business opportunities.
- (4) Revenues are classified by location of customer invoiced. For example, products ordered by U.S.-based companies to be invoiced to Asia Pacific affiliates are classified as Asia Pacific revenues. Net revenues by geographic region have been reclassified to reflect the creation of Region Five in January 1998 which includes emerging markets such as South America, Africa, Eastern Europe, the Middle East and India. Prior years have been restated to reflect this reclassification.

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The following table sets forth certain financial data from the Company's consolidated statements of income since 1995, expressed in each case as a percentage of net revenues:

Year ended December 31,	1995	1996	1997	1998	1999
Net sales	99.1%	98.9%	98.8%	99.1%	99.3%
Other revenues	0.9	1.1	1.2	0.9	0.7
Net revenues Cost of sales	100.0	100.0 (58.6)	100.0	100.0	100.0
Gross profit Operating expenses:	41.0	41.4	38.9	38.3	39.6
Selling, general and administrative Research and development	(11.6) (12.4) (0.4)	(10.2) (12.9)	(11.3) (15.2)	(11.5) (16.2)	(10.6) (16.5)
Restructuring costs Other income and expenses					0.8
Total operating expenses	(22.7)	(22.0)	(26.0)	(26.0)	(26.3)
Operating income Net interest income (expense) Gain on disposal of investment	(0.5)	19.4 (0.3) 0.2		12.3 0.2 	
Income before income taxes & minority interests	17.8	19.3 (4.2)			
Income before minority interests Minority interests	14.8	15.1 0.1			10.9 (0.1)
Net income	14.8%	15.2%	10.1%	9.7%	10.8%

1999 vs. 1998

In 1999, the Company benefitted from the industry recovery and its strong market position, and increased its net revenues, gross profit, operating income, net income and earnings per share in each successive quarter. The Company continued to invest significant amounts in research and development and completed several strategic acquisitions which enhanced its intellectual property portfolio. The Company accelerated its capital spending in the second half of the year.

Net revenues. Net sales increased 19.3%, from \$4,210.6 million in 1998 to \$5,023.1 million in 1999. The increase in net sales was primarily the result of higher volume and an improved product mix, including sales of new products, partly offset by declining average selling prices. The exchange rate impact on net sales in 1999 was estimated to be negligible. Other revenues decreased from \$37.2 million in 1998 to \$33.2 million in 1999 due primarily to a reduction in licensing revenues. Net revenues increased 19.0%, from \$4,247.8 million in 1998 to \$5,056.3 million in 1999.

The Telecommunications, Peripherals and Automotive Groups' net revenues increased 24.3% primarily as a result of volume increases in wireless telecommunications, data storage and automotive products and a more favorable product mix. The Discrete and Standard ICs Group's net revenues increased 13.6%, as the volume increases in basically all major product families and the more favorable product mix in standard commodities more than offset the price declines in all product families. Net revenues of the Memory Products Group increased by 26.7% as the volume increases in all product families more than offset the price declines in nearly all product families (such as EPROMs, EEPROMs, smartcard ICs and flash memories). The Consumer and Microcontrollers Groups' net revenues increased 9.4% as a result of significantly higher volumes in digital video and microcontrollers products, partially offset by decreased volumes in graphics products and lower prices in all product families.

Gross profit. The Company's gross profit increased 23.2%, from \$1,624.8 million in 1998 to \$2,001.8 million in 1999 primarily as a result of higher net revenues. As a percentage of net revenues, gross profit increased from 38.3% in 1998 to 39.6% in 1999, due to higher sales volumes and improved manufacturing efficiency.

Cost of sales. Cost of sales increased from \$2,623.0 million in 1998 to \$3,054.5 million in 1999, primarily due to a significant increase in production volume and the increased depreciation associated with new capital investments.

The exchange rate impact on gross profit in 1999 compared to 1998 was estimated to be favorable, as the negligible impact of the variation of the U.S. dollar on net revenues was more than offset by the positive impact on cost of sales of the appreciation of the U.S. dollar versus the euro. See "--Impact of Changes in Exchange Rates." Cost of sales in 1999 and 1998 was net of \$2.4

Source: STMICROELECTRONICS N, 20-F, June 27, 2000

million and \$3.1 million, respectively, of funds received through government agencies to offset industrialization costs (which include certain costs incurred to bring prototype products to the production stage) included in cost of sales.

Selling, general and administrative expenses. Selling, general and administrative expenses increased 9.4%, from \$488.1 million in 1998 to \$534.2 million in 1999, reflecting higher expenditure for information technology, marketing and administrative functions, including the expenses for year 2000 compliance. As a percentage of net revenues, selling, general and administrative expenses decreased slightly from 11.5% in 1998 to 10.6% in 1999.

Research and development expenses. Research and development expenses increased 21.2%, from \$689.8 million in 1998 to \$836.0 million in 1999. The Company continued to invest heavily in research and development and plans to continue increasing its research and development staff. The Company continues to allocate significant financial resources to expand its market leadership in key applications, reflecting its commitment to service and continuous innovation. The Company's reported research and development expenses do not include design center, process engineering, pre-production or industrialization costs. As a percentage of net revenues, research and development expenses increased from 16.2% in 1998 to 16.5% in 1999.

Other income and expenses. Other income and expenses decreased from income of \$76.5 million in 1998 to income of \$39.9 million in 1999. Other income and expenses include primarily funds received from government agencies in connection with the Company's research and development programs, the cost of new plant start-ups, as well as foreign currency gains and losses, the costs of certain activities relating to intellectual property, goodwill amortization, and miscellaneous revenues and expenses. The decrease in other income and expenses resulted primarily from higher start-up costs of new production facilities, from the inclusion of the goodwill amortization and from a slight decrease in funds received from government agencies in connection with the Company's research and development programs.

Operating income. The Company's operating income increased by 28.3%, from \$523.4 million in 1998 to \$671.5 million in 1999. The exchange rate impact on operating income in 1999 was favorable since the appreciation of the U.S. dollar against the euro had a favorable impact on cost of sales and operating expenses.

Net interest income (expense). Net interest income increased from income of \$8.7 million in 1998 to income of \$35.6 million in 1999 primarily as a result of the increase in cash and cash equivalents following the 1999 Share Offering and the 1999 LYONS Offering completed on September 22, 1999.

Income tax expense. Provision for income tax was \$157.2 million in 1999 compared to \$120.4 million in 1998, primarily as a result of the increase in income before income taxes and minority interests. The accrued effective tax rate decreased from 22.6% in 1998 to 22.2% in 1999 mainly due to the application of benefits in certain countries. As such benefits may not be available after 1999, an increase in the effective tax rate could result in the coming years.

Net income. The Company's net income increased 33.1%, from \$411.1 million to \$547.3 million. As a percentage of sales, 1999 net income was 10.8%, up from 9.7% of 1998 net income. The increase was mainly due to higher net sales. Earnings per diluted share reached \$1.87, an increase of 29.9% compared to earnings per diluted share of \$1.44 in 1998. All per share numbers have been adjusted to reflect the 2-for-1 stock split effected in June 1999.

1998 vs. 1997

The Company distinguished itself during 1998 by the solid performance achieved during an unprecedented downturn in the semiconductor industry. In 1998, the Company increased net revenues, gross profit and net income compared to 1997. In addition, the Company increased significantly its investments in research and development activities during the year, continuing the trend established during the last five years. The improved financial results reflect the Company's business strategy, including the high level of differentiated products within its product portfolio, its focus on high growth markets and its geographic balance.

Net revenues. Net sales increased 6.1%, from \$3,969.8 million in 1997 to \$4,210.6 million in 1998. The increase in net sales was primarily the result of higher volume and an improved product mix, including sales of new products, partly offset by declining average selling prices. The exchange rate impact on net sales in 1998 due to a stronger U.S. dollar was estimated to be marginally unfavorable. Other revenues decreased from \$49.4 million in 1997 to \$37.2 million in 1998 due primarily to a reduction in licensing revenues. Net revenues increased 5.7%, from \$4,019.2 million in 1997 to \$4,247.8 million in 1998.

The Telecommunications, Peripherals and Automotive Groups' net revenues increased 15.5% primarily as a result of volume increases in wireless telecommunications, automotive and printer products (partly offset by lower volumes in data storage products) and a more favorable product mix in data storage, automotive and printer products. The Discrete and Standard ICs Group's net revenues decreased 2.7%, as volume increases in basically all major product families and a more favorable product mix in transistors and standard commodities were more than offset by price declines in transistors, discrete devices, standard commodities and standard logic products. Net revenues of the Memory Products Group declined by 6.9% as the volume increases in EEPROMs, flash memories and smartcard ICs were more than offset by significant price declines in basically all product families (such as EPROMs, EEPROMs, smartcard ICs and flash memories). The Consumer and Microcontrollers Groups' net revenues increased 9.1% as a result of significantly higher volumes in digital image processing and graphics products.

Gross profit. The Company's gross profit increased 4.0%, from \$1,561.8 million in 1997 to \$1,624.8 million in 1998 primarily as a result of higher net revenues. As a percentage of net revenues, gross profit decreased from 38.9% in 1997 to 38.3% in 1998, being primarily impacted by the reduction in average selling prices and a higher depreciation charge. Cost of sales. Cost of sales increased from \$2,457.4 million in 1997 to \$2,623.0 million in 1998, primarily due to a significant increase in production volume and the increased depreciation associated with new capital investments.

The exchange rate impact on gross profit in 1998 compared to 1997 was estimated to be marginally favorable, as the negative impact of the appreciation of the U.S. dollar on net revenues was more than offset by the positive impact on cost of sales. See "-- Impact of Changes in Exchange Rates." Cost of sales in 1998 and 1997 was net of \$3.1 million and \$6.2 million, respectively, of funds received through government agencies to offset industrialization costs (which include certain costs incurred to bring prototype products to the production stage) included in cost of sales.

Selling, general and administrative expenses. Selling, general and administrative expenses increased 7.4%, from \$454.3 million in 1997 to \$488.1 million in 1998, reflecting higher expenditure for information technology, marketing and administrative functions. As a percentage of net revenues, selling, general and administrative expenses increased slightly from 11.3% in 1997 to 11.5% in 1998.

Research and development expenses. Research and development expenses increased 12.9%, from \$610.9 million in 1997 to \$689.8 million in 1998. The Company continued to invest heavily in research and development. The Company's reported research and development expenses do not include design center, process engineering, pre-production or industrialization costs. As a percentage of net revenues, research and development expenses increased from 15.2% in 1997 to 16.2% in 1998.

Other income and expenses. Other income and expenses increased from income of \$23.2 million in 1997 to income of \$76.5 million in 1998. Other income and expenses include primarily funds received from government agencies in connection with the Company's research and development programs, the cost of new plant start-ups, as well as foreign currency gains and losses, the costs of certain activities relating to intellectual property and miscellaneous revenues and expenses. The increase in other income and expenses resulted primarily from lower start-up costs of new production facilities and from an increase in funds received from government agencies in connection with the Company's research and development programs.

Operating income. The Company's operating income increased slightly, from \$519.8 million in 1997 to \$523.4 million in 1998. The exchange rate impact on operating income was estimated to be favorable, since the negative impact on net revenues was more than compensated by the favorable impact on cost of sales and operating expenses.

Net interest income (expense). Net interest income increased from an expense of \$2.6 million in 1997 to an income of \$8.7 million in 1998 primarily as a result of the increase in cash and cash equivalents following the 1998 Share Offering and the 1998 LYONS Offering completed on June 10, 1998.

Income tax expense. Provision for income tax was \$120.4 million in 1998 compared to \$113.0 million in 1997, primarily as a result of the increase in income before income taxes and minority interests and a higher effective tax rate. The accrued effective tax rate increased from 21.8% in 1997 to 22.6% in 1998. The still favorable 1998 rate was mainly due to the application of benefits in certain countries.

Net income. Net income in 1998 was \$411.1 million, a slight increase from the 1997 net income of \$406.6 million. As a percentage of sales, 1998 net income was 9.7%, compared to 10.1% of 1997 net income. Earnings per diluted shares were \$1.44, basically equivalent to 1997 earnings per diluted share of \$1.45. All per share numbers have been adjusted to reflect the 2-for-1 stock split effected in June 1999.

Quarterly Results of Operations

The following table sets forth certain financial information for the years 1998 and 1999. Such information is derived from unaudited consolidated financial statements, prepared on a basis consistent with the audited consolidated financial statements, that include, in the opinion of management, only normal recurring adjustments necessary for a fair presentation of the information set forth therein. Operating results for any quarter are not necessarily indicative of results for any future period. In addition, in view of the significant growth experienced by the Company in recent years, the increasingly competitive nature of the markets in which the Company operates, the changes in product mix and the currency effects of changes in the composition of sales and production among different geographic regions, the Company believes that period-to-period comparisons of its operating results should not be relied upon as an indication of future performance.

The Company's quarterly and annual operating results are also affected by a wide variety of other factors that could materially and adversely affect revenues and profitability or lead to significant variability of operating results, including, among others, capital requirements and the availability of funding, competition, new product development and technological change and manufacturing. In addition, a number of other factors could lead to fluctuations in operating results, including order cancellations or reduced bookings by key customers or distributors, intellectual property developments, international events, currency fluctuations, problems in obtaining adequate raw materials on a timely basis, and the loss of key personnel. As only a portion of the Company's expenses varies with its revenues, there can be no assurance that the Company will be able to reduce costs promptly or adequately in relation to revenue declines to compensate for the effect of any such factors. As a result, unfavorable changes in the above or other factors have in the past and may in the future adversely affect the Company's operating results.

Quarter ended (unaudited) (in millions, except percentages and per share data)(1)	April 4, 1998	July 4, 1998	Oct. 3, 1998	Dec. 31, 1998	April 3, 1999	July 3, 1999	Oct. 2, 1999	Dec. 31, 1999
Consolidated Statement								
of Income Data								
Net revenues Cost of sales		\$1,070.3 (660.3)	\$1,039.4 (643.7)	\$1,132.7 (698.6)	\$1,113.3 (685.4)	\$1,190.6 (719.9)	\$1,274.2 (766.8)	\$1,478.2 (882.4)
Gross profit	385.0	410.0	395.7	434.1	427.9	470.7	507.4	595.8
Operating expenses:								
Selling, general & administrative	(119.9)	(126.2)	(120.1)	(121.9)	(119.1)	(130-3)	(136.8)	(148.0)
Research & development	(166.4)	(176.2)	(168.0)	(179.2)	(193.5)	(202.8)	(205.5)	(234.1)
Other income & expenses	16.2	17.2	21.4	21.8	16.1	14.9	5.0	3.8
Total operating expenses	(270.1)	(285.2)	(266.7)	(279.3)	(296.5)	(318.2)	(337.3)	(378.3)
Operating income Net interest income (expense)	114.9					152.5 6.0		217.5 17.7
Income before income								
taxes & minority interests Income tax expense	113.8 (23.6)		134.2 (32.5)	159.4 (37.6)	135.1 (29.9)	158.5 (35.4)	178.3 (41.6)	235.2 (50.3)
Income before minority								
interests	90.2	98.1	101.7	121.8	105.2	123.1	136.7	184.9
Minority interests		(0.6)	(0.1)		(0.1)	(0.6)	(1.4)	(0.6)
Net income	\$ 90.2	\$ 97.5		\$ 121.8		\$ 122.5	\$ 135.3	\$ 184.3
Earnings per share (basic)						\$ 0.43		
Earnings per share (diluted)	\$ 0.32	\$ 0.35	\$ 0.35	\$ 0.42	\$ 0.36	\$ 0.42	\$ 0.46	\$ 0.62
Number or shares used in calculating earnings per share (basic) Number or shares used in calculating earnings	278.2	279.8	284.4	284.4	285.0	285.5	286.1	288.9
per share (diluted)	279.6	283.8	294.6	294.8	296.0	296.9	298.7	310.2
As a Percentage of Net Revenues								
Net revenues Cost of sales	100.0% (61.7)		100.0% (61.9)	100.0% (61.7)	100.0% (61.6)	100.0% (60.5)	100.0% (60.2)	100.0% (59.7)
Gross profit	38.3	38.3	38.1	38.3	38.4	39.5	39.8	40.3
Operating expenses:								
Selling, general &								
administrative Research & development	(11.9) (16.6)	(11.8) (16.5)	(11.6) (16.2)	(10.8) (15.8)	(10.7) (17.4)	(10.9) (17.0)	(10.7) (16.1)	(10.0) (15.8)
Other income & expenses	1.6	1.7	2.1	2.0	1.5	1.2	0.3	0.2
Total operating expenses	(26.9)	(26.6)	(25.7)	(24.6)	(26.6)	(26.7)	(26.5)	(25.6)
Operating income	11.4	11.7	12.4	13.7	11.8	12.8	13.3	14.7
Net interest income (expense)	(0.1)		0.5	0.4	0.3	0.5	0.7	1.2
Income before income								
taxes & minority	11 0	11 5	10.0	14.5	10.1	10.0	14.0	15 0
interests Income tax expense	11.3 (2.3)	11.7 (2.5)	12.9 (3.1)	14.1 (3.3)	12.1 (2.7)	13.3 (3.0)	14.0 (3.3)	15.9 (3.4)
Income before minority								
interests Minority interests	9.0	9.2 (0.1)	9.8	10.8	9.4	10.3	10.7 (0.1)	12.5
Net income	9.0%	9.1%	9.8%	10.8%	9.4%	10.3%	10.6%	12.5%

 All share information has been adjusted to reflect the 2-for-1 stock split effected in June 1999.

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In the fourth quarter 1999, the Company achieved very solid results of operations. The combination of strong contributions by all major applications, product groups and geographic regions and the Company's efficient worldwide manufacturing infrastructure enabled the Company to post the highest quarterly revenues and earnings in its history.

Net revenues. Fourth quarter 1999 net revenues recorded a 16.0% sequential improvement over the third quarter of 1999 and a 30.5% increase over the fourth quarter of 1998. The Company experienced strong sequential sales gains across all product groups in the fourth quarter of 1999. Third quarter 1999 revenues showed a 7.0% sequential increase over the second quarter of 1999 in spite of seasonal factors that generally reduce sales during the summer months and were 22.6% above 1998 third quarter net revenues. Second quarter 1999 net revenues increased 6.9% compared to the first quarter, and were 11.2% above second quarter 1998 net revenues. First quarter 1999 net revenues declined 1.7% compared to the fourth quarter of 1998 due to normal seasonal patterns, and were 10.7% above first quarter 1998 net revenues.

With respect to the product groups, the Memory Products Group had the highest year-over-year and quarter-over-quarter results; its revenues in the 1999 fourth quarter rose nearly 41% in comparison to the 1998 fourth quarter and increased approximately 22% in comparison to the 1999 third quarter, reflecting the Company's significant progress in penetrating the market with new generation flash products. In the 1999 fourth quarter, net revenues from the Telecommunications, Peripherals and Automotive Group increased sequentially nearly 17%, reflecting the strength in sales of ICs for telecommunications, mainly wireless, hard disk drives, digital cellular phones and automotive applications. For the same period, net revenues from the Consumer and Microcontrollers Groups increased 15% and net revenues from the Discrete and Standards ICs Products Group increased slightly more that 13%. Overall, the Company's 16% sequential revenue growth of the 1999 fourth quarter resulted from the rapidly increasing demand for its products as well as its ability to effectively deploy its resources.

In 1999, approximately 36% of the Company's net revenues originated in Europe, compared to approximately 42% in 1998. The Company's third quarter revenues in Europe have averaged slightly less than average revenues during other quarters due to production slowdowns by its European customers in July and August. Quarterly results have also been and may be expected to continue to be substantially affected by the cyclical nature of the semiconductor and electronic systems industries, the timing and success of new product introductions and the levels of provisions and other unusual charges incurred.

Gross profit. In the fourth quarter, 1999, gross profit was \$595.8 million, 37.2% above the year-ago period. Gross margin in the 1999 fourth quarter was 40.3%, representing a significant improvement compared to 38.3% in the fourth quarter 1998, and to 39.8% in the third quarter 1999.

Selling, general and administrative expenses. Selling, general and administrative expenses were \$148.0 million in the fourth quarter 1999, or 10.0% of net revenues, compared to \$121.9 million, or 10.8% of net revenues in the fourth quarter 1998.

Research and development expenses. In the fourth quarter 1999, research and development costs of \$234.1 million increased 30.6% compared to the fourth quarter 1998. Research and development represented 15.8% of net revenues in the fourth quarter 1999, unchanged from a year-ago period.

Operating income. Operating income reached \$217.5 million in the fourth quarter 1999 which represented an increase of 40.5% compared to the level of the fourth quarter 1998. Operating margin for the 1999 fourth quarter was 14.7% compared to 13.7% in the 1998 fourth quarter, and to 13.3% in the 1999 third quarter.

Net income. Net income for the 1999 fourth quarter rose sharply, increasing 51.3% to \$184.3 million compared to \$121.8 million in the 1998 fourth quarter and 36.2% compared to \$135.3 million in the third quarter 1999. Earnings per diluted share increased 47.6% to \$0.62 from \$0.42 in the fourth quarter 1998. All per share figures have been adjusted to reflect the 2-for-1 stock split effected in June 1999.

Looking ahead, due to improved order visibility, the Company believes that, in contrast to normal seasonal patterns, revenues may increase sequentially in the first quarter of 2000 compared to fourth quarter 1999 levels. Moreover, a modest sequential increase in gross margin may be expected in the first quarter, despite the use of external foundry services to complement the Company's internal capacity. The Company has entered 2000 very well positioned in terms of product portfolio and technology, strategic partnerships, financial position and backlog. In the fourth quarter, the Company made cap-ital investments of \$536 million designed to progressively increase and enhance its capacity and ability to meet the high level of demand for its products during this market recovery.

Impact of Changes in Exchange Rates

The Company's results of operations and financial condition can be significantly affected by changes in exchange rates between the U.S. dollar and other currencies, particularly the euro (with respect to prior periods, the Italian lira, the French franc, the German mark), the Japanese yen and other Asian

Source: STMICROELECTRONICS N, 20-F, June 27, 2000

currencies.

Revenues for certain products (primarily dedicated products sold in Europe and Japan) that are quoted in currencies other than the U.S. dollar are directly affected by fluctuations in the value of the U.S. dollar. Revenues for all other products, which are quoted in U.S. dollars and translated into local currencies for payment, tend not to be affected significantly by fluctuations in exchange rates except to the extent that there is a lag between changes in currency rates and adjustments in the local currency equivalent price paid for such products.

Certain significant costs incurred by the Company, such as manufacturing labor costs and depreciation charges, selling, general and administrative expenses, and research and development expenses, are incurred in the currencies of jurisdictions where the Company's operations are located. Fluctuations in the value of these currencies, particularly the euro, compared to the U.S. dollar can affect the Company's costs and therefore its profitability.

The appreciation in the U.S. dollar in 1999 compared to 1998 against the principal European and Asian currencies (excluding Japanese yen, which appreciated compared to the U.S. dollar) that have a material impact on the Company resulted in a favorable impact on results of operations for the period because of the favorable impact on cost of sales and operating expenses.

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The Company's principal strategies to reduce the risks associated with exchange rate fluctuations have been (i) to increase the proportion of sales to customers denominated in U.S. dollars, (ii) to purchase raw materials and services in transactions denominated in U.S. dollars (thereby reducing the exchange rate risk for costs relative to revenues, which are principally denominated or determined by reference to the U.S. dollar), and (iii) to manage certain other costs, such as financial costs, to maintain an appropriate balance between U.S. dollars and other currencies based upon the currency environment at the time. From time to time, the Company purchases or sells currencies forward to cover currency risk in obligations or receivables. The Company has not experienced significant gains or losses as a result of exchange coverage activities. Its management strategies to reduce exchange rate risks have served to mitigate, but not eliminate, the positive or negative impact of exchange rate fluctuations. Furthermore, the introduction of the euro as of January 1, 1999, has served to reduce the number of currencies whose exchange rate fluctuations versus the U.S. dollar may impact the Company's results, thus making the Company's exposure to exchange rate fluctuations more concentrated.

Assets and liabilities of subsidiaries are, for consolidation purposes, translated into U.S. dollars at the period-end exchange rate. See Note 2.3 to the Consolidated Financial Statements. Income and expenses are translated at the average exchange rate for the period. Adjustments resulting from the translation are recorded directly in shareholders' equity, and are shown as "accumulated other comprehensive income (loss)" in the consolidated statements of changes in shareholders' equity. The balance sheet impact of such translation adjustments has been, and may be expected to be, significant from period to period.

At December 31, 1999, the Company's outstanding indebtedness was denominated principally in U.S. dollars, Italian lire, and French francs. See Note 13 to the Consolidated Financial Statements.

Liquidity and Capital Resources

On September 22, 1999, the Company completed an equity offering of 2,990,000 shares of capital stock at \$74.6250 per share (the "1999 Share Offering"). The net proceeds to the Company in connection with the 1999 Share Offering were \$216.8 million. On September 22, 1999, the Company also completed a debt offering of \$720.9 million aggregate initial principal amount of zero-coupon convertible Liquid Yield Option NotesTM due 2009 (the "1999 LYONS"), with yield to maturity of 2.4375% per annum (the "1999 LYONs Offering"). The net proceeds to the Company in connection with the 1999 LYONs Offering was \$708.3 million. The Company's net cash generated from operations totalled \$1,469.3 million in 1999 compared to \$1,012.5 million in 1998 and \$983.8 million in 1997. Significant amounts of net cash generated from operations in 1997, 1998 and 1999 coupled with the capital increases and debt offering undertaken by the Company in September 1999, and in June 1998, enabled the Company to finance capital expenditures and strengthen its balance sheet over the last five years. The Company had a positive net financial position (cash, cash equivalents and marketable securities net of total debt) of \$351.4 million at December 31, 1999 compared to a positive net financial position of \$153.7 million at December 31, 1998. At December 31, 1999, cash and cash equivalents totalled \$1,823.1 million, compared to \$1,100.7 million at December 31, 1998 and \$702.2 million at December 31, 1997. At December 31, 1999, the aggregate amount of the Company's long-term credit facilities was approximately \$1,445 million, all of which was outstanding, and additionally the aggregate amount of the Company's short-term facilities was approximately \$1,063 million, under which approximately \$26 million of indebtedness was outstanding. At December 31, 1999, the Company had approximately \$97 million of long-term indebtedness that will become due within one year and expects to fund such debt repayments from available cash. During the fourth quarter 1999, certain holders of the 1998 LYONS Offering converted their debt into shares of common stock for an amount of \$52.5 million principal amount at maturity.

In 1999, the Company's capital expenditure payments totalled \$1,347.5 million, compared to \$947.3 million in 1998. Capital expenditures for 1999 were devoted principally to (i) expand a 6-inch facility and the construction of a new 8-inch front-end facility in Agrate, Italy, (ii) equip and upgrade both the new 8-inch and existing 6-inch front-end facilities at the Catania, Italy, plant, (iii) expand the 8-inch front-end wafer fabrication plant in Crolles, France, (iv) expand the 6-inch facility in Carrollton, Texas, (v) upgrade the 6-inch front-end facility in Rousset, France, (vi) ramp-up of production at the Phoenix, Arizona, 8-inch front-end facility, (vii) construct the new 8-inch front-end plant in Rousset, France, (viii) expand the back-end facilities in Muar, Malaysia and (ix) expand the back-end facilities in Morocco, Malta and Shenzhen, China. Capital expenditures for 1998 were devoted principally to (i) expand the 8-inch front-end wafer fabrication plant in Crolles, France, (ii) equip and upgrade both the new 8-inch and existing 6-inch front-end facilities at the Catania, Italy, plant, (iii) extend and convert an existing facility in Agrate, Italy, (iv) expand the 6-inch facility in Carrollton, Texas, (v) ramp-up production at the Phoenix, Arizona, 8-inch front-end facility, (vi) expand the back-end facilities in Muar, Malaysia and (vii) expand the back-end facilities in Morocco, Malta and Shenzhen, China.

The Company currently expects approximately \$2.3 billion capital spending for 2000, significantly higher than in 1998 and 1999. The most significant of the Company's 2000 capital expenditure projects are expected to be (i) the conversion from 6-inch to 8-inch and expansion at one of its front-end wafer fabrication plants in Agrate, Italy, (ii) the increase of

capacity of the 8-inch facilities in Catania, Italy, (iii) the completion of construction of its new 8-inch front-end wafer fabrication facility in Rousset, France, (iv) the conversion of its facilities in Crolles, France, to 0.25 micron and 0.18 micron processes, (v) the construction of a new 8-inch fab facility and the equipment of a new 6-inch facility in Singapore, (vi) the increase of capacity of its 8-inch facilities in Phoenix, Arizona, and of the 6-inch facility in Carrollton and (vii) the expansion of the back-end facilities in Muar, Morocco and Singapore. The Company has also identified an additional 8-inch wafer fabrication facility to be built in Italy that is planned to be operational by the year 2001. The Company has decided to build a new 300 millimeter, 12-inch wafer research fabrication and pilot line at Crolles (France) using 0.18 micron and below process technology. The pilot line will be operated in partnership with LETI and CNET, which are already working with the Company in Crolles. As of December 31, 1999, the Company had commitments of approximately \$1.2 billion for equipment purchases. The Company will continue to monitor its level of capital spending, however, taking into consideration factors such as trends in the semiconductor market, capacity utilization and announced additions.

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At December 31, 1999, the Company's receivables from government agencies totalled \$152.2 million compared to \$261.2 million in 1998 and \$154.9 million in 1997. The decrease in 1999 was due primarily to the cash recognition of certain government contracts. See Note 6 to the Consolidated Financial Statements. In 1999, the Company's advances from government agencies totalled \$38.7 million compared to \$14.1 million in 1998 and \$10.1 million in 1997. See Note 14 to the Consolidated Financial Statements. The timing of receipt of funds under government contracts has been delayed from time to time in the past, and while generally the Company has received the amounts recorded in such receivables, there have been instances in which such funds ultimately have not been paid.

The Company expects to have significant capital requirements in the coming years and intends to continue to devote a substantial portion of its net revenues to research and development. The Company plans to fund its capital requirements from cash from operations, available funds, available support from third parties (including state support) and may make recourse to borrowings under available credit lines and, to the extent necessary or attractive based on market conditions prevailing at the time, the sale of debt or additional equity securities. There can be no assurance that additional financing will be available as necessary to fund the Company's working capital requirements, research and development, industrialization costs or expansion plans, or that any such financing, if available, will be on terms acceptable to the Company.

The Company believes that its available funds, available support from third parties, and additional borrowings will be sufficient to meet its anticipated needs for liquidity through at least 2001.

New accounting pronouncements

In June 1998, the Financial Accounting Standards Board issued Statement of Financial Accounting Standards No. 133 (FAS 133), "Accounting for Derivative Instruments and Hedging Activities." FAS 133 is required to be adopted for fiscal years beginning after June 15, 2000. This statement establishes accounting and reporting standards for derivative instruments and requires recognition of all derivatives as assets or liabilities in the balance sheet, and the measurement of those instruments at fair value. The Company will adopt the standards required by this statement in 2001. Management has not fully evaluated the impact, if any, that this new standard may have on future consolidated results of operations, financial position, or financial statement disclosure.

Year 2000

The overall cost of the Company's year 2000 readiness was below the Company's expectations and totalled approximately \$30 million, including both expenses and capital expenditures. The Company instituted heightened year 2000 procedures to detect and remedy year 2000-related problems from December 31, 1999 to January 9, 2000, and at the end of January no significant year 2000-related problems were detected. The Company will institute similar year 2000 follow- up procedures at the end of February (a leap year), March (first quarter) and December (year end), with support teams available in case of need.

Euro Conversion

On January 1, 1999, eleven of the fifteen member countries of the European Union established fixed conversion rates between their existing national currencies and the euro. The participating countries have agreed to adopt the euro as their common legal currency on that date. Until January 1, 2002, either the euro or a participating country's present currency (a "national currency") will be accepted as legal currency. On January 1, 2002, euro-denominated bills and coins will be issued and national currencies will be withdrawn from circulation.

The Company does not expect that introduction and use of the euro will materially affect its foreign exchange activities, or its use of derivatives and other financial instruments, or will result in any material increase in costs to the Company. The Company will continue to assess the impact of the introduction of the euro currency over the transition period as well as the period subsequent to the transition, as applicable.

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Consolidated Statement of Income

Year ended December 31, (in thousands of US dollars except per share amounts)

	1997	1998	1999
Net sales Other revenues	3,969,773 49,372	4,210,618 37,134	5,023,109 33,167
Net revenues Cost of sales	4,019,145 (2,457,386)	4,247,752 (2,622,943)	5,056,276 (3,054,476)
Gross profit Selling, general and administrative Research and development Other income and expenses	1,561,759 (454,311) (610,847) 23,218	1,624,809 (488,072) (689,785) 76,458	2,001,800 (534,178) (835,964) 39,840
Operating income Net interest income (expense)	519,819 (2,646)	523,410 8,691	671,498 35,624
Income before income taxes & minority interests Income tax expense	517,173 (113,017)	532,101 (120,351)	,
Income before minority interests	404,156	411,750	549,908
Minority interests	2,398	(629)	(2,656)
Net income	406,554	411,121	547,252
Earnings per share (Basic)	1.46	1.46	1.91
Earnings per share (Diluted)	1.45	1.44	1.87

The accompanying notes are an integral part of these financial statements.

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As at December 31,		
(in thousands of US dollars)		
	1998	1999
Assets		
Current assets	1 100 550	1 000 000
Cash and cash equivalents Trade accounts and notes receivable	1,100,752 779,489	1,823,086 913,282
Inventories	644,279	619,402
Other receivables and assets	496,582	435,784
Fotal current assets	3,021,102	
Intangible assets, net	33,571	179,947
Property, plant and equipment, net Investments and other non-current assets	3,333,005 46,351	3,873,019 85,783
	3,412,927	4,138,749
Fotal assets	6,434,029	7,930,303
Liabilities and shareholders' equity		
Current liabilities		
Bank overdrafts	146,040	26,471
Current portion of long-term debt	45,245	96 , 669
Trade accounts and notes payable	564,457	998,881
Other payables and accrued liabilities	327,681	381,845
Accrued and deferred income tax	173,097	189,308
Fotal current liabilities	1,256,520	1,693,174
Long-term debt	755,864	1,348,477
Reserves for pension and termination indemnities	111,803	108,294
Other non-current liabilities	204,520	191,660
	1,072,187	1,648,431
 Fotal liabilities	2,328,707	3,341,605
Minority interests	22,012	24,757
Common stock	1,096,743	1,112,680
Capital surplus	1,135,526	1,395,307
Accumulated result	2,027,413	2,551,817
Accumulated other comprehensive income	(176,372)	(495,863
Shareholders' equity	4,083,310	4,563,941

Commitments and contingencies: Notes 20 and 21 The accompanying notes are an integral part of these financial statements.

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Consolidated Statement of Cash Flows

Year ended December 31, (in thousands of US dollars)

	1997	1998	1999
Cash flows from exception activities.			
Cash flows from operating activities: Net income	406,554	411,121	547,252
Add (deduct) non-cash items:	400,004	411,121	547,252
Depreciation and amortization	608,123	704,004	806,789
Other non-cash items	19,015	13,016	4,527
Minority interest in net income of subsidiaries	(2,398)	629	2,656
Deferred taxes	(3,157)	34,333	28,711
Changes in assets and liabilities:			
Trade accounts and notes receivable	(74,721)	(115,879)	(164,564)
Inventories	(149,642)	(18,807)	(38,340)
Trade accounts and notes payable	73 , 790	45,982	208,899
Other assets and liabilities, net	106,227	(61,852)	73,352
Net cash provided by operating activities	983,791	1,012,547	1,469,282
Cash flows from investing activities:			
Payment for purchases of tangible assets	(1,035,434)	(947,253)	(1,347,537)
Other investing activities	(11,576)	(18,997)	(190,290)
Net cash used in investing activities	(1,047,010)	(966 , 250)	(1,537,827)
Cash flows from financing activities:			
Proceeds from issuance of long-term debt	250,759	424,955	756,836
Repayment of long-term debt	(80,238)	(72,396)	(48,080)
Increase (decrease) in short-term facilities	68,869	(233,261)	(110,308)
Capital increase	9,669	233,334	230,437
Dividends paid			(22,848)
Net cash provided by financing activities	249,059	352 , 632	806,037
Effect of changes in exchange rates	(35,579)	(334)	(15,158)
Net cash increase	150,261	398,595	722,334
Cash and cash equivalents			
at beginning of the period	551,896	702,157	1,100,752
Cash and cash equivalents			
at end of the period	702,157	1,100,752	1,823,086

The accompanying notes are an integral part of these financial statements.

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	Common Stock	*	Accumulated Result	Accumulated Other Comprehensive Income (Loss)	Shareholders' Equity
Balance as of December 31, 1996		930,330	1,209,738	47,019	3,260,020
Capital increase Comprehensive income Net Income Other comprehensive income, net of ta	1,057	615	406,554	(360,800)	1,672 406,554 (360,800)
Comprehensive income					45,754
Balance as of December 31, 1997	1,073,990	930,945	1,616,292	(313,781)	3,307,446
Capital increase Comprehensive income Net Income Other comprehensive income, net of ta	·	204,581	411,121	137,409	227,334 411,121 137,409
Comprehensive income					548,530
Balance as of December 31, 1998	1,096,743	1,135,526	2,027,413	(176,372)	4,083,310
Capital increase	15,937	259,781			275,718
Comprehensive income Net Income Other comprehensive income, net of ta	ix		547,252	(319,491)	547,252 (319,491)
Comprehensive income Dividends, \$0.08 per share			(22,848)		227,761 (22,848)
Balance as of December 31, 1999	1,112,680	1,395,307	2,551,817	(495,863)	4,563,941

The accompanying notes are an integral part of these financial statements.

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Notes to Consolidated Financial Statements (in thousands of U.S. dollars, except per share amounts)

1 The Company

STMicroelectronics N.V. (formerly known as SGS-THOMSON Microelectronics N.V.) (the "Company") was formed in 1987 by the combination of the semiconductor business of SGS Microelettronica (then owned by Societa Finanziaria Telefonica (S.T.E.T.), an Italian corporation) and the non-military business of Thomson Semiconducteurs (then owned by Thomson-CSF, a French corporation) whereby each company contributed their respective semiconductor businesses in exchange for a 50% interest in the Company. The Company designs, develops, manufactures and markets a broad range of semiconductor integrated circuits and discrete devices that are used in a wide variety of microelectronic applications.

The Company is registered in The Netherlands with its statutory domicile in Amsterdam.

At December 31, 1999, the Company was 44.80% (December 31, 1998: 56.05%) owned by STMicroelectronics Holding II B.V., and 55.20% by the public (December 31, 1998: 43.95%).

At December 31, 1998, and at December 31, 1999, STMicro-electronics Holding II B.V. was 100% owned by STMicroelectronics Holding N.V.

At December 31, 1998, STMicroelectronics Holding N.V. was owned as follows:

o 50% by FT1CI, a French holding company, whose shareholders are CEA-Industrie (51%) and France Telecom (49%).

o 50% by M.E.I.--Microelettronica Italiana s.r.l. ("M.E.I."), an Italian holding company, whose shareholders are Comitato per l'Intervento nella SIR ed in Settori ad Alta Tecnologia ("Comitato SIR") (49.9%) and Istituto per la Ricostruzione Industriale S.p.a. (I.R.I.) (50.1%).

At December 31, 1999, STMicroelectronics Holding N.V. was owned as follows:

o 50% by FT1CI, a French holding company, whose shareholders are CEA-Industrie (51%) and France Telecom (49%).

o 50% by Finmeccanica, an Italian holding company, whose shareholders are Istituto per la Ricostruzione Industriale S.p.a. (I.R.I.) (54.2%), the Italian Ministry of Treasury (28.9%) and the public (16.9%).

2 Summary of accounting policies

2.1 Principles of consolidation

The accompanying consolidated financial statements have been prepared in accordance with accounting principles generally accepted in the United States of America (U.S. GAAP). The Company's consolidated financial statements include the assets, liabilities and results of operations of its majority-owned subsidiaries. The ownership of other interest holders is reflected as minority interests. Intercompany balances and transactions have been eliminated in consolidation.

2.2 Use of estimates

The preparation of financial statements in accordance with U.S. GAAP requires management to make estimates and assumptions that affect the amounts reported in the financial statements and accompanying notes to the financial statements. Actual results could differ from those estimates and may affect amounts reported in future periods.

2.3 Foreign currency

The U.S. dollar is the reporting currency for the Company because the dollar is the currency of reference in terms of market pricing in the world-wide semiconductor industry. Furthermore, there is no currency in which the majority of transactions are denominated, and revenues from external sales in U.S. dollars exceed revenues in any other currency.

The functional currency of each subsidiary throughout the group is generally the local currency. For consolidation purposes, assets and liabilities of these subsidiaries are translated at current rates of exchange at the balance sheet date. Income and expense items are translated at the average exchange rate for the period. The effects of translating the financial position and results of operations from local functional currencies are included in "other comprehensive income."

Assets, liabilities, revenue, expenses, gains or losses arising from foreign currency transactions are recorded in the functional currency of the recording entity at the exchange rate in effect at the date of the transaction.

Source: STMICROELECTRONICS N, 20-F, June 27, 2000

At each balance sheet date, recorded balances denominated in a currency other than the recording entity's functional currency are translated at the exchange rate prevailing at that date. The related exchange gains and losses are recorded in the income statement.

The Company conducts its business on a global basis in various major international currencies. As a result, it is exposed to adverse movements in foreign currency exchange rates. The Company covers certain portions of its foreign currency exposure primarily through the use of foreign exchange forward contracts and option contracts. Generally, gains and losses associated with exchange rate changes on foreign exchange forward contracts are recorded currently in "other income and expenses," while the interest element is recognized over the life of each contract and is included in operations. The Company utilizes foreign exchange forward contracts and foreign exchange options to manage the effect of currency fluctuations on its probable anticipated transactions. The Company does not enter into foreign exchange forward contracts or option contracts for speculative or trading purposes.

2.4 Reclassifications

Certain prior year amounts have been reclassified to conform with the current year presentation.

2.5 Income recognition

Sales: Revenue on sales of semiconductor products is recognized upon shipment of the products. A portion of the Company's sales are made to distributors who participate in certain programs common in the semiconductor industry whereby the distributors are allowed to return merchandise under certain circumstances and may receive future price reductions. Provision is made at the time of sale for estimated product returns and price protection which may occur under programs the Company has with these customers.

Subsidies: Government subsidies are recognized as the related costs are incurred, commencing when the subsidies' contract is signed with the relevant government department or agency. Government subsidies for research and development are included in "other income and expenses." Government subsidies for industrialization costs (certain costs incurred to bring prototype products to the production stage) are offset against related expenses in "cost of sales." Government subsidies for capital expenditures are deducted

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from the cost of the related fixed assets and reduce depreciation over the assets' remaining estimated useful lives.

2.6 Advertising costs

Advertising costs are expensed as incurred. Advertising expenses for 1997, 1998 and 1999 were \$14,523, \$16,012 and \$21,102, respectively.

2.7 Research and development

Research and development costs are charged to expense as incurred. Research and development costs include costs incurred by the Company as well as the Company's share of costs incurred by other research and development interest groups.

2.8 Start-up costs

Start-up costs incurred to expand the Company's manufacturing facilities are included in "other income and expenses" in the accompanying consolidated statement of income.

2.9 Income taxes

The provision for current taxes represents the income taxes expected to be payable for the current year. Deferred tax assets and liabilities are recorded for all temporary differences arising between the tax and book bases of assets and liabilities and for the benefits of tax credits and loss carryforwards. Those deferred tax assets and liabilities are measured using the enacted tax rates at which they are expected to be realized or paid. A valuation allowance is provided where necessary to reduce deferred tax assets to the amount expected to be "more likely than not" realized in the future.

2.10 Earnings per share

Basic earnings per share are computed by dividing net income by the weighted average number of common shares outstanding during the period. Diluted earnings per share are computed by dividing net income (less interest expense, net of tax effects, related to convertible debt) by the weighted average number of common shares and common share equivalents outstanding during the period. The weighted average shares used to compute diluted earnings per share include the incremental shares of common stock relating to outstanding options and convertible debt to the extent such incremental shares are dilutive.

2.11 Cash equivalents

All highly liquid investments purchased with an original maturity of ninety days or less are considered to be cash equivalents.

2.12 Inventories

Inventories are stated at the lower of cost or market. Cost is computed on a currently adjusted standard basis which approximates actual cost on a current average basis.

2.13 Intangible assets

Intangible assets include the cost of technologies and licenses purchased from third parties, amortized over a period ranging from five to ten years, and goodwill acquired in business combinations amortized over its estimated useful life, generally five years.

The carrying value of long-lived assets, including intangibles, is evaluated whenever changes in circumstances indicate the carrying amount of such assets may not be recoverable. In performing such review for recoverability, the Company compares the expected future cash flow to the carrying value of long-lived assets and identifiable intangibles. If the anticipated undiscounted future cash flows are less than the carrying amount of such assets, the Company recognizes an impairment loss for the difference between the carrying amount of the assets and their estimated fair value.

2.14 Property, plant and equipment

Property, plant and equipment are stated at cost, net of government subsidies. Major renewals and improvements are capitalized; minor replacements, maintenance and repairs are charged to current operations. Depreciation is computed using the straight-line method over the following estimated useful lives:

Buildings	33 years
Leasehold improvements	10 years
Machinery and equipment	6 years
Computer and R&D equipment	3-6 years
Other	2-5 years

Assets subject to leasing agreements and classified as capital leases are included in property, plant and equipment and depreciated over the shorter of the estimated useful life or the lease term.

2.15 Investments

The equity accounting method is used when the Company has both a 20% to 50% equity interest and the ability to exercise significant influence over the investee. The Company also holds certain equity investments constituting less than 20% ownership of the investee. These investments are carried at historical cost. Although the market value of the investments is not readily determinable, management believes the fair value of these investments exceed their carrying amounts.

2.16 Pension and termination indemnities

The Company sponsors various retirement plans for its employees; such plans include both defined benefit and defined contribution plans. Upon retirement, the Company's employees receive benefits provided by the pension plan arrangements. These plans conform with local regulations and practices of the countries in which the Company operates.

2.17 Comprehensive income

In 1998, the Company adopted Statement of Financial Accounting Standards No. 130, "Reporting Comprehensive Income" (FAS 130). FAS 130 established standards for reporting comprehensive income and its components and accumulated balances. Comprehensive income is defined as the change in equity of a business during a period from transactions and circumstances related to non-owner sources, and includes all changes in equity except those resulting from investment by owners and distributions to owners. In the Company's case, "other comprehensive income" consists of foreign currency translation adjustments.

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In May 1999, the Company's shareholders approved a two-for-one stock split of the Company's common stock. The record date for the stock split was June 16, 1999, and the distribution date was June 17, 1999. All earnings per share amounts, references to common stock, shareholders' equity amounts and stock option plan data have been restated as if the stock split had occurred as of the earliest period presented.

2.19 New accounting pronouncements

In June 1998, the Financial Accounting Standards Board issued Statement of Financial Accounting Standards No. 133 (FAS 133), "Accounting for Derivative Instruments and Hedging Activities." FAS 133 is required to be adopted for fiscal years beginning after June 15, 2000. This statement establishes accounting and reporting standards for derivative instruments and requires recognition of all derivatives as assets or liabilities in the balance sheet, and the measurement of those instruments at fair value. The Company will adopt the standards required by this statement in 2001. Management has not fully evaluated the impact, if any, that this new standard may have on future consolidated results of operations, financial position, or financial statement disclosure.

3 Consolidated Entities

The consolidated financial statements include the accounts of STMicroelectronics N.V. and the following entities as of December 31, 1999:

United KingdomLondonSTMicroelectronics LTD100LondonThomson Components LTD100BristolSTMicroelectronics E.E.I.G.100GermanyMunichSTMicroelectronics A.B.100SwedenStockholmSTMicroelectronics GmbH100SwitzerlandGenevaSTMicroelectronics S.A.100MaltaMaltaSTMicroelectronics S.A.100SpainMadridSTMicroelectronics S.A.100ItalyMilanoSTMicroelectronics S.A.100ItalyMilanoSTMicroelectronics S.A.100CataniaCO.R.I.M.ME.100MalaysiaMuarSTMicroelectronics S.A.100MalaysiaMuarSTMicroelectronics SDN BHD100MarSTMicroelectronics SDN BHD100JapanTokyoSTMicroelectronics MALAYSIAN SDN BHD100AustraliaSydneySTMicroelectronics ITD100AustraliaSydneySTMicroelectronics Inc.100LaganHong KongSTMicroelectronics Inc.100AustraliaSydneySTMicroelectronics Inc.100La JollaMetaflow Technologies Inc.100BrazilSo PauloSTMicroelectronics Inc.100CasablancaSTMicroelectronics Itda100CasablancaSTMicroelectronics Leasing Co. Inc.100CondaSo PauloStMicroelectronics Itda100Marcelectonic Holding S.A.100So Paulo100M	Legal Seat		C	ercentage Ownership Direct or Indirect)
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4 Trade accounts and notes receivable

Trade accounts and notes receivable consist of the following:

December 31,	1998	1999
Trade accounts and notes receivable Less valuation allowance	789,983 (10,494)	924,872 (11,590)
Total	779,489	913,282

During 1997 and 1998 no customer individually represented over ten percent of consolidated net revenues. In 1999, one customer represented 11.4% of consolidated net revenues.

5 Inventories

Inventories consist of the following:

December 31,	1998	1999
Raw materials Work-in-process Finished products	107,546 392,666 144,067	101,590 395,320 122,492
Total	644,279	619,402
6 Other receivables and assets		
Other receivables and assets consist of the follow	ving:	

December 31,	1998	1999
Receivables from government		
agencies	261,194	152,237
Taxes and other government		
receivables	64,573	61,523
Down payment to suppliers	6,274	11,394
Loans to employees	3,580	3,557
Prepaid expenses	18,222	17,648
Sundry debtors	23,989	35,053
Deferred tax assets	80,247	73,079
Other	38,503	81,293
Total	496,582	435,784

Receivables from government agencies relate to research and development contracts, industrialization contracts and capital expenditures.

7 Intangible assets

Intangible assets consist of the following:

December 31,	1998	1999
Goodwill Technologies and licenses Less accumulated amortization	6,734 86,368 (59,531)	67,417 202,560 (90,030)
Total	33,571	179,947

8 Property, plant and equipment

Property, plant and equipment consist of the following:

December 31, 1998	Gross	Depreciation	Net
Land and buildings Machinery and	506,140	(118,415)	387,725
equipment Other tangible	5,357,281	(2,866,957)	2,490,324
fixed assets Construction in	360,123	(253,956)	106,167
progress	348,789		348,789
Total	6,572,333	(3,239,328)	3,333,005

Net

December 31, 1999 Gross Depreciation

Source: STMICROELECTRONICS N, 20-F, June 27, 2000

Land and buildings	616,035	(132,973)	483,062
Machinery and			
equipment	6,216,830	(3,266,819)	2,950,011
Other tangible			
fixed assets	321,494	(235,968)	85,526
Construction in			
progress	354,420		354,420
		() () 7(0)	2 072 010
Total	7,508,779	(3,635,760)	3,873,019

9 Investments and other non-current assets

Investments and other non-current assets consist of the following:

December 31,	1998	1999
Investments Long-term deposits and receivables Deferred tax assets Debt issuance costs	11,403 13,053 12,547 9,348	20,056 12,435 33,373 19,919
Total	46,351	85,783

10 Shareholders' equity

Public offerings of shares: In connection with a secondary offering of common stock in June 1998, the Company issued 6,000,000 new shares of common stock, which resulted in an increase in common stock and capital surplus of \$20,378 and \$188,320, respectively. In connection with a secondary offering of common stock in September 1999, the Company issued 2,990,000 new shares of common stock, which resulted in an increase in common stock and capital surplus of \$9,740 and \$207,027, respectively.

Outstanding shares: The authorized share capital of the Company is EUR 1,809,600,000, consisting of 400,000,000 common shares and 180,000,000 preference shares each with a nominal value of EUR 3.12. As of December 31, 1997, 1998 and 1999, the number of shares of common stock outstanding at a par value of EUR 3.12 was 278,264,794 shares, 284,956,212 shares and 289,808,140 shares, respectively. There were no preference shares outstanding as of December 31, 1998 and 1999.

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Preference shares: In May 1999, the Company's shareholders approved the creation of 180,000,000 preference shares. The preference shares entitle a holder to full voting rights and to a preferential right to dividends and distributions upon liquidation. In May 1999, the Company entered into an option agreement with ST Holding II B.V. in order to protect the Company from a hostile takeover or other similar action. The option agreement provides for 180,000,000 preference shares to be issued to ST Holding II B.V. upon their request based on approval by the Company's Supervisory Board. ST Holding II B.V. would be required to pay at least 25% of the par value of the preference shares to be issued, and to retain ownership of at least 33% of the Company's issued share capital.

Stock option plans: In 1989, the Shareholders voted to adopt the 1989 Stock Option Plan (the "1989 Plan") and approved the issuance of 3,268,800 options to 136 employees to purchase common stock. Under the 1989 Plan, the options vested over four years and were exercisable for ten years at an exercise price of NLG 8.75.

In 1995, the Shareholders voted to adopt the 1995 Stock Option Plan (the "1995 Plan") whereby options for up to 11,000,000 shares may be granted in installments over a five year period. Under the 1995 Plan, the options may be granted to purchase shares of common stock at a price not lower than the market price of the shares on the date of grant, and generally vest over four years and are exercisable over a period of eight years. In March 1996, the Company granted 2,400,000 options to employees at an exercise price of \$18.13 per share. In September 1997, the Company granted 1,291,000 options to employees at an exercise price of \$42.69 per share. In July 1998, the Company granted 1,300,000 options to employees at an exercise price of \$36.09 per share. In September 1999, the Company granted 2,959,400 options to employees at an exercise price of \$74.63 per share.

In 1996, the Shareholders voted to adopt the Supervisory Board Option Plan whereby members of the Supervisory Board were eligible to receive, during the three year period 1996-1998, 6,000 options for 1996 and 3,000 options for both 1997 and 1998, to purchase shares of common stock at the closing market price of the shares on the date of the grant. In the same three-year period, professionals of the Supervisory Board were eligible to receive 3,000 options for 1996 and 1,500 options for both 1997 and 1998. Under the Plan, the options vest over one year and are exercisable for a period expiring eight years from the date of grant. In October 1996, options to purchase 66,000 shares were granted at an exercise price of \$27.00 per share. In September 1997, options to purchase 30,000 shares were granted at an exercise price of \$42.69 per share. In July 1998, options to purchase 30,000 shares were granted at an exercise price of \$36.09 per share.

In 1999, the Shareholders voted to renew the Supervisory Board Option Plan whereby members of the Supervisory Board may receive, during the three year period 1999-2001, 6,000 options for 1999 and 3,000 options for both 2000 and 2001, to purchase shares of capital stock at the closing market price of the shares on the date of the grant. In the same three-year period, professionals of the Supervisory Board may receive 3,000 options for 1999 and 1,500 options for both 2000 and 2001. Under the Plan, the options vest over one year and are exercisable for a period expiring eight years from the date of grant. In September 1999, options to purchase 60,000 shares were granted at an exercise price of \$74.63 per share.

A summary of stock option activity for the plans for the three years ended December 31, 1999, follows:

	Number of	Pric	e Per Share
	Shares	Range	Average
Outstanding at December 31, 1996	2,989,820	\$5.20-\$27.00	\$16.08
Options granted: 1995 Plan Supervisory Board Plan Options cancelled Options exercised	1,291,000 30,000 (36,000) (274,760)	\$42.69 \$42.69 \$18.13-\$42.69 \$4.51-\$18.13	
Outstanding at December 31, 1997 Options granted:	4,000,060	\$4.51-\$42.69	\$25.43
1995 Plan Supervisory Board Plan Options cancelled Options exercised	1,300,000 30,000 (19,130) (114,820)	\$36.09 \$36.09 \$18.13-\$42.69 \$4.61-\$27.00	
Outstanding at December 31, 1998 Options granted:	5,196,110	\$4.61-\$42.69	\$28.59

Source: STMICROELECTRONICS N, 20-F, June 27, 2000

1995 Plan	2,959,400	\$74.63	\$74.63
Supervisory Board Plan	60,000	\$74.63	\$74.63
Options cancelled	(53,880)	\$18.13-\$74.63	\$42.90
Options exercised	(922,400)	\$4.00-\$42.69	\$16.42
Outstanding at December 31, 1999	7,239,230	\$18.13-\$74.63	\$49.22

Stock options exercisable were as follows:

Year Ended December 31,	1997	1998	1999
Options exercisable Weighted average	348,060	273,640	877,110
exercise price	\$9.27	\$14.75	\$19.37

The weighted average remaining contractual life of options outstanding as of December 31, 1999 was 6.4 years.

Employee stock purchase plans: In June 1998, the Company offered to certain of its employees world-wide the right to acquire up to 800 shares of capital stock per employee, at a price of \$31.76 (189 French francs, 55,400 Italian lira) per share, representing a discount of twelve percent from the market price. A total of 576,598 shares were issued to participating employees world-wide as a result of the offering.

Fair value of stock-based compensation: The Company has various stock option plans and employee stock purchase plans, as described above. The Company applies the intrinsic-value-based method prescribed by Accounting Principles Board Opinion No. 25 "Accounting for Stock Issued to Employees" (APB 25), and related Interpretations, in accounting for stock-based awards to employees. Under APB 25, the Company generally recognizes no compensation expense with respect to such awards.

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Pro forma information regarding net income and earnings per share is required by Statement of Financial Accounting Standards No. 123 "Accounting for Stock-Based Compensation" (FAS 123) as if the Company had accounted for its stock-based awards to employees under the fair value method prescribed by FAS 123. The fair value if the Company's stock-based awards to employees was estimated using a Black-Scholes option pricing model. The fair value was estimated using the following weighted-average assumptions:

	1997	1998	1999
Expected life (years) Volatility Risk-free interest rate Dividend yield	5 40.7% 6.2% 	5 38.2% 5.4% 	5 41.0% 5.8% 0.1%

The weighted average fair value of options granted during 1997, 1998 and 1999 was \$19.20, \$16.95 and \$33.24 per option, respectively.

If compensation cost for the Company's stock-based compensation plans had been determined based on the fair value at the grant dates consistent with FAS 123, the Company's net income and earnings per share would have been adjusted to the pro forma amounts indicated below:

1997	1998	1999
399 , 509	393,949	522 , 593
1.44	1.40	1.82
1.43	1.38	1.78
	399,509	399,509 393,949 1.44 1.40

These pro forma amounts include amortized fair values attributable to stock-based awards granted after December 31, 1995 only, and are therefore not representative of future pro forma amounts.

Retained earnings: At December 31, 1999, the amount of retained earnings available to pay dividends under Dutch law was approximately \$3,653,000 (1998: \$2,987,000). Retained earnings for purposes of this calculation are based upon generally accepted accounting principles in The Netherlands. The Company's subsidiaries are subject to the laws of the countries in which they are domiciled. These laws may restrict the ability of the subsidiaries to transfer funds to the Company. Such restrictions are not considered to be significant as of December 31, 1999.

11 Earnings per share

For the years ended December 31, 1997, 1998 and 1999 earnings per share (EPS) was calculated as follows:

Year Ended December 31,	1997	1998	1999
Basic EPS Net income Weighted average	406,554	411,121	547,252
shares outstanding Basic EPS Diluted EPS	278,185,800 1.46	281,704,016 1.46	
Net income Convertible debt	406,554	411,121	547,252
interest, net of tax	0	4,566	13,387
Net income adjusted Weighted average	406,554	415,687	560,639
shares outstanding Dilutive effect of	278,185,800	281,704,016	286,370,556
stock options Dilutive effect	1,515,392	1,265,126	2,665,186
of convertible debt	0	5,141,918	11,372,228
Number of shares used in calculating EPS Diluted EPS	279,701,192 1.45	288,111,060 1.44	300,407,970 1.87

12 Retirement plans

The Company and its subsidiaries have a number of defined benefit pension plans covering employees in various countries. The plans provide for pension benefits, the amounts of which are calculated based on factors such as years of service and employee compensation levels. Eligibility is generally determined in accordance with local statutory requirements. The Company also has a defined benefit termination plan in Italy whereby an indemnity is paid to personnel upon termination of employment.

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December 31,	1998	1999
Change in benefit obligation: Benefit obligation at beginning of year Service cost Interest cost Benefits paid Actuarial losses Foreign currency translation adjustments	169,455 17,045 7,551 (8,293) 4,034 7,258	195,115 20,318 8,642 (8,883) 9,137 (19,939)
Other	(1,935)	(1,737)
Benefit obligation at end of year	195,115	202,653
Change in plan assets: Plan assets at fair value at beginning of year Actual return on plan assets Employer contributions Benefits paid Foreign currency translation adjustment Other	77,455 8,228 5,223 (8,293) 1,062 (437)	83,238 13,424 13,853 (8,883) (2,236) 53
Plan assets at fair value at end of year	83,238	99,449
Funded status Unrecognized prior service cost Unrecognized transition obligation Unrecognized net actuarial gain (loss)	(111,877) 7,848 (3,281) 820	(103,204) 7,853 (3,022) (2,034)
Accrued benefit cost	(106,490)	(100,407)
Net amount recognized in the balance sheet consists of the following: Prepaid benefit cost Accrued benefit liability Intangible asset 	3,883 (111,803) 1,430 (106,490)	5,663 (108,294) 2,224 (100,407)

Each year, the liability for the Italian indemnity plan is adjusted to reflect current year compensation as well as a revaluation of prior years' accruals based on an index. The plan is unfunded, and all participants are fully vested.

The components of the net periodic benefit cost includes the following:

December 31,	1997	1998	1999
Service cost	17,501	17,045	20,318
Interest cost	8,155	7,551	8,642
Expected return on			
plan assets	(4,478)	(6,147)	(5,955)
Amortization of			
unrecognized			
transition obligation	(282)	(366)	(324)
Recognized gains			
and losses	56	56	503
Recognition of prior			
service cost	553	762	850
Net periodic benefit cost	21,505	18,901	24,034

The weighted average assumptions used in the determination of the net pension cost for the pension plans were as follows:

Assumptions	1997	1998	1999
Discount rate Salary increase rate Expected rate of return	5.98% 4.21%		4.72% 3.50%
on funds	8.53%	8.43%	7.04%
13 Long-term debt			
Long-term debt, all of which is unsecured, subsidiaries:	includes	debt held by the	following
		1998	1999
STMicroelectronics SA (France) - 4.97% Bank Loan due 2002 - 4.95% Bank Loan due 2002		35,712 35,712	30,718 30,718

- 4.39% Other Bank Loans STMicroelectronics s.r.l. (Italy)	27,204	21,557
- 5.68% Bank Loan due 2002	60,492	52,033
- 5.35% Bank Loan due 2006	44,914	34,322
- 2.15% Government Loan	,	01/022
due 2000	40,276	18,507
- 4.70% Other Bank Loans	86,070	76,727
STMicroelectronics N.V. (Netherlands)	,	-,
- 1.75% Liquid Yield Option Notes		
(LYONs due 2008)	435,885	398,251
- 2.44% Liquid Yield Option Notes		
(LYONs due 2009)		725,813
STMicroelectronics (other countries)		
- 6.01% Other Bank Loans	34,844	56,500
Total long-term debt	801,109	1,445,146
Less current portion	,	96,669
Total long-term debt, less		
current portion	755,864	1,348,477

Long-term debt is denominated in the following currencies:

December 31,	1998	1999
U.S. dollar Italian lira French franc Other	455,885 231,752 98,628 14,844	1,157,366 192,432 82,993 12,355
Total	801,109	1,445,146

Aggregate future maturities of long-term debt outstanding are as follows:

	1999
2000 2001 2002 2003 2004 Thereafter	96,669 86,976 87,168 9,688 10,795 1,153,850
Total	1,445,146

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In June 1998, the Company issued \$513,852 face value of zero-coupon subordinated convertible notes (LYONS), due 2008, for net proceeds of \$421,837. The notes are convertible at any time by the holders at the rate of 17.904 shares of the Company's common stock for each one thousand dollar face value of the notes. The notes may be redeemed by the holders on June 10, 2003 or by the Company on or after that date at the book value, payable in cash. The notes are subordinated to all the other existing and future indebtedness of the Company.

In September 1999, the Company issued \$918,530 face value of zero-coupon subordinated convertible notes (LYONs), due 2009, for net proceeds of \$708,288. The notes are convertible at any time by the holders at the rate of 8.764 shares of the Company's common stock for each one thousand dollar face value of the notes. The notes may be redeemed by the holders on September 22, 2004 or by the Company on or after that date at the book value, payable in cash. The notes are subordinated to all the other existing and future indebtedness of the Company.

. During 1999, \$52,476 face amount of LYONs were converted into 939,528 shares of common stock.

Credit facilities: The Company has revolving line of credit agreements with several financial institutions totaling \$1,062,600. At December 31, 1999, amounts available under the lines of credit are reduced by borrowings of \$26,471 at an average interest rate of 4.73%.

14 Other payables and accrued liabilities

Other payables and accrued liabilities consist of the following:

December 31,	1998	1999
Taxes other than income taxes Salaries and wages Social charges Advances received on fundings Commercial rebates Royalties payable	29,825 78,493 74,064 14,050 37,577 12,778	64,950 111,125 53,781 38,686 23,775 13,195
Other	80,894	76,333
Total	327,681	381,845

15 Other revenues

Other revenues consist of the following:

December 31,	1997	1998	1999
Licensing revenues Miscellaneous sales Other	27,598 17,250 4,524	1,765 27,833 7,536	 30,205 2,962
Total	49,372	37,134	33,167

16 Personnel

Labor costs consist of the following:

December 31,	1997	1998	1999
Salaries and wages Social security	753,275	825,961	957,950
contribution	214,023	219,942	247,550
Other	57,929	60,871	65,099
Total	1,025,227	1,106,774	1,270,599

Labor costs are allocated to cost of sales, selling, general and administrative expenses and research and development costs. At December 31, 1999 the Company employed 34,498 persons (1998: 29,182).

17 Other income and expenses Other income and expenses consist of the following: December 31, 1997 1998 1999

December 31,	1997	1998	1999
Research and development funding Start-up costs Exchange gain	55,269 (47,867)	63,531 (12,609)	60,352 (24,736)

(loss), net	15,158	19,019	14,653
Other	658	6,517	(10,429)
Total	23,218	76,458	39,840

Research and development finding does not include certain other funding received for industrialization costs (which include certain costs incurred to bring prototype products to the production stage). Such funding and costs are netted in cost of sales in the income statement (\$6,192 for 1997, \$3,081 for 1998 and \$2,417 for 1999).

18 Net interest income

Net interest income consists of the following:

December 31,	1997	1998	1999
Income Expenses	39,009 (41,655)	54,294 (45,603)	81,888 (46,264)
Total	(2,646)	8,691	35,624

Cash paid for interest was \$43,305 in 1997, \$48,569 in 1998 and \$48,086 in 1999. Capitalized interest was \$1,673 in 1997, \$5,487 in 1998 and \$8,317 in 1999.

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Income before income tax expense is comprised of the following:

December 31,	1997	1998	1999
Income from domestic operations Income from foreign	(8,437)	(18,730)	(17,494)
operations	525,610	550,831	724,616
Income before income tax expense	517,173	532,101	707,122

STMicroelectronics N.V. and its subsidiaries are individually liable for income tax. Tax losses can only offset profits generated by the taxable entity incurring such loss.

Income tax expense is comprised of the following:

December 31,	1997	1998	1999
Domestic taxes current	(8,377)	(3,886)	(4,353)
Foreign taxes current	(107,797)	(82,132)	(130,904)
Current taxes	(116,174)	(86,018)	(135,257)
Deferred taxes	3,157	(34,333)	(21,957)
Income tax expense	(113,017)	(120,351)	(157,214)

The principal items comprising the differences in income taxes computed at The Netherlands statutory rate (35%) and the effective income tax rate are the following:

December 31,	1997	1998	1999
Income tax expense computed at			
statutory rate	(181,011)	(186,235)	(247,493)
Benefit (deductions) for financial reporting			
with no tax effect	(2,056)	7,864	(699)
Variation in valuation			
allowance	(294)	397	3,107
Other tax and credits	(627)	2,995	8,549
Earnings of subsidiaries			
taxed at different rates	70,971	54,628	79,322
Income tax expense	(113,017)	(120,351)	(157,214)

Permanent differences reflect mainly the effects of capital allowance programs existing in certain Southeast Asian and Mediterranean countries, of special tax incentive programs existing in Asia Pacific regions, and of various non-deductible items.

Deferred tax assets and liabilities consist of the following:

December 31,	1998	1999
Tax loss carryforwards and capital allowances Inventory Other assets	41,375 46,856 95,353	74,321 41,256 111,447
Total deferred tax assets Valuation allowance	183,534 (4,053)	227,024 (12,251)
Deferred tax assets, net	179,531	214,773
Fixed assets depreciation Other liabilities	(240,116) (34,472)	
Deferred tax liabilities	(274,588)	(325,163)
Net deferred income tax liability	(95,057)	(110,390)

Deferred income taxes were classified in the consolidated balance as follows:

December 31,	1998	1999
Other receivables and assets Investments and other non-current	80,247	73,079
assets Accrued and deferred income tax	12,547 (15,695)	33,373 (31,072)

Source: STMICROELECTRONICS N, 20-F, June 27, 2000

Other non-current liabilities	(172,156)	(185,770)		
Net deferred income tax liability	(95,057)	(110,390)		
As of December 31, 1999, the Company and its subsidiaries have net operating loss carryforwards and capital allowances of which \$6,282 expire in the year 2000 and \$252,544 have indefinite expiration dates.				
The Company paid \$37,207 cash for inc for income taxes in 1998 and \$99,930 cash for inc		75,886 cash		
20 Commitments				
Lease commitments: The Company leases land, build	ling, plant and equip	ment under		

non-cancellable lease agreements. As of December 31, 1999 the future minimum lease payments to which the Company was committed under operating leases were as follows:

Year	1999
2000	18,789
2001	14,431
2002	10,496
2003	8,188
2004	6,682
Thereafter	16,250
Total	74,836

Other commitments: As of December 31, 1999, the Company had commitments of \$1,248,218 for equipment purchases.

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The Company is involved in various lawsuits, claims, investigations and proceedings incidental to the normal conduct of its operations. These matters mainly include the risks associated with external patents utilization, various investigations, claims from customers and tax disputes. Management believes that these contingencies will not have a material adverse effect on the business, financial condition or results of operations of the Company.

22 Financial Instruments and Risk Management

Financial instruments and derivatives are used exclusively for purposes other than trading.

Foreign exchange forward contracts and currency options: The Company enters into foreign exchange forward contracts and currency options to manage exposure to fluctuations in foreign currency exchange rates and to cover a portion of both its probable anticipated, but not firmly committed, transactions and transactions with firm foreign currency commitments. These transactions include international sales by various subsidiaries in foreign currencies, foreign currency denominated purchases, intercompany sales and other intercompany transactions. Such contracts outstanding as of December 31, 1999 have remaining terms of one to 13 months, maturing mainly during the first quarter of 2000.

The notional amounts of foreign exchange forward contracts totaled \$634,870 and \$611,567 at December 31, 1998 and 1999, respectively. The principal currencies covered are the Italian lira, the Japanese Yen, the Euro, the British pound and the Swiss franc.

The risk of loss associated with purchased options is limited to premium amounts paid for the option contracts. The risk of loss associated with forward contracts is equal to the exchange rate differential from the time the contract is entered into until the time it is settled. Realized and unrealized gains and losses on forward contracts are included in "other income and expenses." The discount or premium on forward contracts have been amortized over the life of the forward contract and included in "net interest expenses."

Concentration of credit risk: Financial instruments that potentially subject the Company to concentrations of credit risk consist primarily of interest-bearing investments, financial instruments with off-balance sheet risks (primarily forward contracts), and trade receivables. The Company places its cash and cash equivalents and certain other financial instruments with a variety of high credit quality financial institutions and has not experienced any material losses relating to such instruments. The Company invests its excess cash in accordance with its investment policy which aims to minimize credit risk.

The Company controls the credit risks associated with financial instruments through credit approvals, investment limits and centralized monitoring procedures but does not normally require collateral or other security from the parties to the financial instruments with off-balance sheet risk. Concentrations of credit risk with respect to trade receivables are limited due to the large number of customers and their dispersion across many geographic areas. The Company monitors the creditworthiness of its customers to which it grants credit terms in the normal course of business. The Company does not anticipate non-performance by counterparties which could have a significant impact on its financial position or results of operations.

Fair value of financial instruments: The estimates of fair value were obtained using prevailing financial market information resulting from various valuation techniques. The methodologies used to estimate fair value are as follows:

Cash and cash equivalents, accounts and notes receivable, bank overdrafts, short-term borrowings, accounts and notes payables: The carrying amounts reflected in the consolidated financial statements are reasonable estimates of fair value because of the relatively short period of time between the origination of the instruments and their expected realization.

Long-term debt and current portion of long-term debt: The fair values of long-term debt were determined based on quoted market prices, and by estimating future cash flows on a borrowing-by-borrowing basis and discounting these future cash flows using the Company's incremental borrowing rates for similar types of borrowing arrangements.

Foreign exchange forward contracts: The fair values of these instruments are estimated based upon quoted market prices for the same or similar instruments.

	1998		1999
Carrying	Estimated	Carrying	Estimated
Amount	Fair Value	Amount	Fair Value

Balance sheet --Bank loans

(including current portion) Liquid Yield Option Notes	365,224	355,514	321,082	323,482
(LYONs) Off-balance sheet Forward exchange	435,885	447,051	1,124,064	2,521,752
contracts	(10,869)	(12,080)	10,412	7,939

Transactions with significant shareholders and their affiliates were

December 31,	1997	1998	1999
Sales	148,172	5,608	19,033
Research and development expenses	(12,794)	(16,215)	(16,958)
Other purchases and expenses	(29,757)	(12,406)	(2,772)
Accounts receivable Accounts payable	17,244 9,745	1,872 10,509	6,222 1,876

As at December 31, 1997, the transactions with the shareholders included transactions with Thomson S.A. and Thomson CSF, who were shareholders during that year.

In June 1997, the United States Financial Accounting Standards Board issued Statement of Financial Accounting Standards No. 131, "Disclosure about Segments of an Enterprise and Related Information" (FAS 131), which the Company adopted effective December 31, 1998. FAS 131 requires that enterprises report certain information about operating segments. It also requires that enterprises report certain information about their products and services, the geographic areas in which they operate, and their major customers. The Company concluded that it has two principal businesses and operates in two segments: the Semiconductor segment and the Subsystems segment. In the Semiconductor segment, the Company designs, develops, manufactures and markets a broad range of products, including discrete, memories and standard commodity components, ASICSs (full custom devices and semicustom devices) and ASSPs for analog, digital, and mixed-signal applications. In the Subsystems segment, the Company designs, develops, manufactures and markets subsystems and modules for the Telecom, Automotive and Industrial markets including mobile phone accessories, battery chargers, ISDN power supplies and in-vehicle equipment for electronic toll payment. The Subsystems segment does not meet the requirements for a reportable segment as defined in FAS 131. The accounting policies of the segments are the same as those described in the summary of significant accounting policies.

The following is a summary of operations by entities located within the indicated geographic areas for 1997, 1998 and 1999. Long-lived assets consist of net property and equipment and other intangible assets.

Net revenues

December 31,	1997	1998	1999
France	455,663	474,580	451,243
Italy	189,222	171,143	174,087
Germany	427,211	444,362	470,554
Other European			
countries	728,128	737,112	828,879
USA	935,010	978,662	1,222,743
Singapore	1,031,020	1,261,165	1,669,129
Other countries	252,891	180,728	239,641
Total	4,019,145	4,247,752	5,056,276

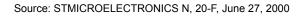
Long-lived assets

December 31,	1997	1998	1999
France Italy Germany	980,250 837,307 869	1,169,273 899,689 1,134	1,239,540 1,117,241 1,094
Other European countries USA Singapore Other countries	7,402 605,666 227,888 413,854	19,922 587,734 216,817 472,007	236,202 736,187 245,386 477,316
Total	3,073,236	3,366,576	4,052,966

25 Subsequent events (unaudited)

In March 2000, the Supervisory Board approved the submission of several resolutions for shareholder approval at the annual shareholders' meeting to be held on April 26, 2000. The resolutions include the payment of a cash dividend of \$0.09 per share and a three for one stock split to be effective the day after the cash dividend payment date.

²⁴ Segment information



To the Supervisory Board and Shareholders of STMicroelectronics N.V.

In our opinion, the accompanying consolidated balance sheet and the related $% \left({{{\left({{{\left({{{\left({{{c}}} \right)}} \right.} \right.} \right)}_{\rm{cons}}}} \right)$ consolidated statements of income, of cash flows and of changes in shareholders' equity present fairly, in all material respects, the financial position of STMicroelectronics N.V. and its subsidiaries at December 31, 1999 and 1998, and the results of their operations and their cash flows for each of the three years in the period ended December 31, 1999, in conformity with accounting principles generally accepted in the United States of America. These financial statements are the responsibility of the Company's management; our responsibility is to express an opinion on these financial statements based on our audits. We conducted our audits of these statements in accordance with auditing standards generally accepted in the United States of America which require that we plan and perform the audit to obtain reasonable assurance about whether the financial statements are free of material misstatement. An audit includes examining, on a test basis, evidence supporting the amounts and disclosures in the financial statements, assessing the accounting principles used and significant estimates made by management, and evaluating the overall financial statement presentation. We believe that our audits provide a reasonable basis for the opinion expressed above.

PricewaterhouseCoopers N.V. Amsterdam, January 25, 2000

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